



LG

Life's Good

LED LCD TV **SERVICE MANUAL**

CHASSIS : LT01M

MODEL : 37LV3500 37LV3500-DG

Internal Use Only

North/Latin America
Europe/Africa
Asia/Oceania

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CAUTION

BEFORE SERVICING THE CHASSIS,
READ THE SAFETY PRECAUTIONS IN THIS MANUAL.

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SAFETY PRECAUTIONS

IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by \triangle in the Schematic Diagram and Exploded View.

It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent Shock, Fire, or other Hazards.

Do not modify the original design without permission of manufacturer.

General Guidance

An **isolation Transformer** should always be used during the servicing of a receiver whose chassis is not isolated from the AC power line. Use a transformer of adequate power rating as this protects the technician from accidents resulting in personal injury from electrical shocks.

It will also protect the receiver and its components from being damaged by accidental shorts of the circuitry that may be inadvertently introduced during the service operation.

If any fuse (or Fusible Resistor) in this TV receiver is blown, replace it with the specified.

When replacing a high wattage resistor (Oxide Metal Film Resistor, over 1W), keep the resistor 10mm away from PCB.

Keep wires away from high voltage or high temperature parts.

Before returning the receiver to the customer,

always perform an **AC leakage current check** on the exposed metallic parts of the cabinet, such as antennas, terminals, etc., to be sure the set is safe to operate without damage of electrical shock.

Leakage Current Cold Check(Antenna Cold Check)

With the instrument AC plug removed from AC source, connect an electrical jumper across the two AC plug prongs. Place the AC switch in the on position, connect one lead of ohm-meter to the AC plug prongs tied together and touch other ohm-meter lead in turn to each exposed metallic parts such as antenna terminals, phone jacks, etc.

If the exposed metallic part has a return path to the chassis, the measured resistance should be between $1M\Omega$ and $5.2M\Omega$.

When the exposed metal has no return path to the chassis the reading must be infinite.

An other abnormality exists that must be corrected before the receiver is returned to the customer.

Leakage Current Hot Check (See below Figure)

Plug the AC cord directly into the AC outlet.

Do not use a line Isolation Transformer during this check.

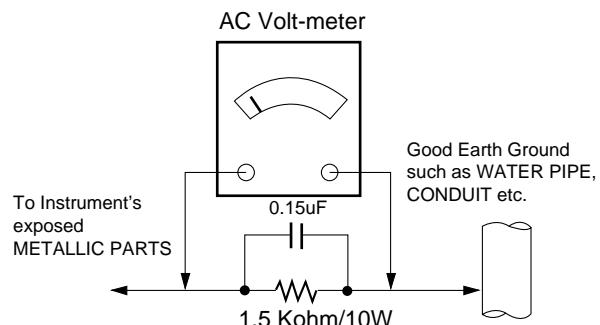
Connect 1.5K/10watt resistor in parallel with a 0.15uF capacitor between a known good earth ground (Water Pipe, Conduit, etc.) and the exposed metallic parts.

Measure the AC voltage across the resistor using AC voltmeter with 1000 ohms/volt or more sensitivity.

Reverse plug the AC cord into the AC outlet and repeat AC voltage measurements for each exposed metallic part. Any voltage measured must not exceed 0.75 volt RMS which corresponds to 0.5mA.

In case any measurement is out of the limits specified, there is possibility of shock hazard and the set must be checked and repaired before it is returned to the customer.

Leakage Current Hot Check circuit



When 25A is impressed between Earth and 2nd Ground for 1 second, Resistance must be less than 0.1Ω

*Base on Adjustment standard

SERVICING PRECAUTIONS

CAUTION: Before servicing receivers covered by this service manual and its supplements and addenda, read and follow the **SAFETY PRECAUTIONS** on page 3 of this publication.

NOTE: If unforeseen circumstances create conflict between the following servicing precautions and any of the safety precautions on page 3 of this publication, always follow the safety precautions. Remember: Safety First.

General Servicing Precautions

1. Always unplug the receiver AC power cord from the AC power source before;
 - a. Removing or reinstalling any component, circuit board module or any other receiver assembly.
 - b. Disconnecting or reconnecting any receiver electrical plug or other electrical connection.
 - c. Connecting a test substitute in parallel with an electrolytic capacitor in the receiver.

CAUTION: A wrong part substitution or incorrect polarity installation of electrolytic capacitors may result in an explosion hazard.
2. Test high voltage only by measuring it with an appropriate high voltage meter or other voltage measuring device (DVM, FETVOM, etc) equipped with a suitable high voltage probe.
Do not test high voltage by "drawing an arc".
3. Do not spray chemicals on or near this receiver or any of its assemblies.
4. Unless specified otherwise in this service manual, clean electrical contacts only by applying the following mixture to the contacts with a pipe cleaner, cotton-tipped stick or comparable non-abrasive applicator; 10% (by volume) Acetone and 90% (by volume) isopropyl alcohol (90%-99% strength)
CAUTION: This is a flammable mixture.
Unless specified otherwise in this service manual, lubrication of contacts is not required.
5. Do not defeat any plug/socket B+ voltage interlocks with which receivers covered by this service manual might be equipped.
6. Do not apply AC power to this instrument and/or any of its electrical assemblies unless all solid-state device heat sinks are correctly installed.
7. Always connect the test receiver ground lead to the receiver chassis ground before connecting the test receiver positive lead.
Always remove the test receiver ground lead last.
8. *Use with this receiver only the test fixtures specified in this service manual.*
CAUTION: Do not connect the test fixture ground strap to any heat sink in this receiver.

Electrostatically Sensitive (ES) Devices

Some semiconductor (solid-state) devices can be damaged easily by static electricity. Such components commonly are called **Electrostatically Sensitive (ES) Devices**. Examples of typical ES devices are integrated circuits and some field-effect transistors and semiconductor "chip" components. The following techniques should be used to help reduce the incidence of component damage caused by static by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed to prevent potential shock reasons prior to applying power to the

unit under test.

2. After removing an electrical assembly equipped with ES devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
 3. Use only a grounded-tip soldering iron to solder or unsolder ES devices.
 4. Use only an anti-static type solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ES devices.
 5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ES devices.
 6. Do not remove a replacement ES device from its protective package until immediately before you are ready to install it. (Most replacement ES devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive material).
 7. Immediately before removing the protective material from the leads of a replacement ES device, touch the protective material to the chassis or circuit assembly into which the device will be installed.
- CAUTION:** Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.
8. Minimize bodily motions when handling unpackaged replacement ES devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ES device.)

General Soldering Guidelines

1. Use a grounded-tip, low-wattage soldering iron and appropriate tip size and shape that will maintain tip temperature within the range of 500°F to 600°F.
2. Use an appropriate gauge of RMA resin-core solder composed of 60 parts tin/40 parts lead.
3. Keep the soldering iron tip clean and well tinned.
4. Thoroughly clean the surfaces to be soldered. Use a small wire-bristle (0.5 inch, or 1.25cm) brush with a metal handle.
Do not use freon-propelled spray-on cleaners.
5. Use the following unsoldering technique
 - a. Allow the soldering iron tip to reach normal temperature. (500°F to 600°F)
 - b. Heat the component lead until the solder melts.
 - c. Quickly draw the melted solder with an anti-static, suction-type solder removal device or with solder braid.
CAUTION: Work quickly to avoid overheating the circuit board printed foil.
6. Use the following soldering technique.
 - a. Allow the soldering iron tip to reach a normal temperature (500°F to 600°F)
 - b. First, hold the soldering iron tip and solder the strand against the component lead until the solder melts.
 - c. Quickly move the soldering iron tip to the junction of the component lead and the printed circuit foil, and hold it there only until the solder flows onto and around both the component lead and the foil.
CAUTION: Work quickly to avoid overheating the circuit board printed foil.
 - d. Closely inspect the solder area and remove any excess or splashed solder with a small wire-bristle brush.

IC Remove/Replacement

Some chassis circuit boards have slotted holes (oblong) through which the IC leads are inserted and then bent flat against the circuit foil. When holes are the slotted type, the following technique should be used to remove and replace the IC. When working with boards using the familiar round hole, use the standard technique as outlined in paragraphs 5 and 6 above.

Removal

1. Desolder and straighten each IC lead in one operation by gently prying up on the lead with the soldering iron tip as the solder melts.
2. Draw away the melted solder with an anti-static suction-type solder removal device (or with solder braid) before removing the IC.

Replacement

1. Carefully insert the replacement IC in the circuit board.
2. Carefully bend each IC lead against the circuit foil pad and solder it.
3. Clean the soldered areas with a small wire-bristle brush. (It is not necessary to reapply acrylic coating to the areas).

"Small-Signal" Discrete Transistor

Removal/Replacement

1. Remove the defective transistor by clipping its leads as close as possible to the component body.
2. Bend into a "U" shape the end of each of three leads remaining on the circuit board.
3. Bend into a "U" shape the replacement transistor leads.
4. Connect the replacement transistor leads to the corresponding leads extending from the circuit board and crimp the "U" with long nose pliers to insure metal to metal contact then solder each connection.

Power Output, Transistor Device

Removal/Replacement

1. Heat and remove all solder from around the transistor leads.
2. Remove the heat sink mounting screw (if so equipped).
3. Carefully remove the transistor from the heat sink of the circuit board.
4. Insert new transistor in the circuit board.
5. Solder each transistor lead, and clip off excess lead.
6. Replace heat sink.

Diode Removal/Replacement

1. Remove defective diode by clipping its leads as close as possible to diode body.
2. Bend the two remaining leads perpendicular y to the circuit board.
3. Observing diode polarity, wrap each lead of the new diode around the corresponding lead on the circuit board.
4. Securely crimp each connection and solder it.
5. Inspect (on the circuit board copper side) the solder joints of the two "original" leads. If they are not shiny, reheat them and if necessary, apply additional solder.

Fuse and Conventional Resistor

Removal/Replacement

1. Clip each fuse or resistor lead at top of the circuit board hollow stake.
2. Securely crimp the leads of replacement component around notch at stake top.
3. Solder the connections.

CAUTION: Maintain original spacing between the replaced component and adjacent components and the circuit board to prevent excessive component temperatures.

Circuit Board Foil Repair

Excessive heat applied to the copper foil of any printed circuit board will weaken the adhesive that bonds the foil to the circuit board causing the foil to separate from or "lift-off" the board. The following guidelines and procedures should be followed whenever this condition is encountered.

At IC Connections

To repair a defective copper pattern at IC connections use the following procedure to install a jumper wire on the copper pattern side of the circuit board. (Use this technique only on IC connections).

1. Carefully remove the damaged copper pattern with a sharp knife. (Remove only as much copper as absolutely necessary).
2. carefully scratch away the solder resist and acrylic coating (if used) from the end of the remaining copper pattern.
3. Bend a small "U" in one end of a small gauge jumper wire and carefully crimp it around the IC pin. Solder the IC connection.
4. Route the jumper wire along the path of the out-away copper pattern and let it overlap the previously scraped end of the good copper pattern. Solder the overlapped area and clip off any excess jumper wire.

At Other Connections

Use the following technique to repair the defective copper pattern at connections other than IC Pins. This technique involves the installation of a jumper wire on the component side of the circuit board.

1. Remove the defective copper pattern with a sharp knife. Remove at least 1/4 inch of copper, to ensure that a hazardous condition will not exist if the jumper wire opens.
2. Trace along the copper pattern from both sides of the pattern break and locate the nearest component that is directly connected to the affected copper pattern.
3. Connect insulated 20-gauge jumper wire from the lead of the nearest component on one side of the pattern break to the lead of the nearest component on the other side. Carefully crimp and solder the connections.

CAUTION: Be sure the insulated jumper wire is dressed so the it does not touch components or sharp edges.

SPECIFICATION

NOTE : Specifications and others are subject to change without notice for improvement.

1. Application range

This specification is applied to LCD TV used LT01M/P/R chassis.

2. Requirement for Test

Each part is tested as below without special appointment.

- 1) Temperature : $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$
- 2) Relative Humidity : $65 \pm 10\%$
- 3) Power Voltage : Standard input voltage (100-240V~50/60Hz)
* Standard Voltage of each products is marked by models.
- 4) Specification and performance of each parts are followed each drawing and specification by part number in accordance with BOM.
- 5) The receiver must be operated for about 20 minutes prior to the adjustment.

3. Test method

- 1) Performance: LGE TV test method followed
- 2) Demanded other specification
 - Safety: CE / ICE / BSMI specification
 - EMI: CE / ICE / BSMI

4. General Specification(TV)

No	Item	Specification			Remark
1	Screen Size	26 inch			T260XW04-V9(AUO)
		31.5 inch			T315XW03-VF(AUO) T315XW06-VD(AUO)
		31.55 inch			T315HW04 V9(AUO) LC320EUN-SDV2(LGD) LC320WUN-SCA2(LGD)
		31.51inch			LC320EXN-SDA1(LGD) LC320WXN-SCA2(LGD)
		32inch			T315HW07-V8(AUO)
		37inch			LC370WUE-SCA1(LGD) LC370EUN-SDV2(LGD)
		42inch			LC420WUE-SCA2(LGD) T420HW08-V1(AUO)
		42.02inch			LC420EUN-SDV3(LGD)
		46.96inch			LC470EUE-SDV1(LGD)
2	LCD Module	26" Color WXGA TFT-LCD Module			T260XW04 V9(AUO)
		31.5" Color WXGA TFT-LCD Module			T315HW04 V9, T315XW03-VF(AUO) T315XW06 VD(AUO-CI)
		32" Color WXGA TFT-LCD Module			T315HW07-V8(AUO)
		31.55" Color WUXGA TFT-LCD Module			LC320EUN-SDV2 LC320WUN-SCA2(LGD)
		31.51" Color WXGA TFT-LCD Module			LC320EXN-SDA1 LC320WXN-SCA2(LGD)
		37" Color WUXGA TFT-LCD Module			LC370WUE-SCA1 LC370EUN-SDV2(LGD)
		42" Color WUXGA TFT-LCD Module			LC420WUE-SCA2(LGD)
		42.02" Color WUXGA TFT-LCD Module			LC420EUN-SDV3(LGD)
		42" Color WUXGA TFT-LCD Module			V420H2-LE5(CMI)
		42" Color WUXGA TFT-LCD Module			T420HW08 V1(AUO) T420HW08 V9(AUO CI)
		46.96" Color WUXGA TFT-LCD Module			LC470EUE-SDV1(LGD)
3	Operating Environment	Temp : 0 ~ 50 deg Humidity :10 ~ 90 %			
4	Storage Environment	Temp : -20 ~ 60 deg Humidity : 10 ~ 90 %			
5	Input Voltage	AC100 ~ 240V, 50/60Hz			
6	Power Consumption	90W	26"	HD(CCFL)	T260XW04 V9(AUO)
		65W	32"	HD(LED)	LC320EXN-SDA1(LGD)
		105W	31.5"	HD(CCFL)	T315XW03-VF(AUO)
		105W	31.51"	HD(CCFL)	LC320WXN-SCA2(LGD)
		105W	32"	FHD(CCFL)	T315HW04 V9(AUO)
		61W	32"	FHD(LED)	T315HW07-V8(AUO)
		70W	31.55"	FHD(LED)	LC320EUN-SDV2(LGD)
		105W	31.55"	FHD(EEFL)	LC320WUN-SCA2(LGD)
		150W	37"	FHD(EEFL)	LC370WUE-SCA1(LGD)
		80W	37"	FHD(LED)	LC370EUN-SDV2(LGD)
		175W	42"	FHD	LC420WUE-SCA2(LGD)
		85W	42"	FHD	T420HW08 V1(AUO)
		110W	42.02"	FHD	LC420EUN-SDV3(LGD)
		130W	46.96"	FHD	LC470EUE-SDV1(LGD)

No	Item	Specification			Remark
8	LCD Module (Outline Demension)	Maker	Inch	(H)x(V)x(D)	Unit: mm
		AUO	26"	626.0 (H) x 373.0 (V) x 43.5 (D)	T260XW04 V9(AUO)
		LGD	32"	735.4 (H) x 433.0 (V) x 10.8 (D)	LC320EXN-SDA1(LGD)
		LGD	31.51"	760.0 (H) x 450.0 (V) x 43.0 (D)	LC320WXN-SCA2(LGD)
		AUO	32"	760.0 (H) x 450.0 (V) x 46.9 (D)	T315XW03-VF(AUO)
		AUO	31.5"	735.4 (H) x 433.8 (V) x 10.8 (D)	T315XW06 VD(AUO CI)
		AUO	32"	760.0 (H) x 450.0 (V) x 46.9 (D)	T315HW04 V9(AUO)
		AUO	32"	735.4 (H) x 433.0 (V) x 20.9 (D)	T315HW07-V8(AUO)
		LGD	31.55"	735.4 (H) x 433.0 (V) x 23.6 (D)	LC320EUN-SDV2(LGD)
		LGD	31.55"	760.0 (H) x 450.0 (V) x 48.0 (D)	LC320WUN-SCA2(LGD)
		LGD	37"	877.0 (H) x 516.8 (V) x 36.4 (D)	LC370WUE-SCA1(LGD)
		LGD	37"	856.4 (H) x 501.0 (V) x 23.6 (D)	LC370EUN-SDV2(LGD)
		LGD	42"	983.0 (H) x 576.0 (V) x 46.0 (D)	LC420WUE-SCA2(LGD)
		LGD	42.02"	968.4 (H) x 564.0 (V) x 18.3 (D)	LC420EUN-SDV3(LGD)
		AUO	42"	968.4 (H) x 576.0 (V) x 25.1 (D)	T420HW08 V1(AUO), T420HW08 V9(AUO CI)
		CMI	42"	968.4 (H) x 564.0 (V) x 10.8 (D)	V420H2-LE5(CMI)
		LGD	46.96"	1078.6 (H) x 626.0 (V) x 22.9 (D)	LC470EUE-SDV1(LGD)

5. LCD Module

5.1. 26" LCD Module (AUO) T260XW04-V9

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		360	450		
		Variation			-	1.3	
3.	Contrast Ratio	CR		2400	3000		All white/ All black
4.	CIE Color Coordinates	White	WX		0.280		
			WY		0.290	Typ +0.03	
		RED	Xr	- 0.03	0.640		
			Yr		0.330		
		Green	Xg		0.281		
			Yg		0.590		
		Blue	Xb		0.150		
			Yb		0.050		

5.2. 32" TFT-LCD Module (AUO) T315HW04-V9

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		320	400		
		Variation			-	1.3	
3.	Contrast Ratio	CR		3200	4000		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.28	Typ +0.03	
			WY		0.29		
		RED	Xr		0.64		
			Yr		0.33		
		Green	Xg		0.29		
			Yg		0.60		
		Blue	Xb		0.15		
			Yb		0.05		

5.3. 32" TFT-LCD Module (AUO) T315HW07-V8

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		320	400		
		Variation			-	1.3	
3.	Contrast Ratio	CR		3200	4000		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.28	Typ +0.03	
			WY		0.29		
		RED	Xr		0.63		
			Yr		0.33		
		Green	Xg		0.32		
			Yg		0.62		
		Blue	Xb		0.15		
			Yb		0.04		

5.4. 32" TFT-LCD Module (CMI) – V315B5-LE3

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		88/88/88/88			CR > 10
2.	Luminance	Luminance (cd/m ²)		360	450		
		Variation			-	1.3	
3.	Contrast Ratio	CR		3750	5000		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.280	Typ +0.03	
			WY		0.290		
		RED	Xr		0.648		
			Yr		0.321		
		Green	Xg		0.304		
			Yg		0.617		
		Blue	Xb		0.149		
			Yb		0.063		

5.5. 32" TFT-LCD Module (AUO) – T315XW06 V3

No.	Item	Specification		Min.	Typ.	Max.	Remark	
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10	
2.	Luminance	Luminance (cd/m ²)		280	350			
		Variation			-	1.3		
3.	Contrast Ratio	CR		2400	3000		All white/ All black	
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.280	Typ +0.03		
			WY		0.290			
		RED	Xr		0.640			
			Yr		0.330			
		Green	Xg		0.310			
			Yg		0.620			
		Blue	Xb	Typ - 0.03	0.150	Typ +0.03		
			Yb		0.060			

5.6. 32" TFT-LCD Module (AUO CI) – T315XW06 VD

No.	Item	Specification		Min.	Typ.	Max.	Remark	
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10	
2.	Luminance	Luminance (cd/m ²)		240	300			
		Variation			-	1.3		
3.	Contrast Ratio	CR		1600	2000		All white/ All black	
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.280	Typ +0.03		
			WY		0.290			
		RED	Xr		0.630			
			Yr		0.330			
		Green	Xg		0.320			
			Yg		0.620			
		Blue	Xb	Typ - 0.03	0.150	Typ +0.03		
			Yb		0.04			

5.7. 32" TFT-LCD Module (AUO) – T315XW03-VF

No.	Item	Specification		Min.	Typ.	Max.	Remark	
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10	
2.	Luminance	Luminance (cd/m ²)		350	400			
		Variation			-	1.3		
3.	Contrast Ratio	CR		2400	3000		All white/ All black	
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.280	Typ +0.03		
			WY		0.290			
		RED	Xr		0.640			
			Yr		0.330			
		Green	Xg		0.290			
			Yg		0.600			
		Blue	Xb	Typ - 0.03	0.150	Typ +0.03		
			Yb		0.060			

5.8. 32" TFT-LCD Module (LGD) – LC320EXN-SDA1

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		300	380		
		Variation			-	1.3	
3.	Contrast Ratio	CR		850	1200		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.279	Typ +0.03	
			WY		0.292		
		RED	Xr		0.635		
			Yr		0.341		
		Green	Xg		0.317		
			Yg		0.605		
		Blue	Xb		0.153		
			Yb		0.055		

5.9. 32" TFT-LCD Module (LGD) – LC320WXN-SCA2

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		380	450		
		Variation			-	1.3	
3.	Contrast Ratio	CR		900	1200		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.279	Typ +0.03	
			WY		0.292		
		RED	Xr		0.636		
			Yr		0.335		
		Green	Xg		0.291		
			Yg		0.603		
		Blue	Xb		0.146		
			Yb		0.061		

5.10. 32" TFT-LCD Module (LGD) – LC320WUN-SCA2

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		300	380		
		Variation			-	1.3	
3.	Contrast Ratio	CR		2400	3000		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.279	Typ +0.03	
			WY		0.292		
		RED	Xr		0.642		
			Yr		0.334		
		Green	Xg		0.292		
			Yg		0.607		
		Blue	Xb		0.146		
			Yb		0.056		

5.11. 32" TFT-LCD Module (LGD) – LC320EUN-SDV2

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		290	360		
		Variation			-	1.3	
3.	Contrast Ratio	CR		1100	1400		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.279	Typ +0.03	
			WY		0.292		
		RED	Xr		0.637		
			Yr		0.341		
		Green	Xg		0.320		
			Yg		0.606		
		Blue	Xb		0.152		
			Yb		0.055		

5.12. 37" TFT-LCD Module (LGD) – LC37WUE-SCA1

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		400	500		
		Variation			-	1.3	
3.	Contrast Ratio	CR		1100	1500		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.279	Typ +0.03	
			WY		0.292		
		RED	Xr		0.639		
			Yr		0.334		
		Green	Xg		0.289		
			Yg		0.606		
		Blue	Xb		0.145		
			Yb		0.065		

5.13. 37" TFT-LCD Module (AUO) – T370HW05-V1

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		320	400		
		Variation			-	1.33	
3.	Contrast Ratio	CR		3200	4000		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.280	Typ +0.03	
			WY		0.290		
		RED	Xr		0.640		
			Yr		0.330		
		Green	Xg		0.320		
			Yg		0.620		
		Blue	Xb		0.150		
			Yb		0.050		

5.14. 37" TFT-LCD Module (LGD) – LC370EUN-SDV2

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		290	360		
		Variation			-	1.3	
3.	Contrast Ratio	CR		1100	1600		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.279	Typ +0.03	
			WY		0.292		
		RED	Xr		0.637		
			Yr		0.341		
		Green	Xg		0.319		
			Yg		0.605		
		Blue	Xb		0.154		
			Yb		0.051		

5.15. 42" LCD Module (LGD) – LC420WUE-SCA2

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		400	500		
		Variation			-	1.3	
3.	Contrast Ratio	CR		1100	1500		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.279	Typ +0.03	
			WY		0.292		
		RED	Xr		0.636		
			Yr		0.335		
		Green	Xg		0.291		
			Yg		0.603		
		Blue	Xb		0.146		
			Yb		0.061		

5.16. 42" TFT-LCD Module (AUO) – T420HW08-V1

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10
2.	Luminance	Luminance (cd/m ²)		320	400		
		Variation			-	1.3	
3.	Contrast Ratio	CR		3200	4000		All white/ All black
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.280	Typ +0.03	
			WY		0.290		
		RED	Xr		0.630		
			Yr		0.330		
		Green	Xg		0.320		
			Yg		0.620		
		Blue	Xb		0.150		
			Yb		0.050		

5.17. 42" TFT-LCD Module (AUO CI) – T420HW08-V9

No.	Item	Specification		Min.	Typ.	Max.	Remark	
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10	
2.	Luminance	Luminance (cd/m ²)		240	400			
		Variation			-	1.3		
3.	Contrast Ratio	CR		1600	2000		All white/ All black	
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.280	Typ +0.03		
			WY		0.290			
		RED	Xr		0.630			
			Yr		0.330			
		Green	Xg		0.320			
			Yg		0.620			
		Blue	Xb	Typ - 0.03	0.150	Typ +0.03		
			Yb		0.040			

5.18. 42" TFT-LCD Module (LGD) – LC420EUN-SDV3

No.	Item	Specification		Min.	Typ.	Max.	Remark	
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10	
2.	Luminance	Luminance (cd/m ²)		290	360			
		Variation			-	1.3		
3.	Contrast Ratio	CR		1100	1400		All white/ All black	
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.279	Typ +0.03		
			WY		0.292			
		RED	Xr		0.637			
			Yr		0.341			
		Green	Xg		0.325			
			Yg		0.600			
		Blue	Xb	Typ - 0.03	0.152	Typ +0.03		
			Yb		0.061			

5.19. 47" TFT-LCD Module (LGD) – LC470EUE-SDV1

No.	Item	Specification		Min.	Typ.	Max.	Remark	
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89/89/89/89			CR > 10	
2.	Luminance	Luminance (cd/m ²)		290	360			
		Variation			-	1.3		
3.	Contrast Ratio	CR		1000	1400		All white/ All black	
4.	CIE Color Coordinates	White	WX	Typ - 0.03	0.279	Typ +0.03		
			WY		0.292			
		RED	Xr		0.639			
			Yr		0.343			
		Green	Xg		0.316			
			Yg		0.595			
		Blue	Xb	Typ - 0.03	0.152	Typ +0.03		
			Yb		0.058			

6. Component Video Input (Y, C_B/P_B, C_R/P_R)

No	Specification				Remark
	Resolution	H-freq(kHz)	V-freq(Hz)		
1.	720x480	15.73	60.00	SDTV,DVD 480i	
2.	720x480	15.63	59.94	SDTV,DVD 480i	
3.	720x480	31.47	59.94	480p	
4.	720x480	31.50	60.00	480p	
5.	720x576	15.625	50.00	SDTV,DVD 625 Line	
6.	720x576	31.25	50.00	HDTV 576p	
7.	1280x720	37.50	50.00	HDTV 720p	
8.	1280x720	44.96	59.94	HDTV 720p	
9.	1280x720	45.00	60.00	HDTV 720p	
10.	1920x1080	28.125	50.00	HDTV 1080i	
11.	1920x1080	33.75	60.00	HDTV 1080i	
12.	1920x1080	33.72	59.94	HDTV 1080i	
13.	1920x1080	56.250	50	HDTV 1080p	
14.	1920x1080	67.43/67.5	59.94/60	HDTV 1080p	

7. RGB (PC)

No	Specification				Proposed	Remark
	Resolution	H-freq(kHz)	V-freq(Hz)	Pixel Clock(MHz)		
1.	720*400	31.468	70.08	28.321		For only DOS mode
2.	640*480	31.469	59.94	25.17	VESA	Input 848*480 60Hz, 852*480 60Hz -> 640*480 60Hz Display
3.	800*600	37.879	60.31	40.00	VESA	
4.	1024*768	48.363	60.00	65.00	VESA(XGA)	
5.	1280*768	47.78	59.87	79.5	WXGA	
6.	1360*768	47.72	59.8	84.75	WXGA	
7.	1280*1024	63.595	60.0	108.875	SXGA	FHD model
8.	1920*1080	66.587	59.93	138.625	WUXGA	FHD model

8. HDMI Input (PC/DTV)

8.1. DTV Mode

No	Resolution	H-freq(kHz)	V-freq.(Hz)	Pixel clock(MHz)	Proposed	Remark
1.	720*480	31.469 /31.5	59.94 / 60	27.00/27.03	SDTV 480P	
2.	720*576	31.25	50	54	SDTV 576P	
3.	1280*720	37.500	50	74.25	HDTV 720P	
4.	1280*720	44.96 / 45	59.94 / 60	74.17/ 74.25	HDTV 720P	
5.	1920*1080	33.72 / 33.75	59.94 / 60	74.17/ 74.25	HDTV 1080I	
6.	1920*1080	28.125	50.00	74.25	HDTV 1080I	
7.	1920*1080	26.97 / 27	23.97 / 24	74.17/ 74.25	HDTV 1080P	
8.	1920*1080	33.716 / 33.75	29.976 / 30.00	74.25	HDTV 1080P	
9.	1920*1080	56.250	50	148.5	HDTV 1080P	
10.	1920*1080	67.43 / 67.5	59.94 / 60	148.35/148.50	HDTV 1080P	

8.2. PC Mode

No	Resolution	H-freq(kHz)	V-freq.(Hz)	Pixel clock(MHz)	Proposed	Remark
1.	720*400	31.468	70.08	28.321		HDCP
2.	640*480	31.469	59.94	25.17	VESA	HDCP
3.	800*600	37.879	60.31	40.00	VESA	HDCP
4.	1024*768	48.363	60.00	65.00	VESA(XGA)	HDCP
5.	1360*768	47.72	59.8	84.75	WXGA	HDCP
6.	1280*1024	63.981	60.02	108.00	SXGA	HDCP / FHD Model
7.	1920*1080	67.5	60	148.5	WUXGA	HDCP / FHD Model

ADJUSTMENT INSTRUCTION

1. Application Range

This specification sheet is applied to all of the LCD TV with LT01M/P/R chassis.

2. Designation

- 1) The adjustment is according to the order which is designated and which must be followed, according to the plan which can be changed only on agreeing.
- 2) Power Adjustment: Free Voltage
- 3) Magnetic Field Condition: Nil.
- 4) Input signal Unit: Product Specification Standard
- 5) Reserve after operation: Above 5 Minutes (Heat Run)
Temperature : at $25\pm 5^{\circ}\text{C}$
Relative humidity : $65\pm 10\%$
Input voltage : 220V, 60Hz

The receiver must be operated for about 5 minutes prior to the adjustment when module is in the circumstance of over 15°C
In case of keeping module is in the circumstance of 0°C , it should be placed in the circumstance of above 15°C for 2 hours
In case of keeping module is in the circumstance of below -20°C , it should be placed in the circumstance of above 15°C for 3 hours.,

Caution) When still image is displayed for a period of 20 minutes or longer, there can some afterimage in the black level area.

- 6) Adjustment equipments : Color Analyzer (CA-210 or CA-110), DDC Adjustment Jig equipment, SVC remote controller.
- 7) Push The "IN STOP KEY" - For memory initialization.

Case1 : Software version up

1. After downloading S/W by USB, TV set will reboot automatically
2. Push "In-stop" key
3. Push "Power on" key
4. Function inspection
5. After function inspection, Push "In-stop" key.

Case2 : Function check at the assembly line

1. When TV set is entering on the assembly line, Push "In-stop" key at first.
2. Push "Power on" key for turning it on.
-> If you push "Power on" key, TV set will recover channel information by itself.
3. After function inspection, Push "In-stop" key.

3. Main PCB check process

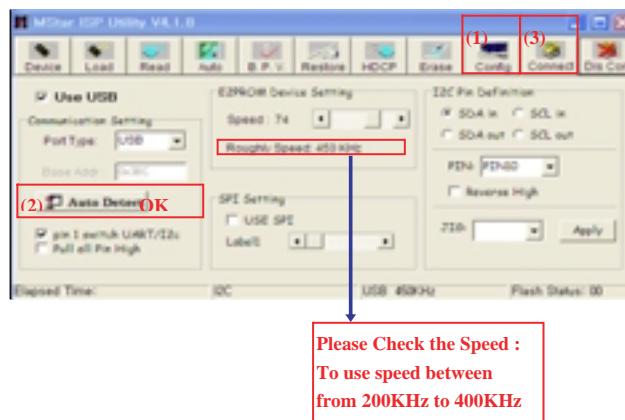
* APC - After Manual-Insert, executing APC

* Boot file Download

- (1) Execute ISP program "Mstar ISP Utility" and then click "Config" tab.
- (2) Set as below, and then click "Auto Detect" and check "OK" message.
If "Error" is displayed, Check connection between computer, jig, and set..
- (3) Click "Read" tab, and then load download file (XXXX.bin) by clicking "Read".



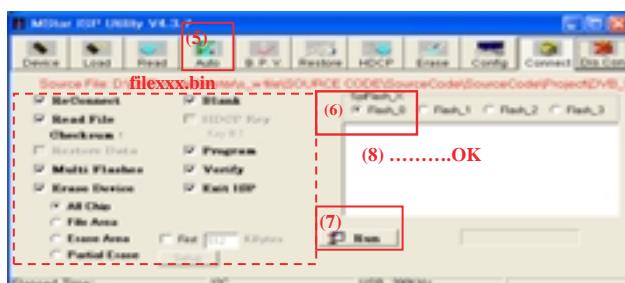
- (4) Click "Connect" tab. If "Can't" is displayed, check connection between computer, jig, and set.



- (5) Click "Auto" tab and set as below

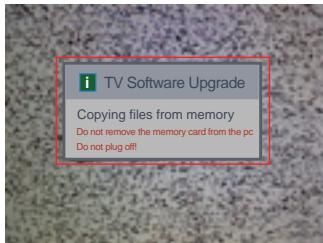
- (6) Click "Run".

- (7) After downloading, check "OK" message.

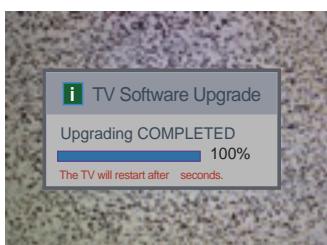
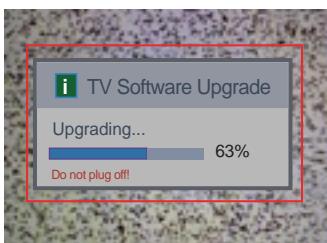


* USB DOWNLOAD(*.epk file download)

- (1) Put the USB Stick to the USB socket.
- (2) Automatically detecting update file in USB Stick.
 - If your downloaded program version in USB Stick is Low, it didn't work. But your downloaded version is High, USB data is automatically detecting
- (3) Show the message "Copying files from memory"



- (4) Updating is staring.



- (5) After updating is complete, The TV will restart automatically.
- (6) If TV turns on, check your updated version and Tool option. (refer to the next page about tool option)
 - * If downloading version is higher than your TV have, TV can lost all channel data. In this case, you have to channel recover. If all channel data is cleared, you didn't have a DTV/ATV test on production line.

* After downloading, have to adjust Tool Option again.

1. Push "IN-START" key in service remote controller.
2. Select "Tool Option 1" and Push "OK" button.
3. Punch in the number. (Each model has their number.)

Model	Tool option1	Tool option2	Tool option3	Tool option4	Tool option5
47LV3500-DG_LGD	34656	19478	55337	26904	256
42LV3500-DG_CMI	26468	19478	55337	26904	352
42LV3500-DG_AUO	26472	19478	55337	26904	352
42LV3500-DG_LGD	26464	19478	55337	26904	288
37LV3500-DG_LGD	22368	19478	55337	26904	288
37LV3500-DG_AUO	22376	19478	55337	26904	352
32LV3500-DG_LGD	18272	19478	55337	26904	288
32LV3500-DG_AUO	18280	19478	55337	26904	352
42LV3400-DG_LGD	26592	9226	53289	26904	288
42LV3300-DG_AUO		9226	53289	26904	288

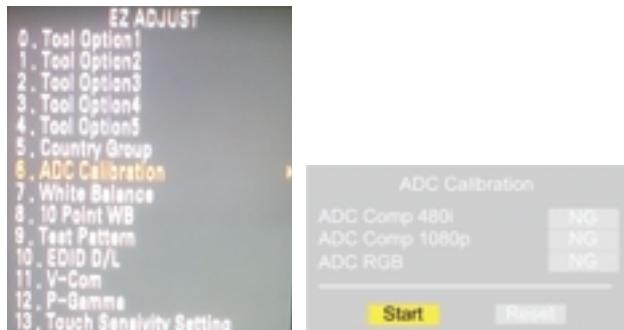
32LV3400-DG_LGD	18400	9226	53289	26904	288
32LV2500-DG_CMI	18212	19478	55337	26904	352
32LV2500-DG_LGD	18208	19478	55337	26904	288
32LV2500-DG_AUO	18216	19478	55337	26904	352
32LV2450-DG_AUO		19478	55337	26904	352
26LV2500-DG_LGD	14112	8714	55337	26904	288
42LK450-DG_LGD	26240	18966	55305	26904	8450
37LK450-DG_LGD	22144	18966	55305	26904	8450
32LK450-DG_AUO	18056	18966	55305	26904	290
32LK450-DG_LGD	18048	18966	55305	26904	8482
32LK330-DH_AUO	17992	18966	51209	26904	290
32LK330-DH_LGD	17984	18966	51209	26904	290
26LK330-DH_AUO	13896	18966	51209	26904	290
22LK330-DH_CMI	9796	18966	51209	26904	256
22LV2500-DG_AUO	10024	8714	55337	26904	288
22LV2500-DG_CMI	10020	8714	55337	26904	288
19LV2500-DG_AUO	5928	8714	55337	26904	288

4. Completed selecting Tool option.

3.1. ADC Process

(1) ADC

- Enter Service Mode by pushing "ADJ" key
- Enter Internal ADC mode by pushing "G" key at "6. ADC Calibration"



* Caution: Using 'power on' button of the Adj. R/C, power on TV.

* ADC Calibration Protocol (RS232)

No.	Item	CMD1	CMD2	Data0
1	Enter Adjust Mode	A	A	0 0
2	ADC Adjust	A	D	0 0

- Adjust Sequence

- aa 00 00 [Enter Adjust Mode]
- xb 00 40 [Component1 Input (480i)]
- ad 00 10 [Adjust 480i Comp1]
- xb 00 60 [RGB Input (1024x768)]
- ad 00 10 [Adjust 1024x768 RGB]
- aa 00 90 [End Adjust Mode]

* Required equipment : Adjustment R/C

3.2. Function Check

- (1) Check display and sound
 - Check Input and Signal items. (cf. work instructions)
 - 1) TV
 - 2) AV (CVBS)
 - 3) COMPONENT (480i)
 - 4) RGB (PC : 1024 x 768 @ 60hz)
 - 5) HDMI
 - 6) PC Audio In

* Display and sound check is executed by remote control.

* Caution :Not to push the INSTOP KEY after completion if the function inspection.

4. Total Assembly line process

4.1. Adjustment Preparation

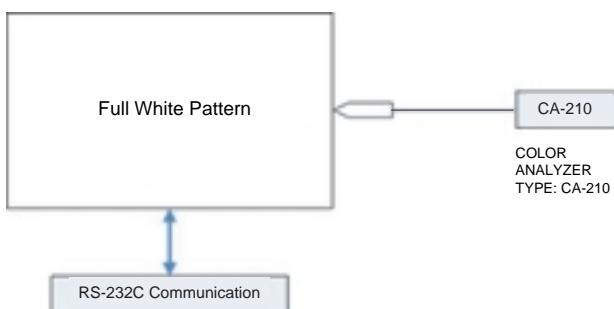
- W/B Equipment condition
CA210 : CH 9, Test signal : Inner pattern (85IRE)
- Above 5 minutes H/run in the inner pattern. ("power on" key of adjust remote control)

Cool	13,000k	°K	X=0.269(±0.002) Y=0.273(±0.002)	All <Test Signal> Inner pattern (216gray,85IRE)
Medium	9,300k	°K	X=0.285(±0.002) Y=0.293(±0.002)	
Warm	6,500k	°K	X=0.313(±0.002) Y=0.329(±0.002)	

Cool	9,300k	°K	X=0.285(±0.002) Y=0.293(±0.002)	Only 22LD350 <Test Signal> Inner pattern (216gray,85IRE)
Medium	8,000k	°K	X=0.295(±0.002) Y=0.305(±0.002)	
Warm	6,500k	°K	X=0.313(±0.002) Y=0.329(±0.002)	

4.1.1. Connecting picture of the measuring instrument (On Automatic control)

Inside PATTERN is used when W/B is controlled. Connect to auto controller or push Adjustment R/C POWER ON -> Enter the mode of White-Balance, the pattern will come out



4.1.2. Auto-control interface and directions

- 1) Adjust in the place where the influx of light like floodlight around is blocked. (illumination is less than 10ux).
- 2) Adhere closely the Color Analyzer (CA210) to the module less than 10cm distance, keep it with the surface of the Module and Color Analyzer's Probe vertically.(80~100°).
- 3) Aging time
 - After aging start, keep the power on (no suspension of power supply) and heat-run over 15minutes.
 - Using 'no signal' or 'full white pattern' or the others, check the back light on.

4.1.3. Auto adjustment Map (RS-232C)

RS-232C COMMAND

[CMD ID DATA]

Wb 00 00 White Balance Start

Wb 00 ff White Balance End

	RS-232C COMMAND			MIN	CENTER			MAX
	[CMD ID DATA]				(DEFAULT)			
	Cool	Mid	Warm		Cool	Mid	Warm	
R Gain	jg	Ja	jd	00	172	192	192	255
G Gain	jh	Jb	je	00	172	192	192	255
B Gain	ji	Jc	jf	00	192	192	172	255
R Cut					64	64	64	128
G Cut					64	64	64	128
B Cut					64	64	64	128

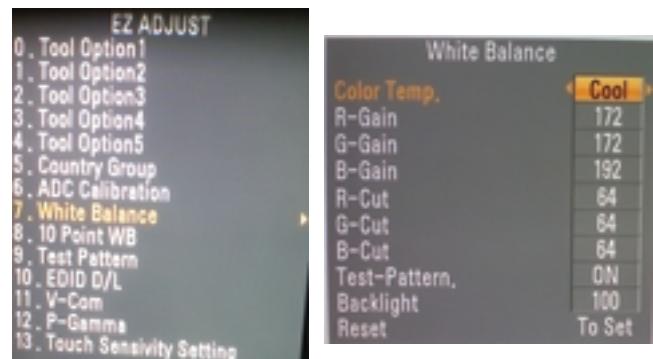
** Caution **

Color Temperature : COOL, Medium, Warm.

One of R Gain/G Gain/ B Gain should be kept on 0xC0, and adjust other two lower than C0. (when R/G/B Gain are all C0, it is the FULL Dynamic Range of Module)

*Manual W/B process using adjusts Remote control.

- After enter Service Mode by pushing "ADJ" key,
- Enter White Balance by pushing "G" key at "7. White Balance".



After You finish all adjustments, Press "In-start" button and compare Tool option and Area option value with its BOM, if it is correctly same then unplug the AC cable. If it is not same, then correct it same with BOM and unplug AC cable. For correct it to the model's module from factory JIG model.

Push The "IN STOP KEY" after completing the function inspection. And Mechanical Power Switch must be set "ON".

4.2. DDC EDID Write (RGB 128Byte)

- Connect D-sub Signal Cable to D-Sub Jack.
- Write EDID DATA to EEPROM (24C02) by using DDC2B protocol.
- Check whether written EDID data is correct or not.
- * For SVC main Ass'y, EDID have to be downloaded to Insert Process in advance.

4.3 DDC EDID Write (HDMI 256Byte)

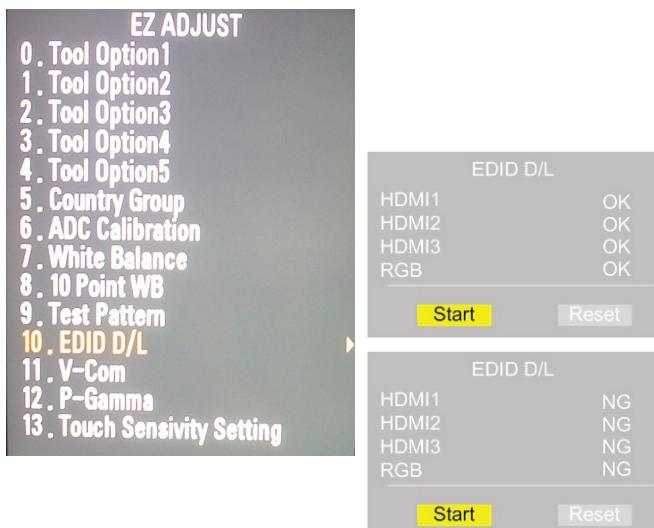
- Connect HDMI Signal Cable to HDMI Jack.
- Write EDID DATA to EEPROM(24C02) by using DDC2B protocol.
- Check whether written EDID data is correct or not.
- * For SVC main Ass'y, EDID have to be downloaded to Insert Process in advance.

4.4 EDID DATA

- 1) All Data : HEXA Value
- 2) Changeable Data :
 - *: Serial No : Controlled / Data:01
 - **: Month : Controlled / Data:00
 - ***:Year : Controlled
 - ****:Check sum

- Auto Download

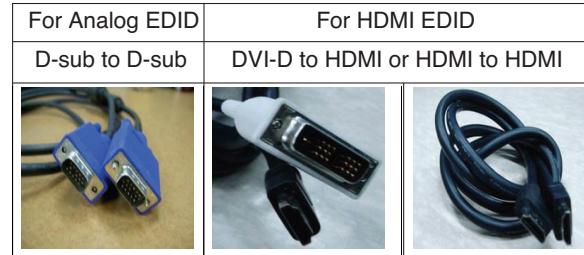
- After enter Service Mode by Pushing "ADJ" key
 - Enter EDID D/L mode.
 - Enter "START" by pushing "OK" key.
- HDMI number is dependent on model.



- Manual Download

* Caution

- 1) Use the proper signal cable for EDID Download
 - Analog EDID : Pin3 exists
 - Digital EDID : Pin3 exists
- 2) Never connect HDMI & D-sub Cable at the same time.
- 3) Use the proper cables below for EDID Writing.
- 4) Download HDMI1, HDMI2 separately because each data is different.



Item	Condition	Data(Hex)
Manufacturer ID	GSM	1E6D
Version	Digital : 1	01
Revision	Digital : 3	03

(1) FHD RGB EDID Data (CS : 1C)

Addr	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
0000	00	FF	FF	FF	FF	FF	FF	00	1E	6D	01	00	01	01	01	01
0010	01	15	01	03	68	10	09	78	0A	EE	91	A3	54	4C	99	26
0020	0F	50	54	A1	08	00	81	80	61	40	45	40	31	40	01	01
0030	01	01	01	01	01	02	3A	80	18	71	38	2D	40	58	2C	
0040	45	00	A0	5A	00	00	00	1E	01	1D	00	72	51	D0	1E	20
0050	6E	28	55	00	A0	5A	00	00	00	1E	00	00	00	FD	00	3A
0060	3E	1E	53	10	00	0A	20	20	20	20	20	20	20	00	00	FC
0070	00	4C	47	20	54	56	0A	20	20	20	20	20	20	20	00	1C
0080	FF															
0090	FF															
00A0	FF															
00B0	FF															
00C0	FF															
00D0	FF															
00E0	FF															
00F0	FF															

(2) FHD HDMI 1 EDID Data (CS : E299)

Addr	00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
0000	00	FF	FF	FF	FF	FF	FF	00	1E	6D	01	00	01	01	01	01
0010	01	15	01	03	80	10	09	78	0A	EE	91	A3	54	4C	99	26
0020	0F	50	54	A1	08	00	71	4F	81	80	01	01	01	01	01	01
0030	01	01	01	01	01	02	3A	80	18	71	38	2D	40	58	2C	
0040	45	00	A0	5A	00	00	00	1E	1B	21	50	A0	51	00	1E	30
0050	48	88	35	00	A0	5A	00	00	00	1C	00	00	00	FD	00	3A
0060	3E	1E	53	10	00	0A	20	20	20	20	20	20	20	00	00	FC
0070	00	4C	47	20	54	56	0A	20	20	20	20	20	20	20	01	E2
0080	02	03	26	F1	4E	10	1F	84	13	05	14	03	02	12	20	21
0090	22	15	01	26	15	07	50	09	57	07	67	03	0C	00	10	00
00A0	B8	2D	E3	05	03	01	01	1D	80	18	71	1C	16	20	58	2C
00B0	25	00	A0	5A	00	00	00	9E	01	1D	00	72	51	D0	1E	20
00C0	6E	28	55	00	A0	5A	00	00	00	1E	02	3A	80	18	71	38
00D0	2D	40	58	2C	45	00	A0	5A	00	00	00	00	1E	01	1D	00
00E0	52	D0	1E	20	B8	28	55	40	A0	5A	00	00	00	1E	00	00
00F0	00	00	00	00	00	00	00	00	00	00	00	00	00	00	00	99

(9) ASCII Code

	0	1	2	3	4	5	6	7	8	9	A	B	C	D	E	F
20		!	"	#	\$	%	&	'	()	*	,	-	.	/	
30	0	1	2	3	4	5	6	7	8	9	:	;	<	=	>	?
40	@	A	B	C	D	E	F	G	H	I	J	K	L	M	N	O
50	P	Q	R	S	T	U	V	W	X	Y	Z	[\]	^	_
60	~	a	b	c	d	e	f	g	h	i	j	k	l	m	n	o
70	p	q	r	s	t	u	v	w	x	y	z	{	}		~	
80																
90																
A0																
B0																
C0																
D0																
E0																
F0																

4.5. Outgoing condition Configuration

- When pressing IN-STOP key by SVC remocon, Red LED are blinked alternatively. And then Automatically turn off.
(Must not AC power OFF during blinking)

4.6 GND & Hi-pot test

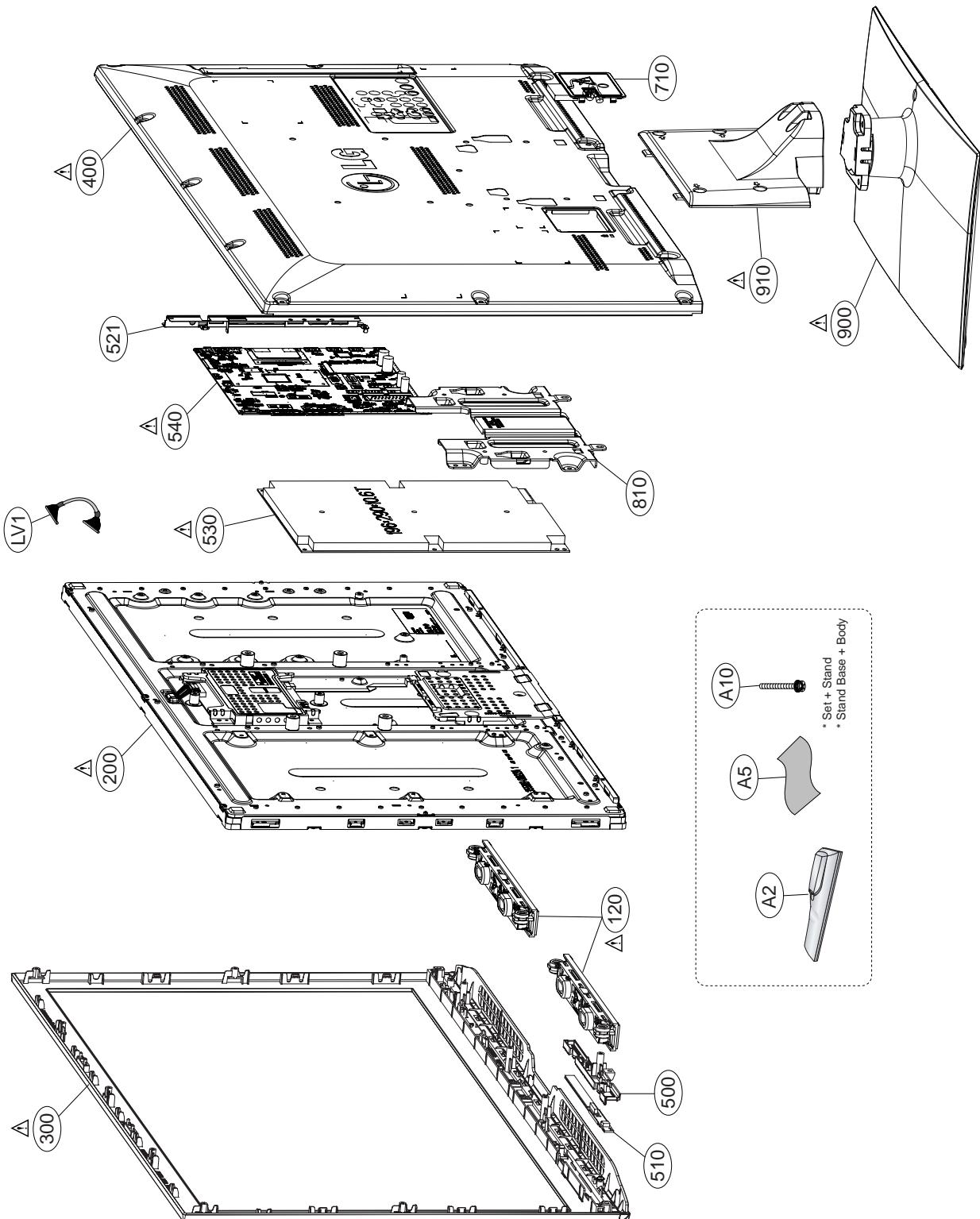
Confirm whether is normal or not when between power board's ac block and GND is impacted on 1.5kV(dc) or 2.2kV(dc) for one second.

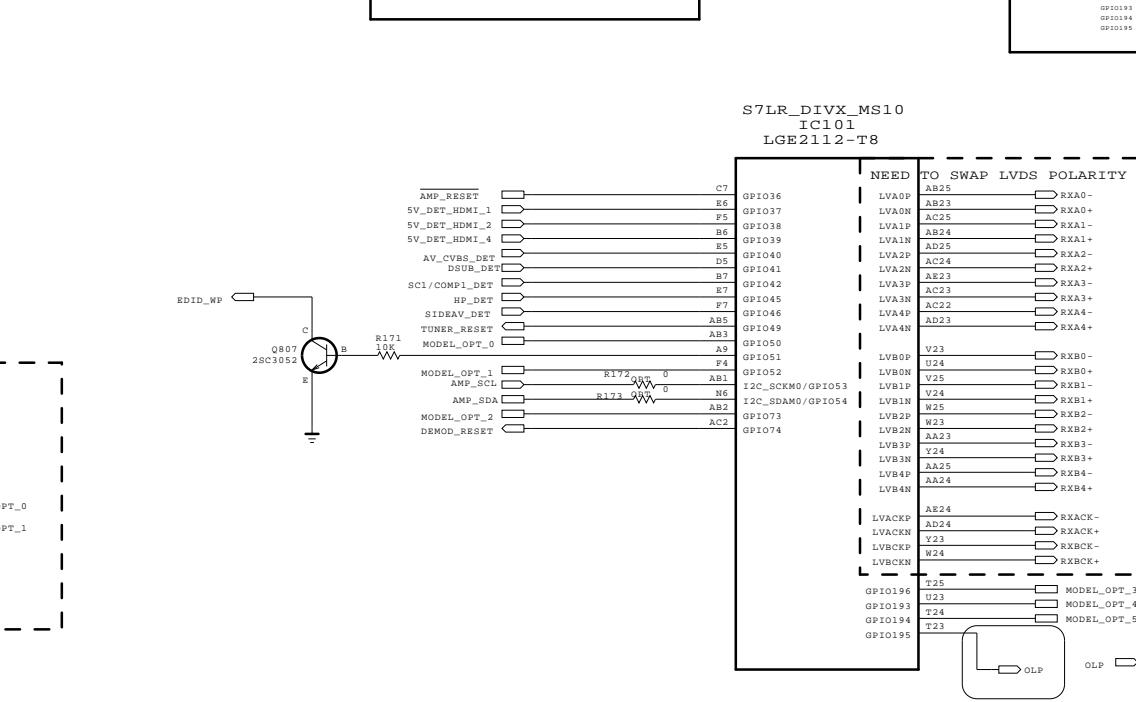
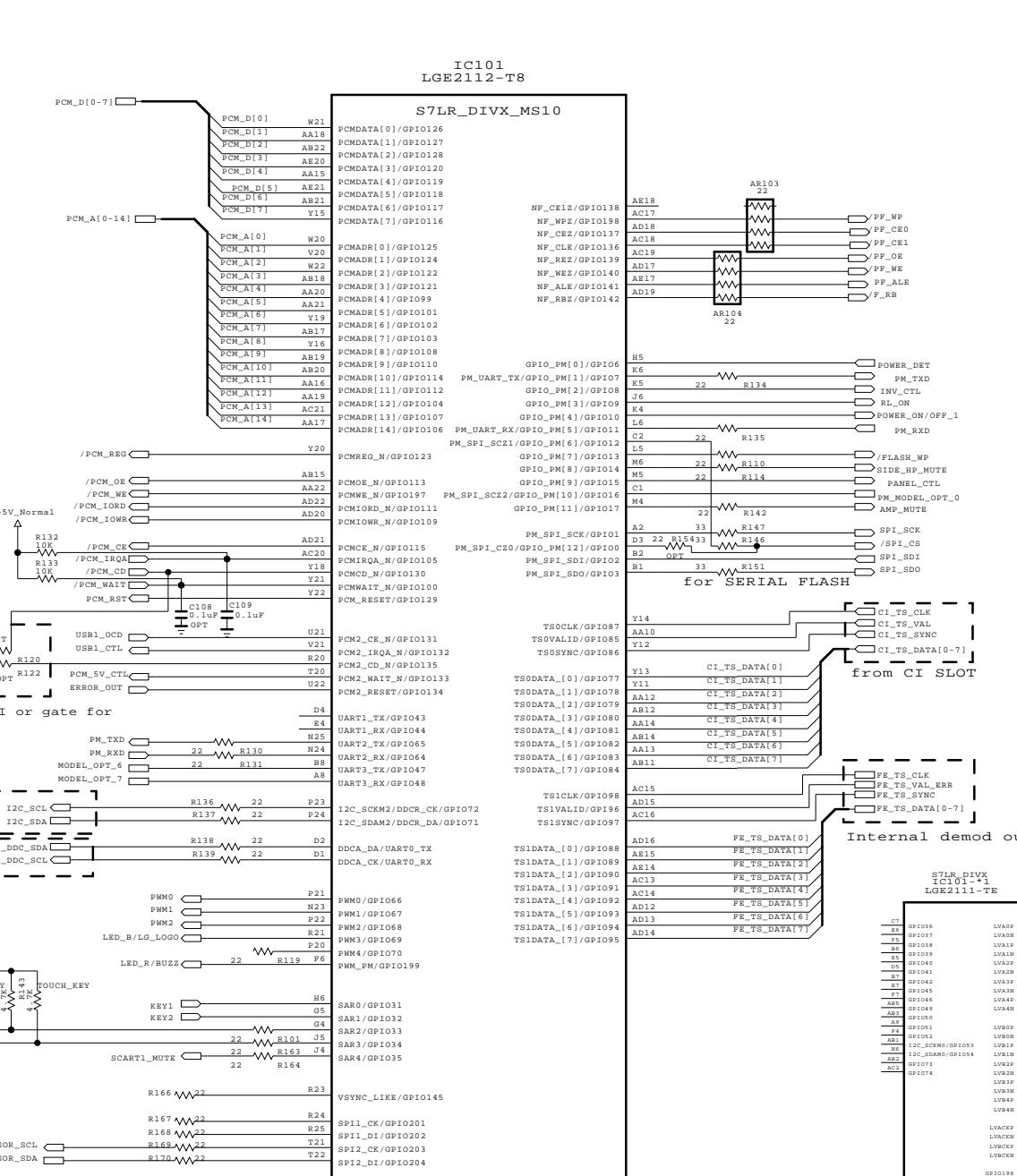
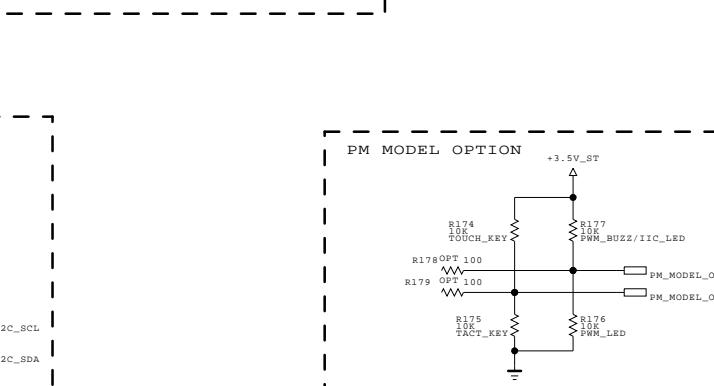
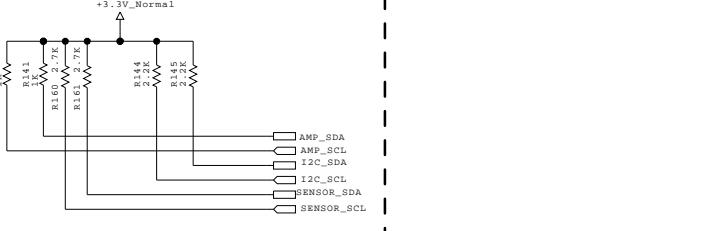
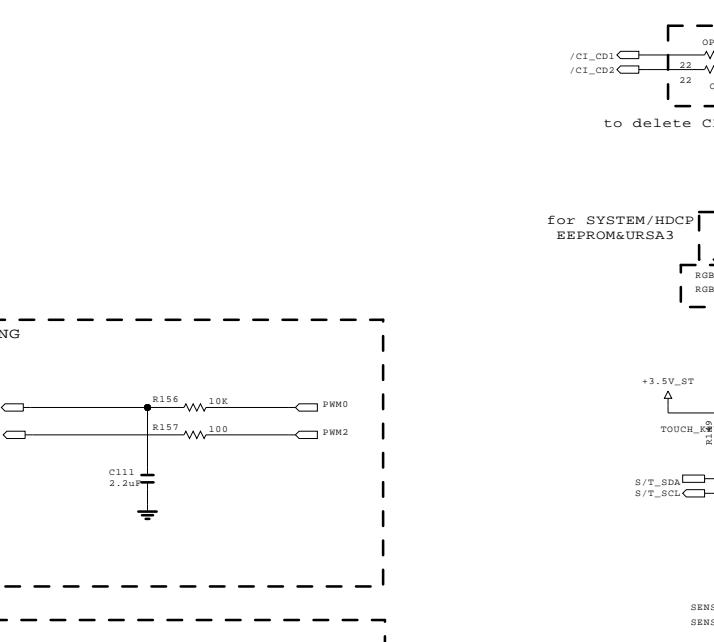
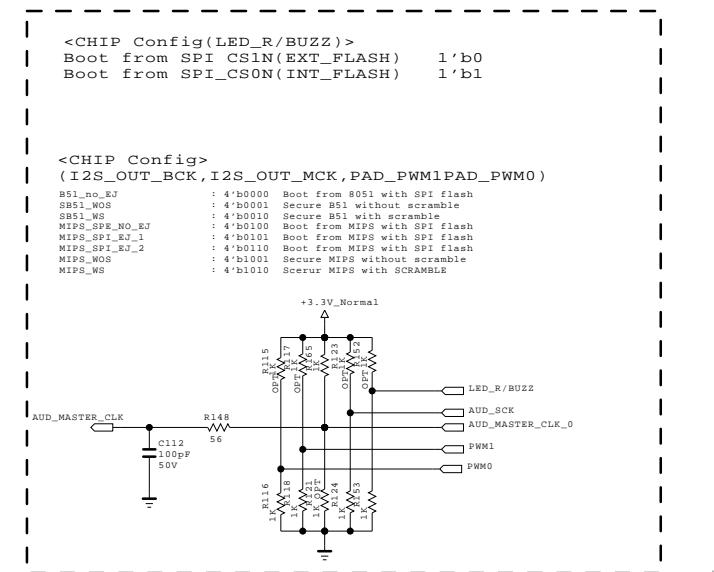
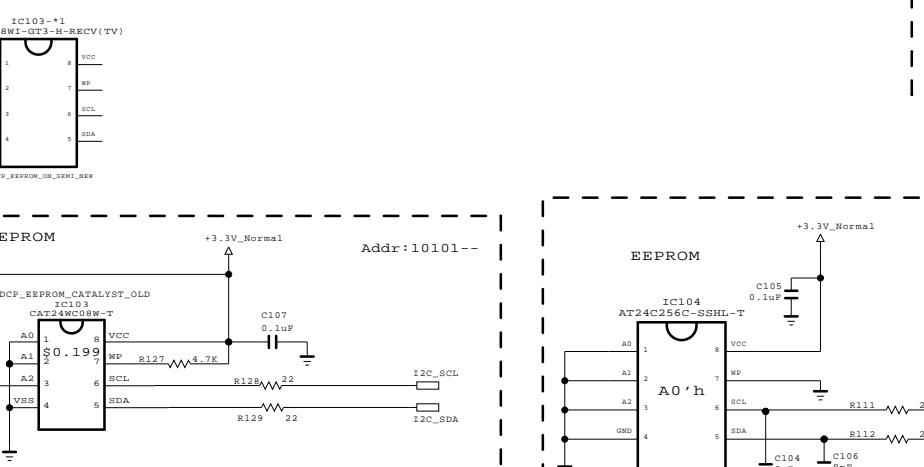
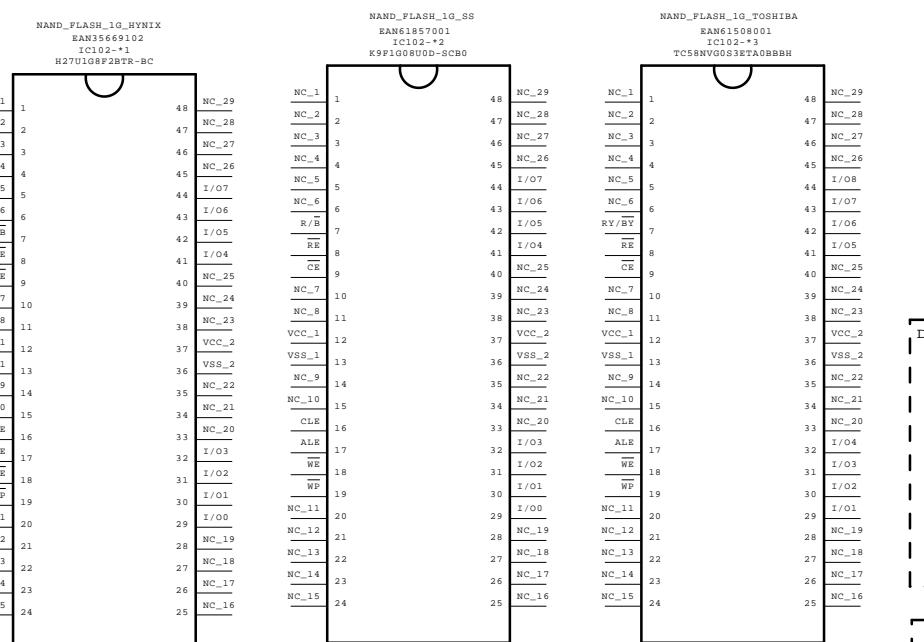
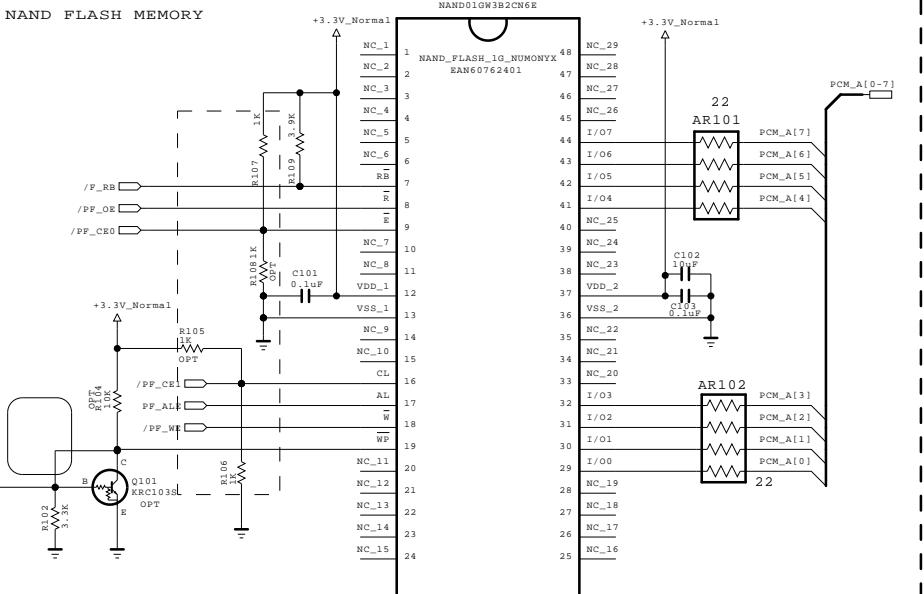
- GND TEST = POWER CORD GND and SIGNAL CABLE GND
- Hi-pot TEST = POWER CORD GND and LIVE&NUETRAL
- Test Process
 1. Check the POWER CABLE and SIGNAL CABLE insertion condition.
 2. Connect the AV JACK Tester
 3. Controller(GWS103-4) on
 4. GND TEST(Auto)
 - If Test is failed, Buzzer operate
 - If Test is passed, execute next process(Hi-pot test)
 - Remove A/V CORD from A/V JACK BOX
 5. HI-POT test(Auto)
 - If Test is failed, Buzzer operate
 - If Test is passed, GOOD Lamp on and move to next process automatically.

EXPLODED VIEW

IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by \triangle in the Schematic Diagram and EXPLODED VIEW.
It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent X-RADIATION, Shock, Fire, or other Hazards.
Do not modify the original design without permission of manufacturer.



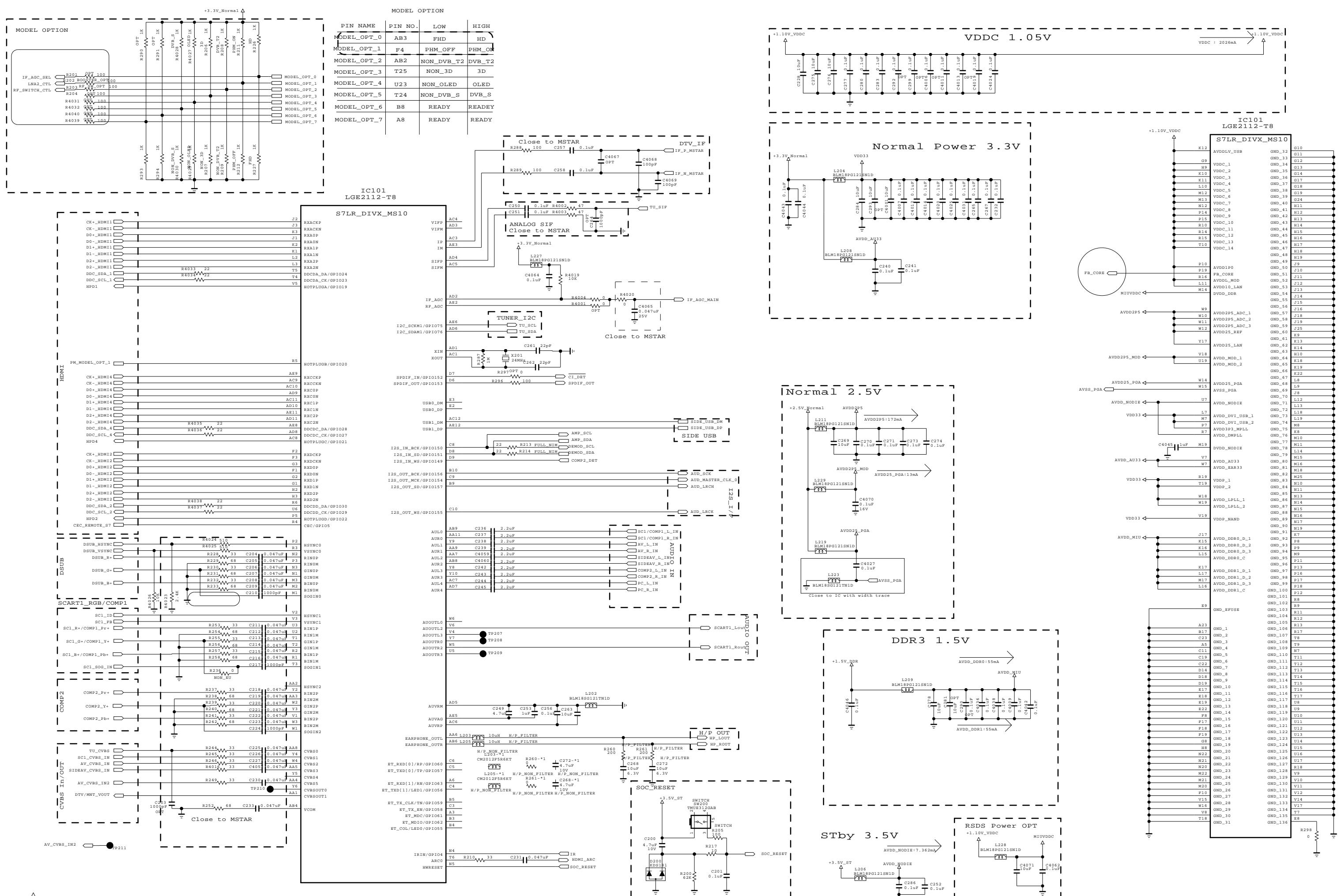


THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION, FIRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

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LG Electronics

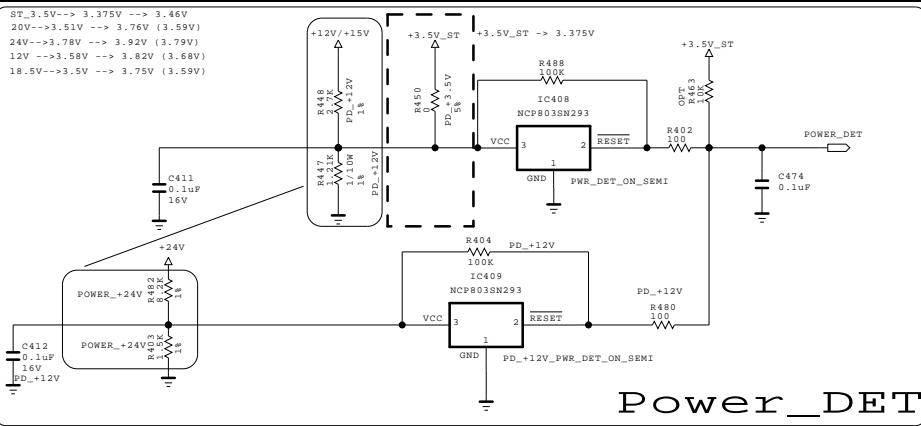
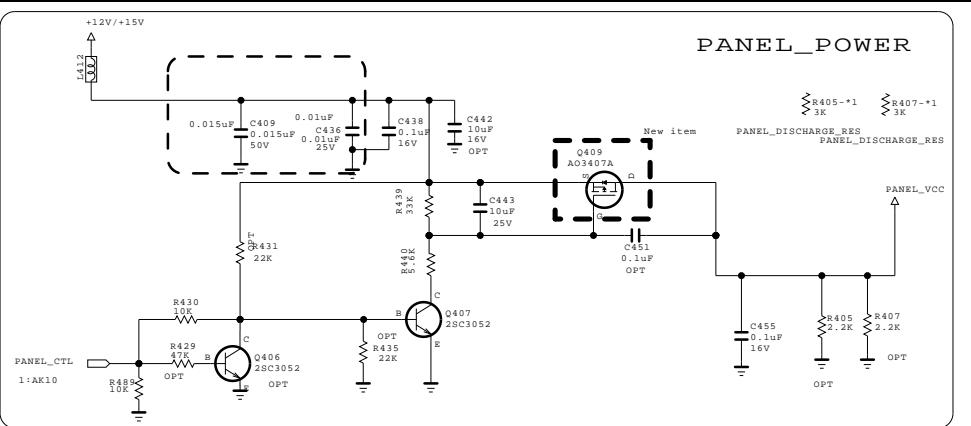
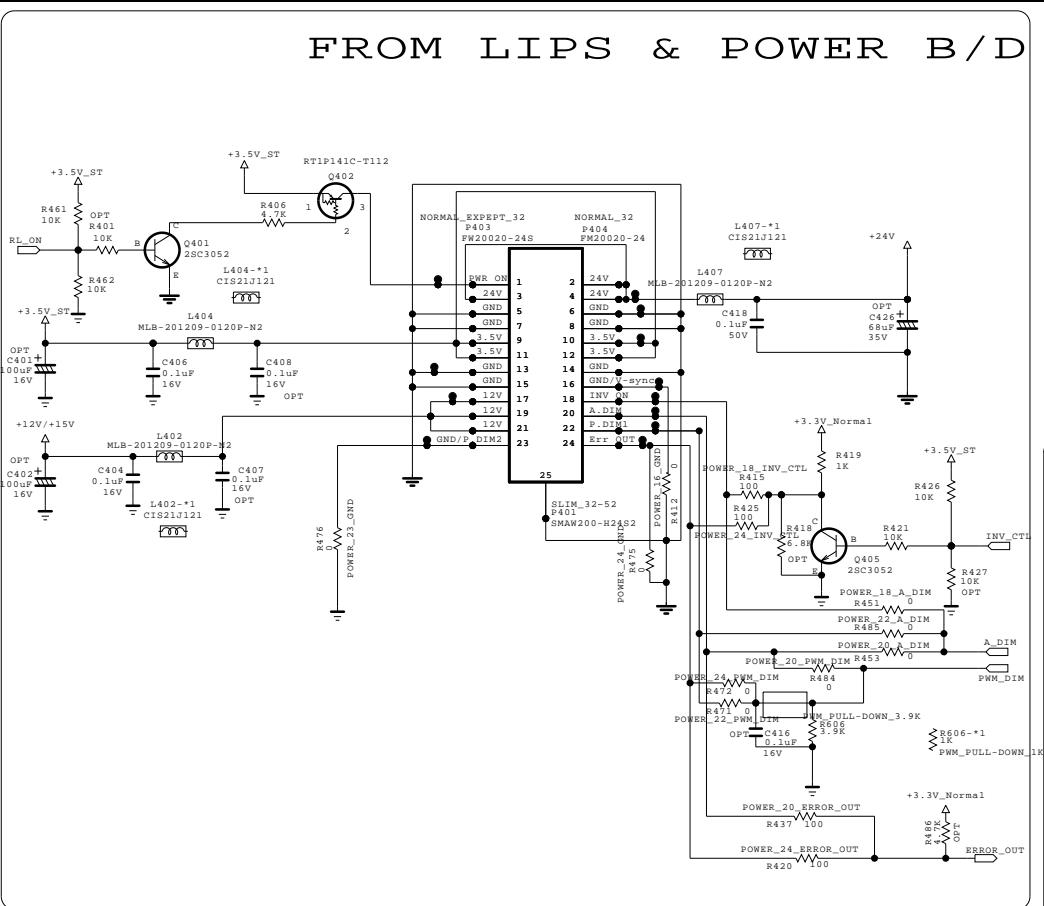
LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110511
BLOCK	FLASH/EEPROM/GPIO	SHEET	1

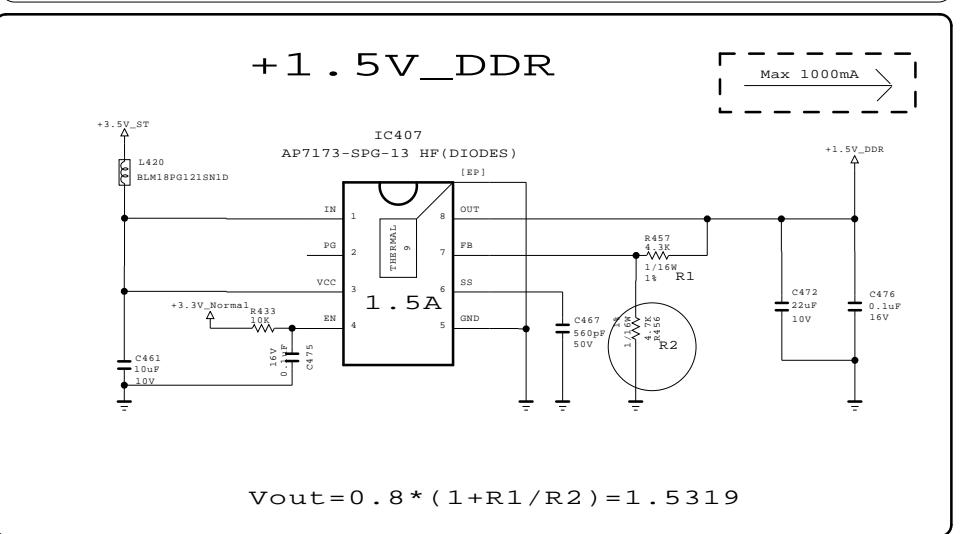


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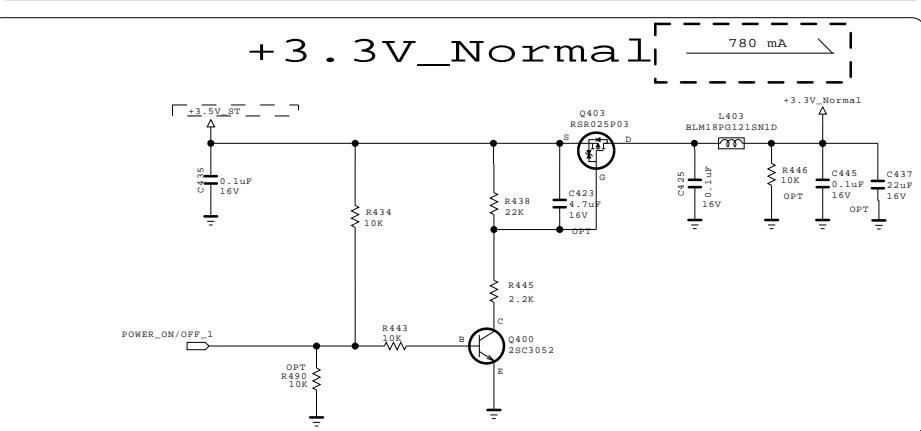
FROM LIPS & POWER B/D



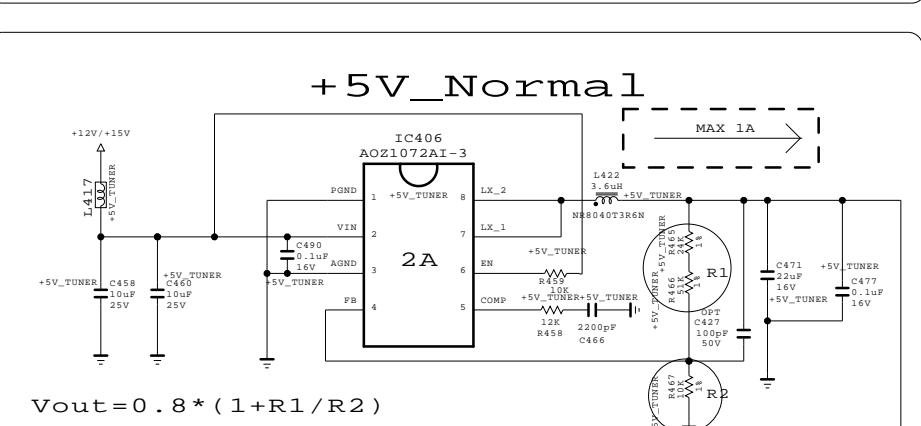
+1.5V_DDR



+3.3V_Normal



+5V_Normal



<MODULE PIN MAP>

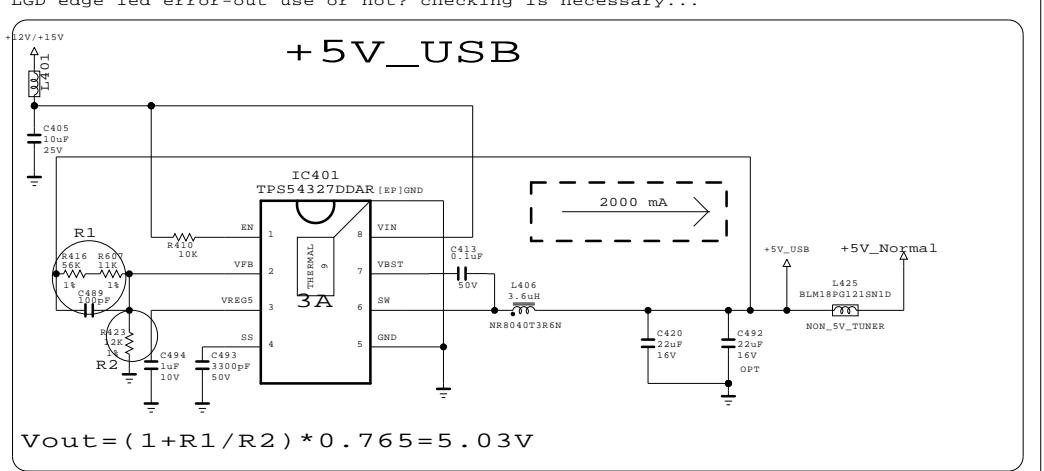
PIN NO	LGD(PSU) or LIPS	CMO10* Lamp (PSU)	AUO 10* Lamp (PSU)	SHARP (PSU)	IPS-@ (PSU)
16	GND	GND	GND	GND	GND
18	INV_ON	A-DIM	INV_ON	INV_ON	INV_ON
20	VBR-A	NC	Err_out	52/60:ERROR 26/32:HD:INC	Err_out
22	PWM_DIM	PWM_DIM	NC	26/32:52:PWM 60:INC	NC
24	Err_OUT	INV_ON	PWM_DIM	26/32:52:GND 60:PWM	PWM_DIM
23	GND	GND	GND	GND	GND

<LED MODULE PIN MAP -> latest update 20100618>

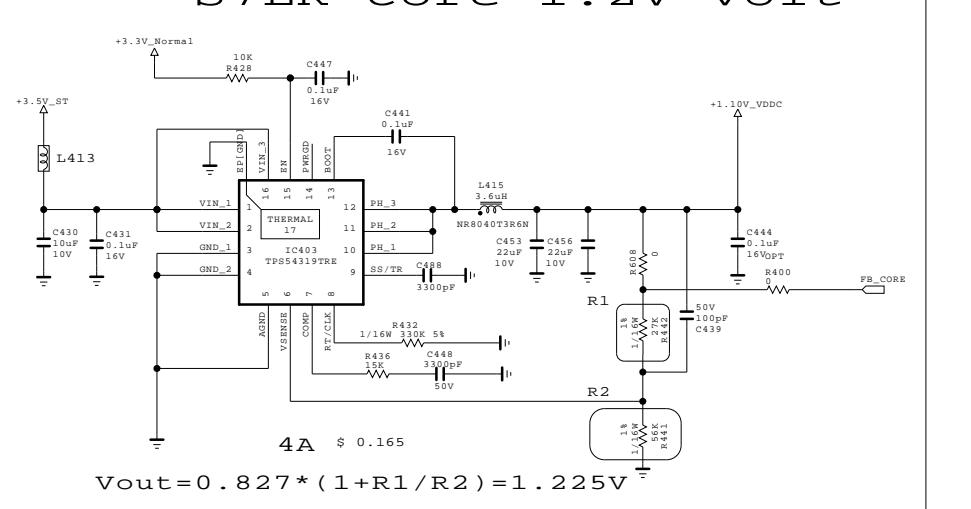
PIN No	LGD LPB / OS LPB (PSU)	3ZLE5300-TA CMO10*LED (PSU)	3ZLE5300-TA AIO 10*LED (PSU)	3ZLE5300-TA LGD 10*LED (PSU)
16	NC	NC	NC	NC
18	INV_ON	INV_ON	INV_ON	INV_ON
20	NC	err_out	err_out	NC
22	PWM_DIM	NC	NC	PWM_DIM
24	err_out	NC	PWM_DIM	err_out
23	NC	NC	NC	NC

LGD edge led error-out use or not? checking is necessary...

+5V_USB



S7LR core 1.2V volt



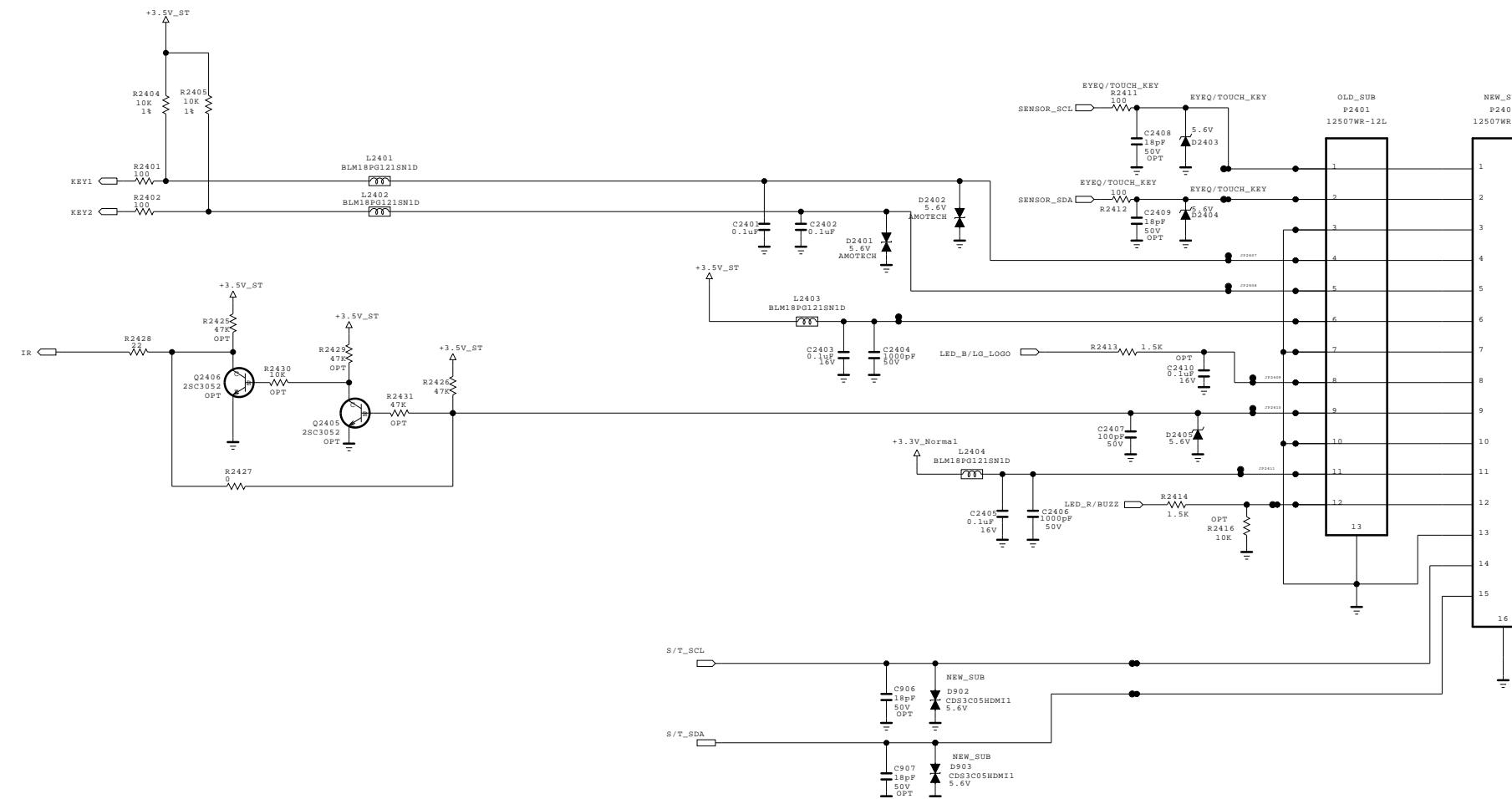
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LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110324
BLOCK	POWER_LARGE	SHEET	4

CONTROL
IR & LED

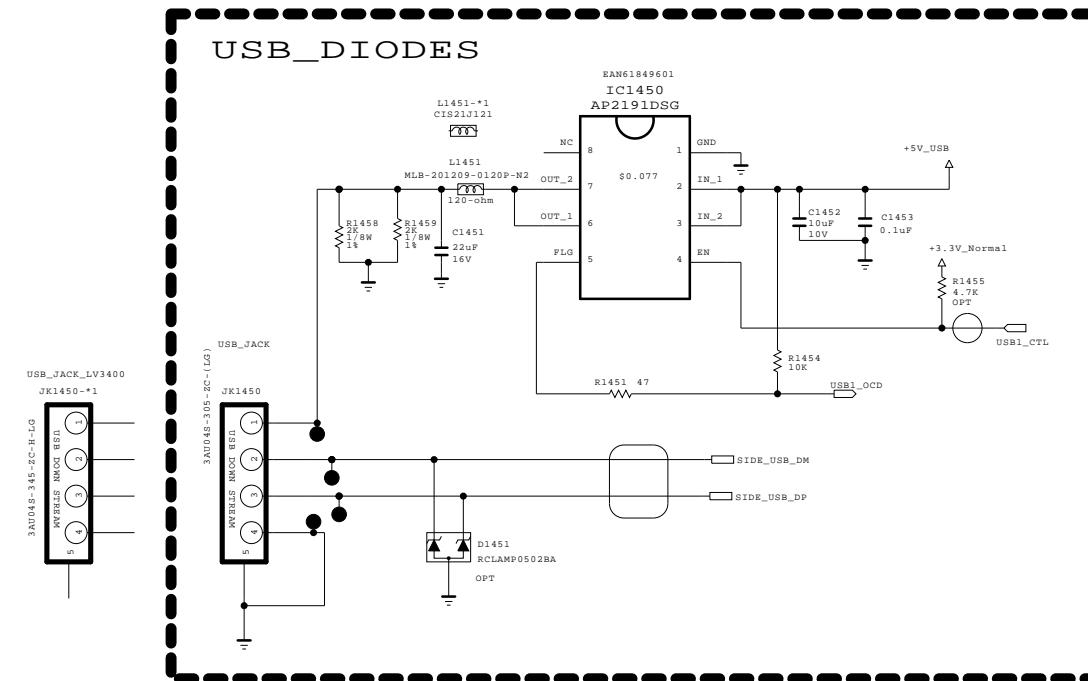


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LG Electronics

LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110324
BLOCK	IR / CONTROL - L	SHEET	6

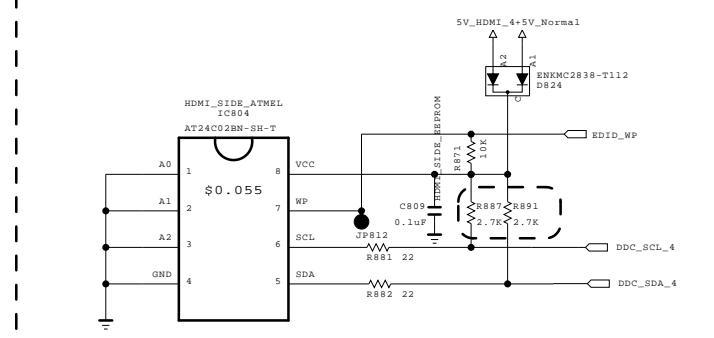
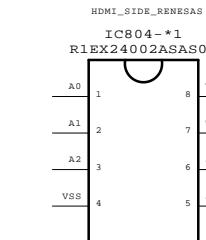
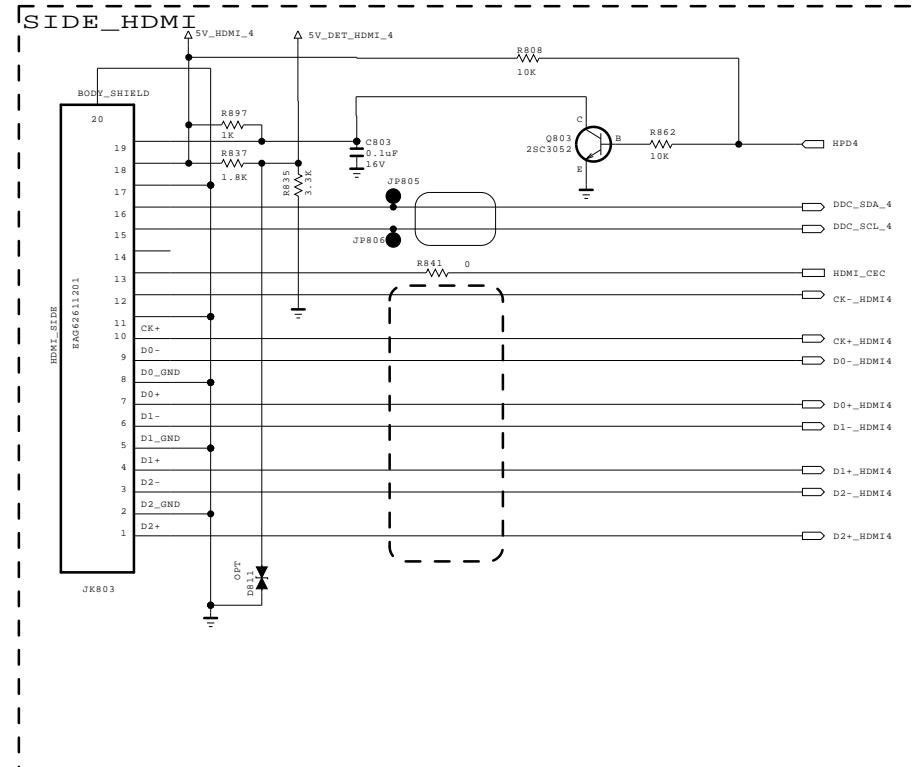
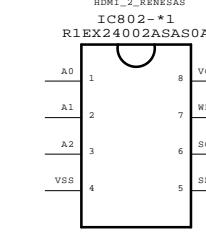
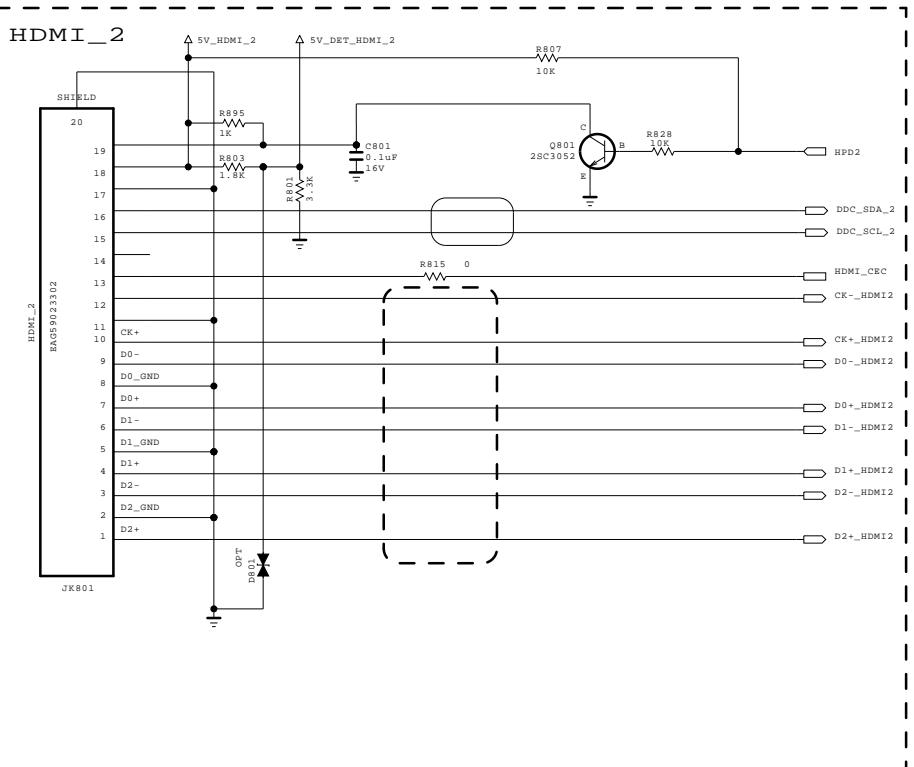
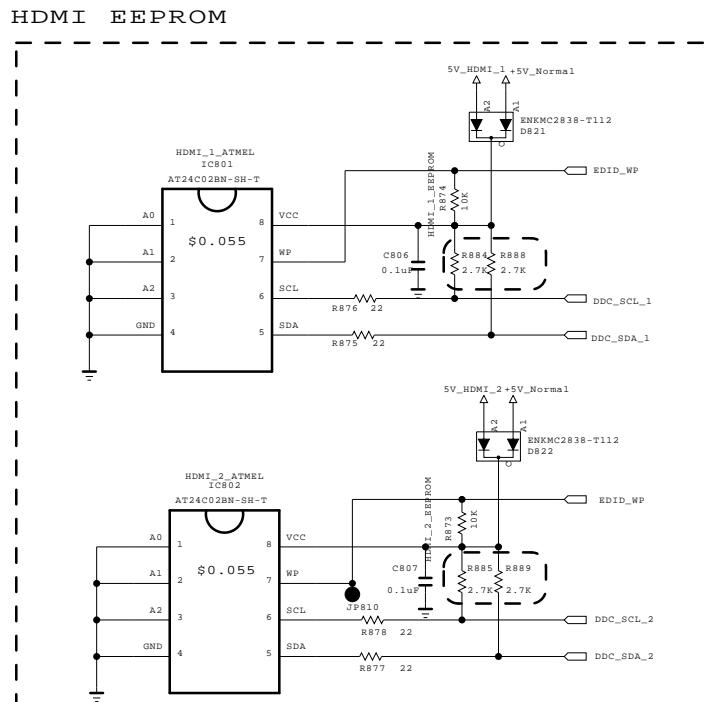
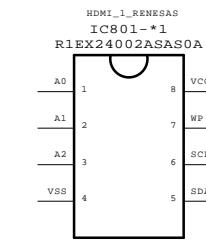
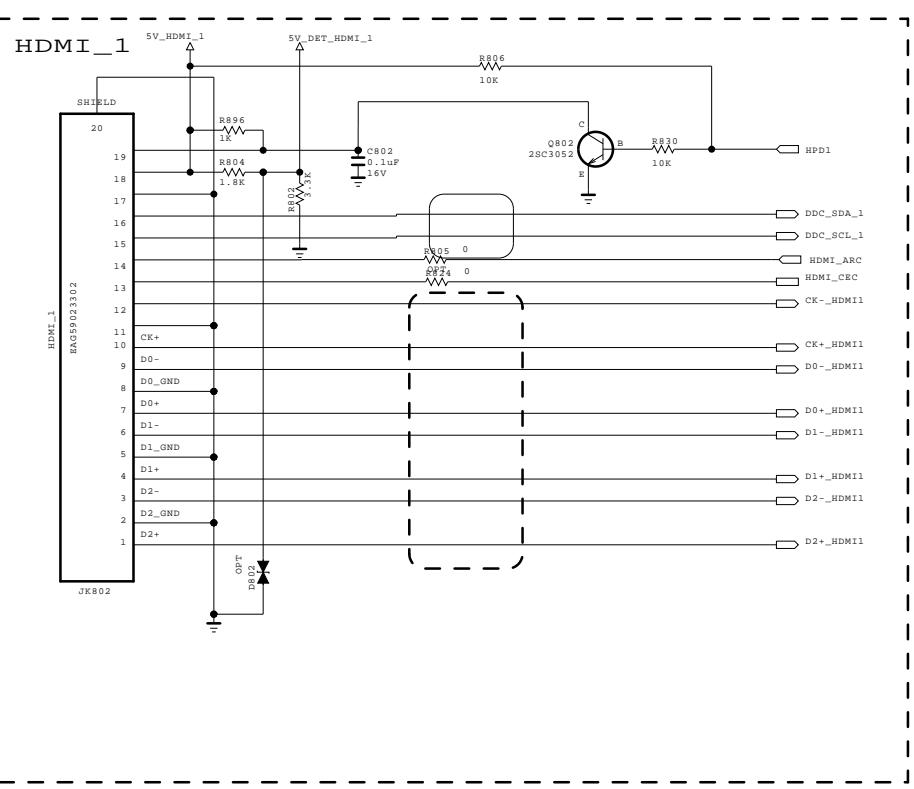


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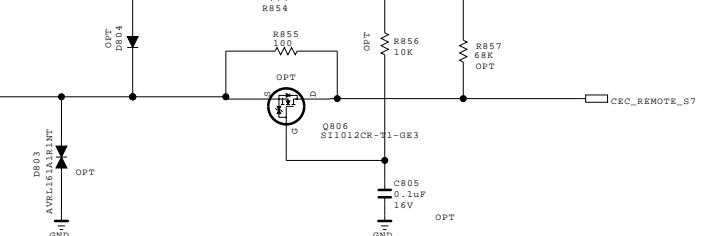
SECRET
LG Electronics

LG ELECTRONICS

MODEL	GP2R	DATE	20101023
BLOCK	USB_OCP_DIODE	SHEET	7



For CEC



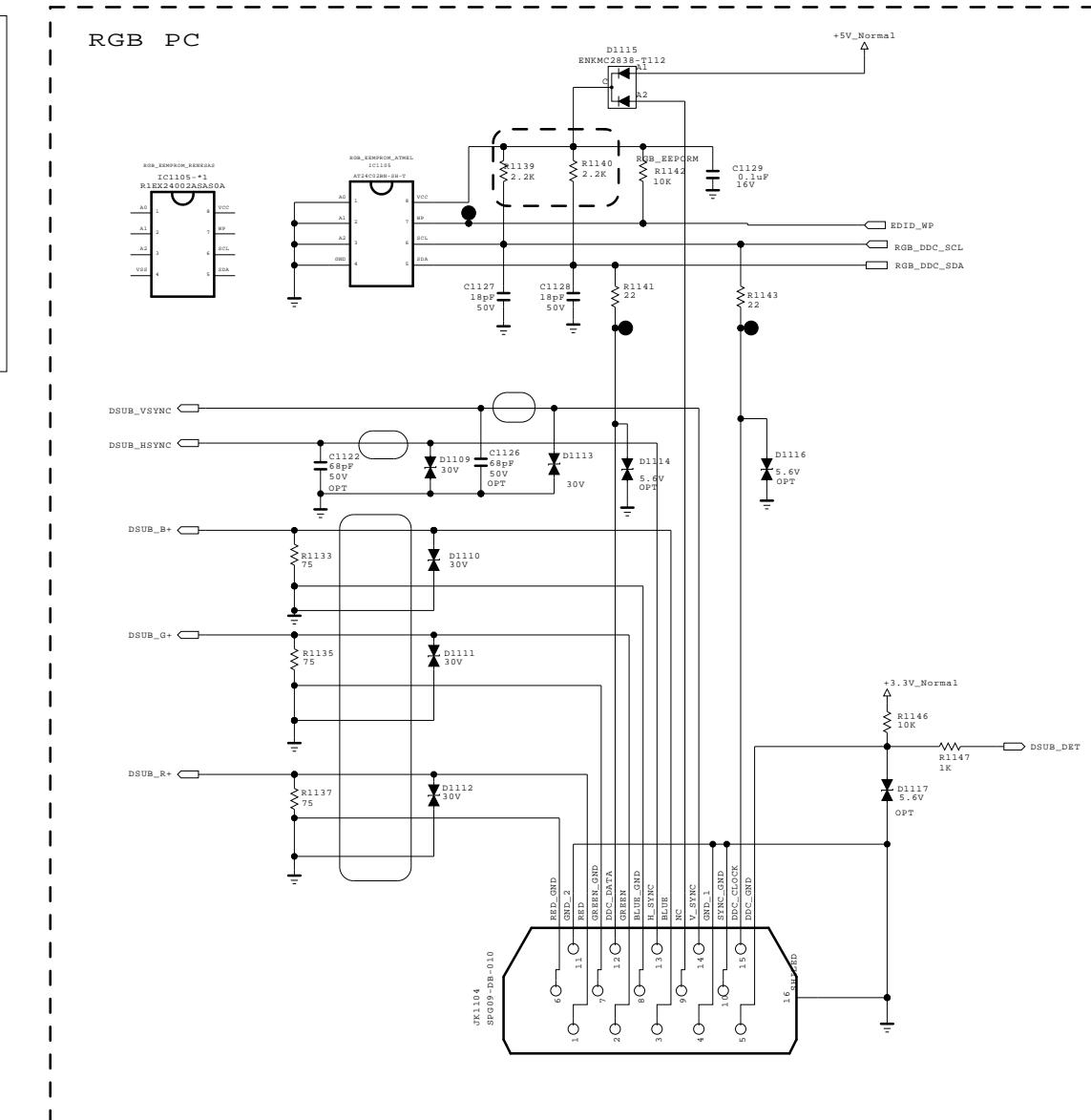
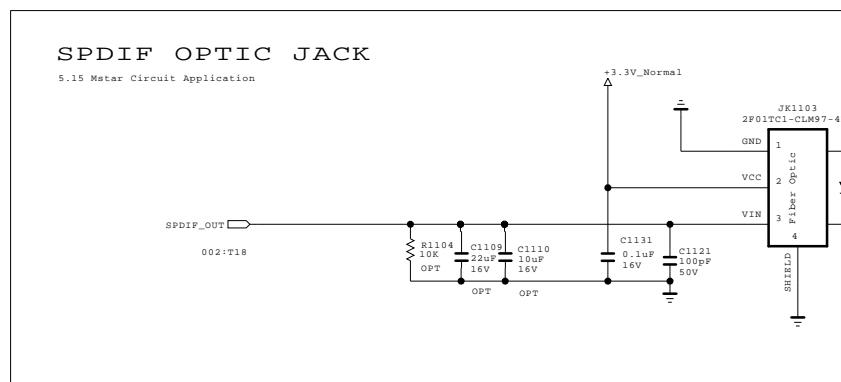
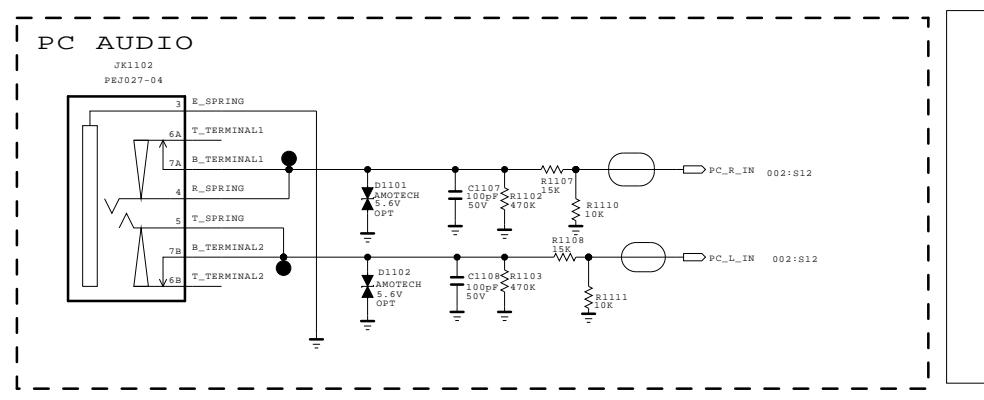
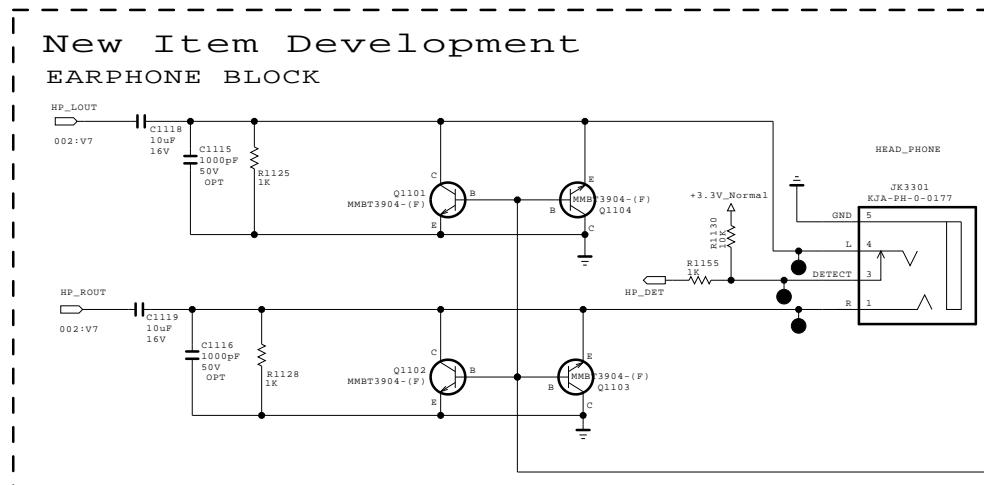
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MODEL	GP3_S7LR	DATE	20110324
BLOCK	HDMI	SHEET	8

RGB / SPDIF / PC / HP

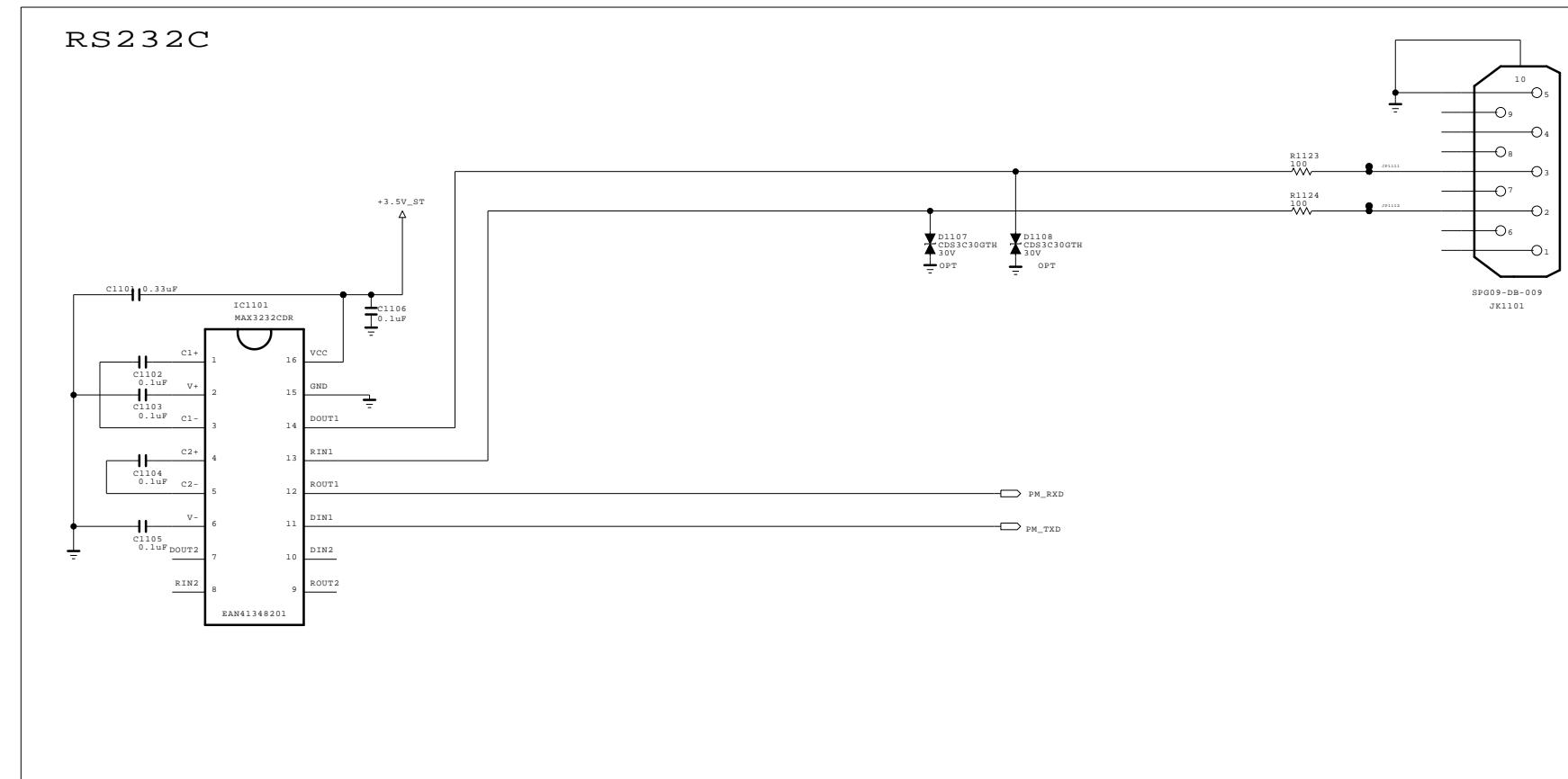


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LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110324
BLOCK	RGB / SPDIF / HP	SHEET	9



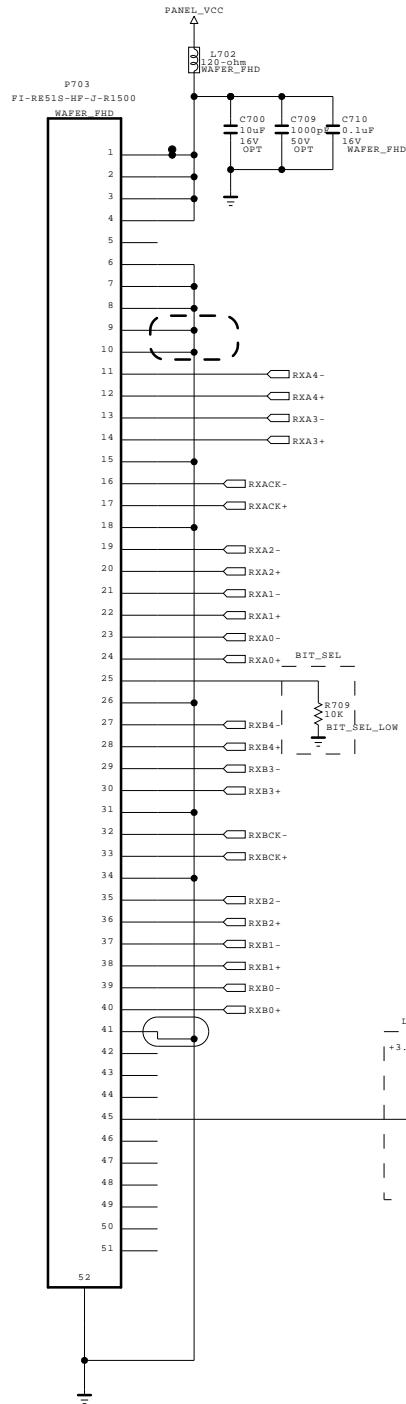
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LG Electronics

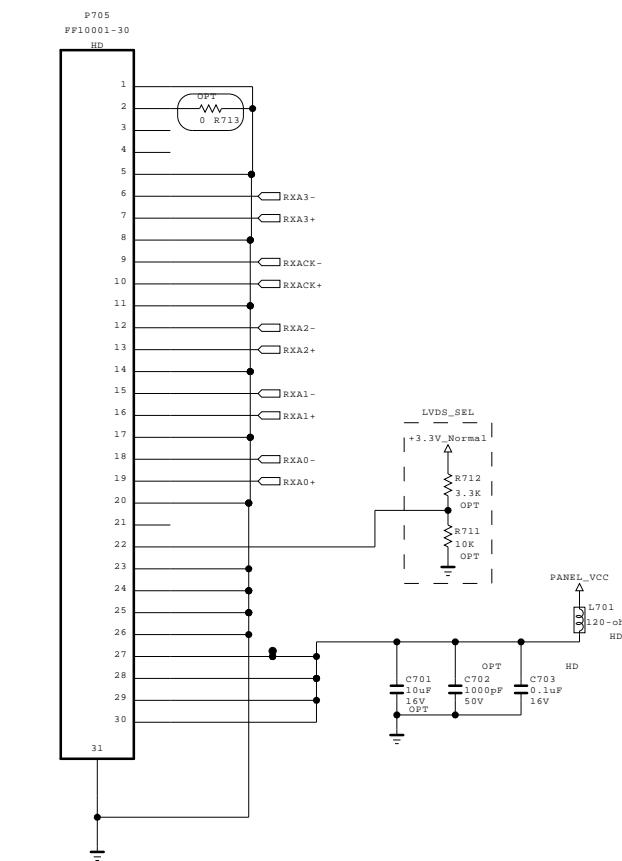
LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110324
BLOCK	RS232C_9PIN	SHEET	10

[51Pin LVDS Connector]
(For FHD 60/120Hz)



[30Pin LVDS Connector]
(For HD 60Hz_Normal)

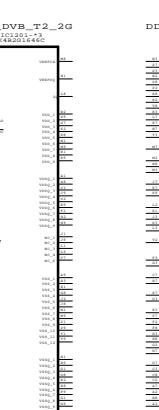
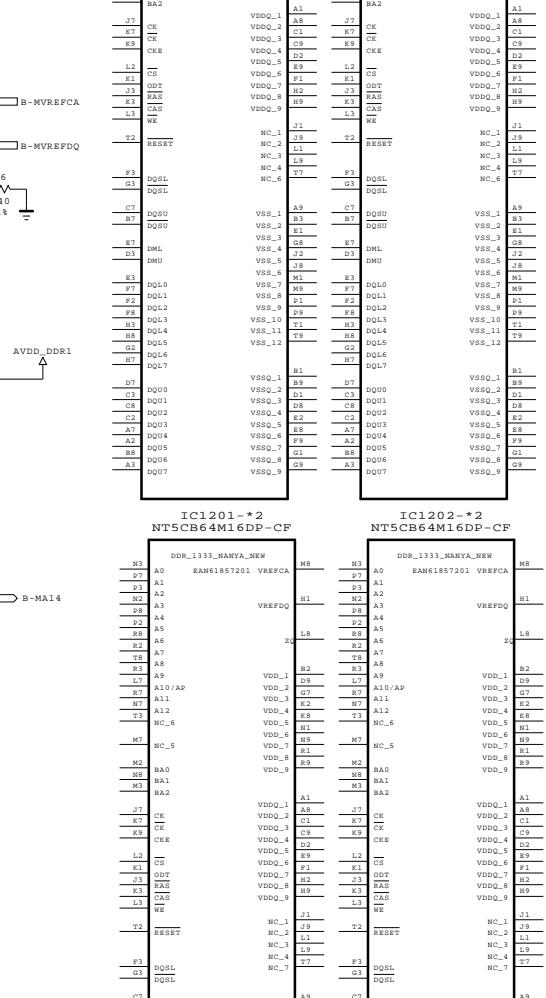
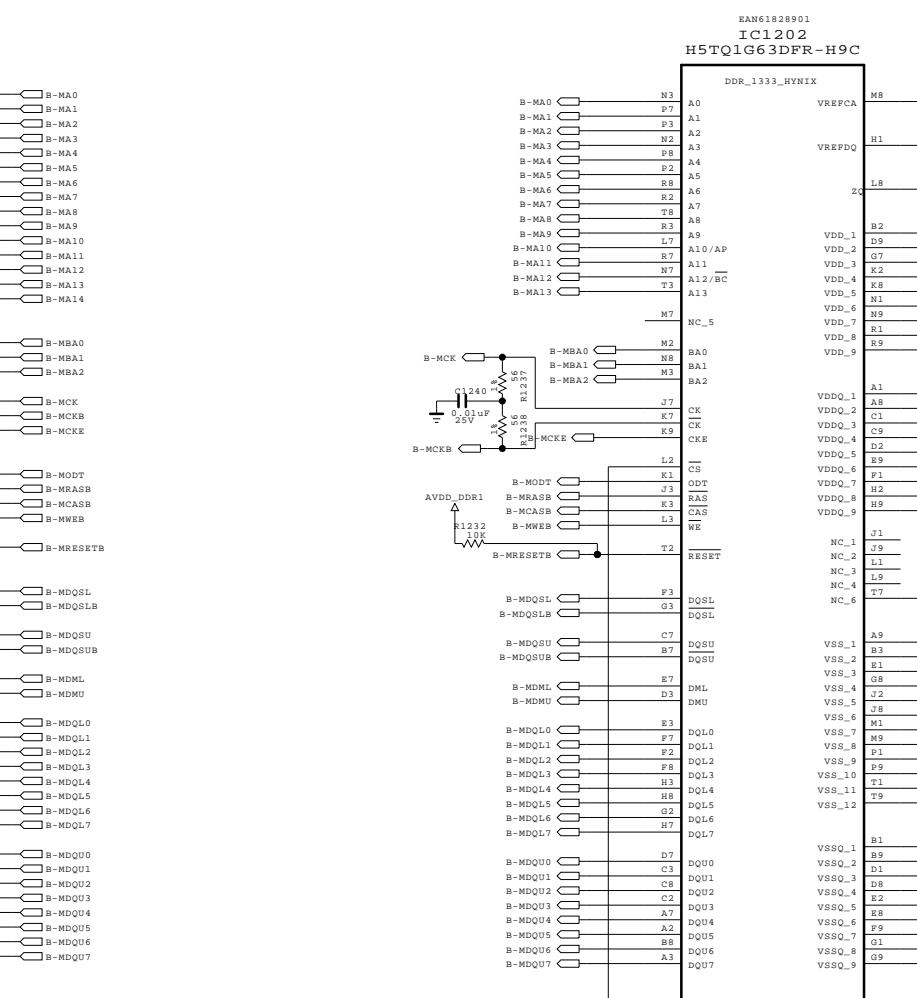
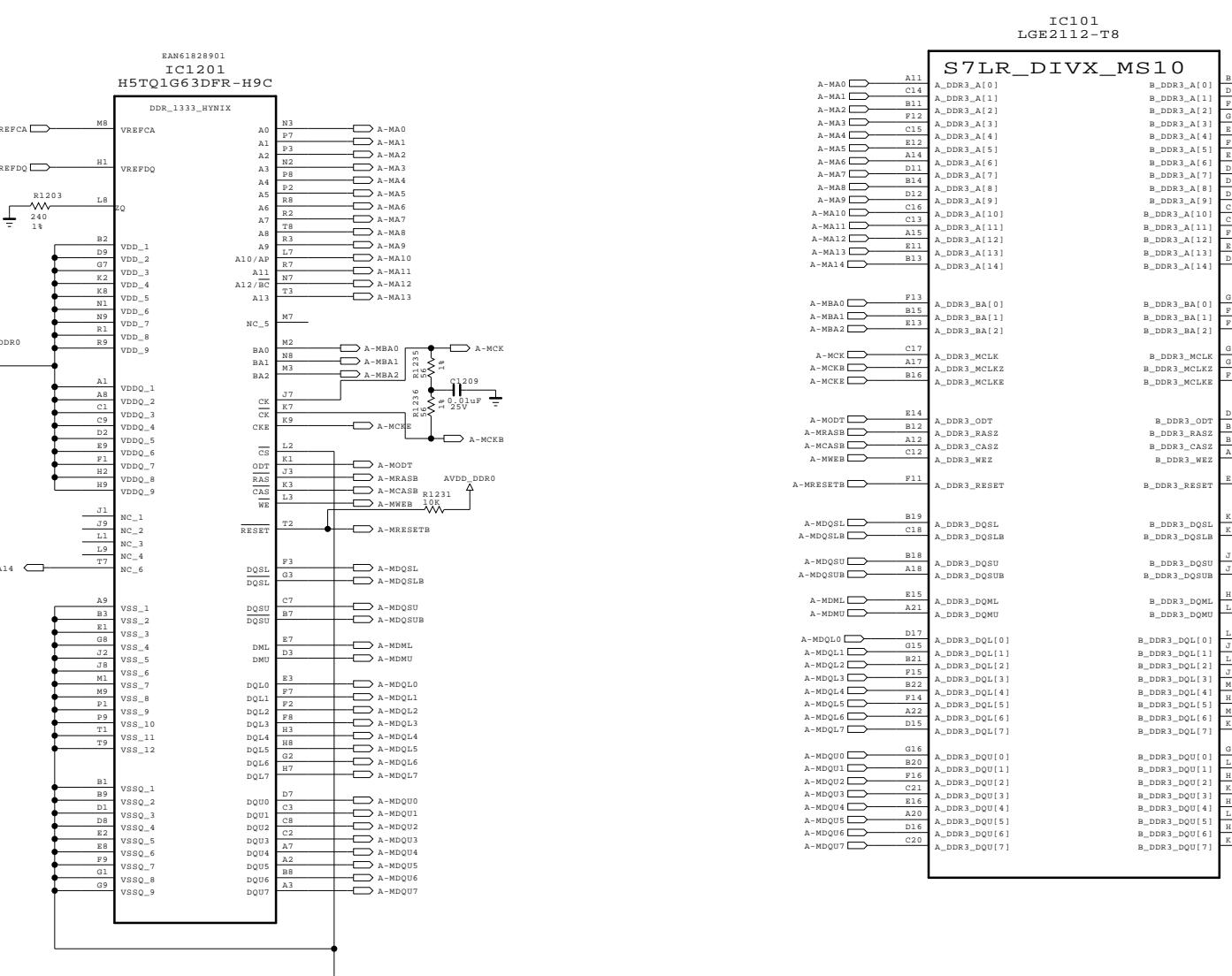
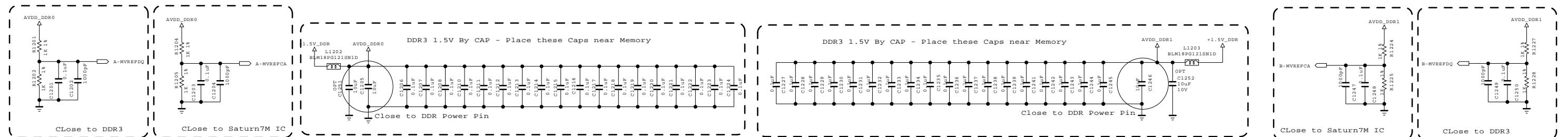


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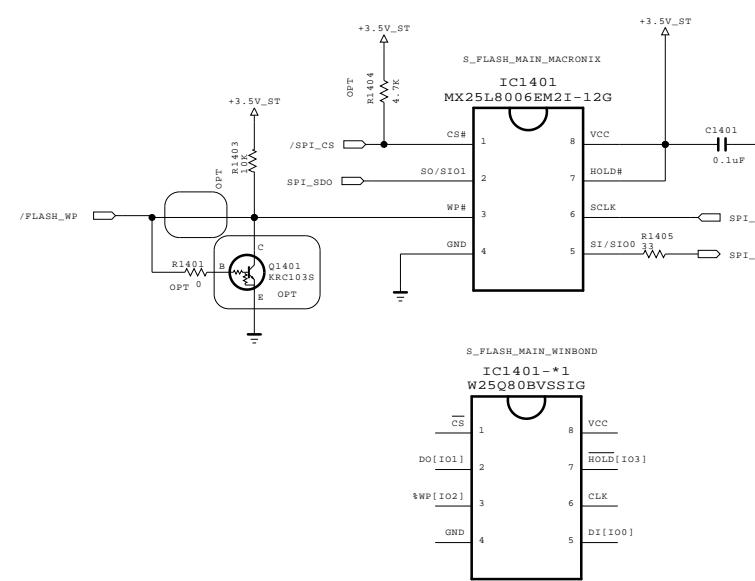
SECRET
LG Electronics

LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110324
BLOCK	LVDS_LARGE	SHEET	11



SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FIRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.



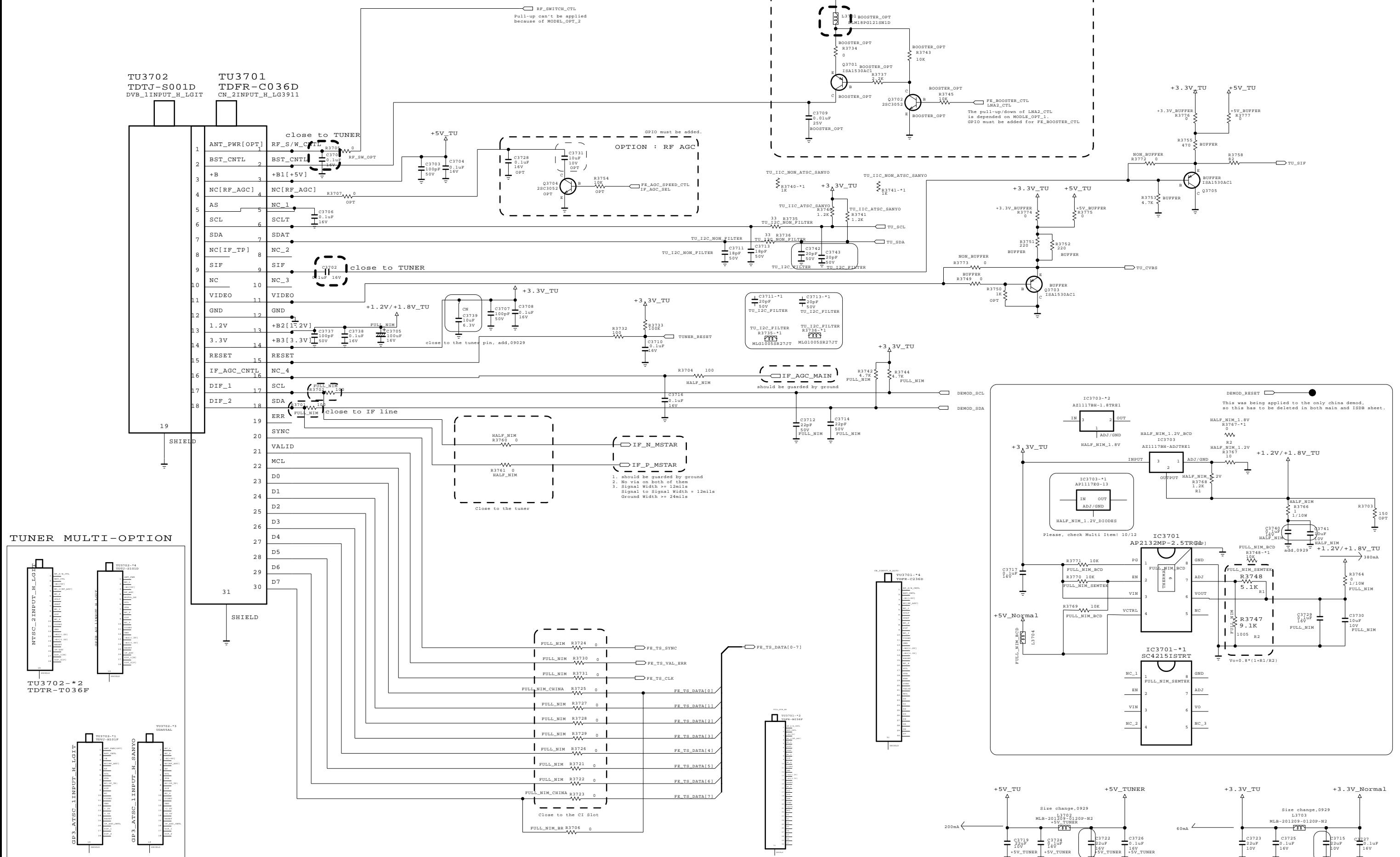
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LG ELECTRONICS

MODEL	GP3 S7LR	DATE	20110324
BLOCK	SFLASH	SHEET	13

GP4R_GLOBAL_TUNER_BLOCK

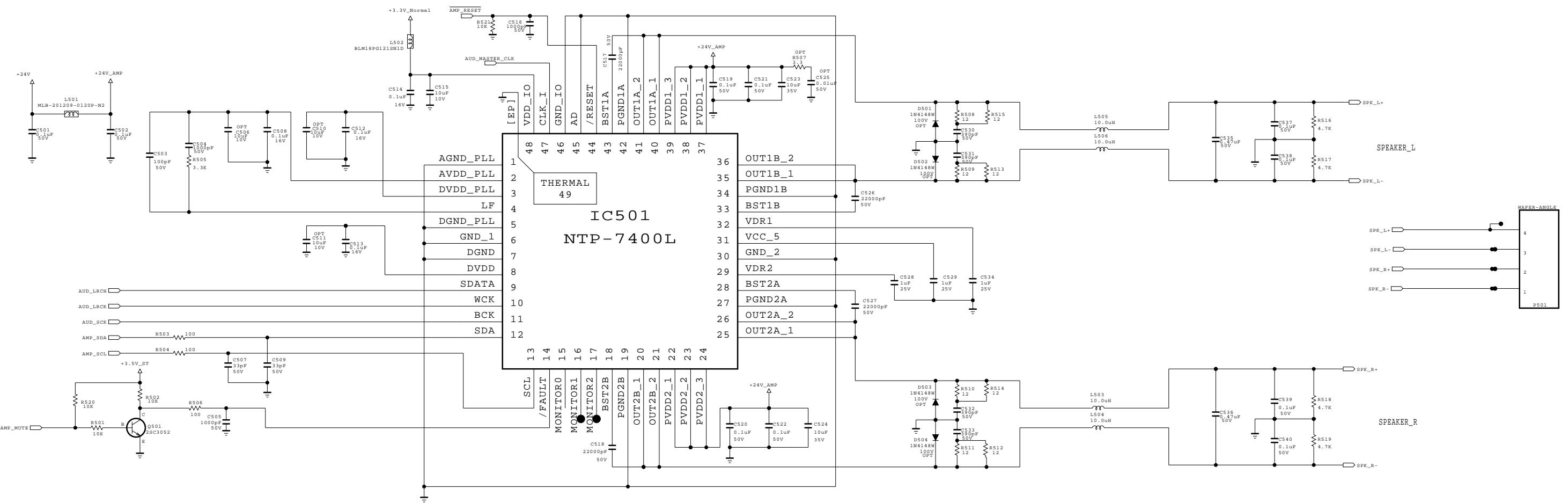


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SECRET

LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110511
BLOCK	TUNER L	SHEET	14 /



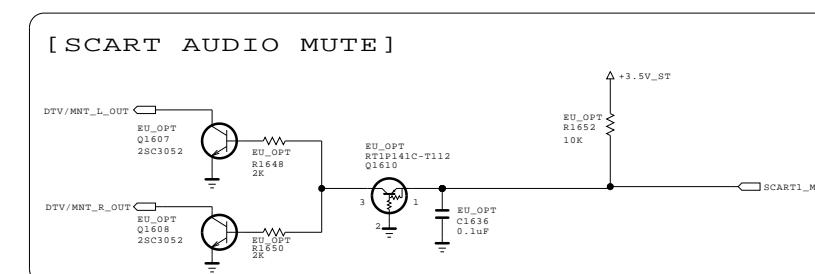
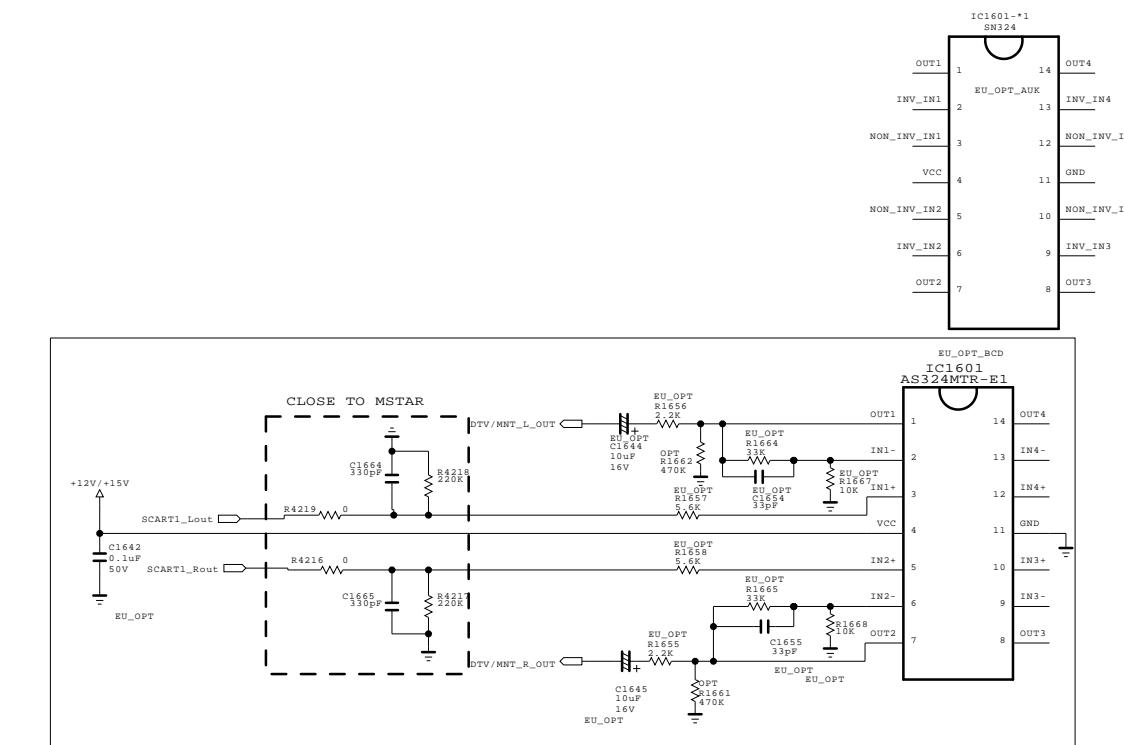
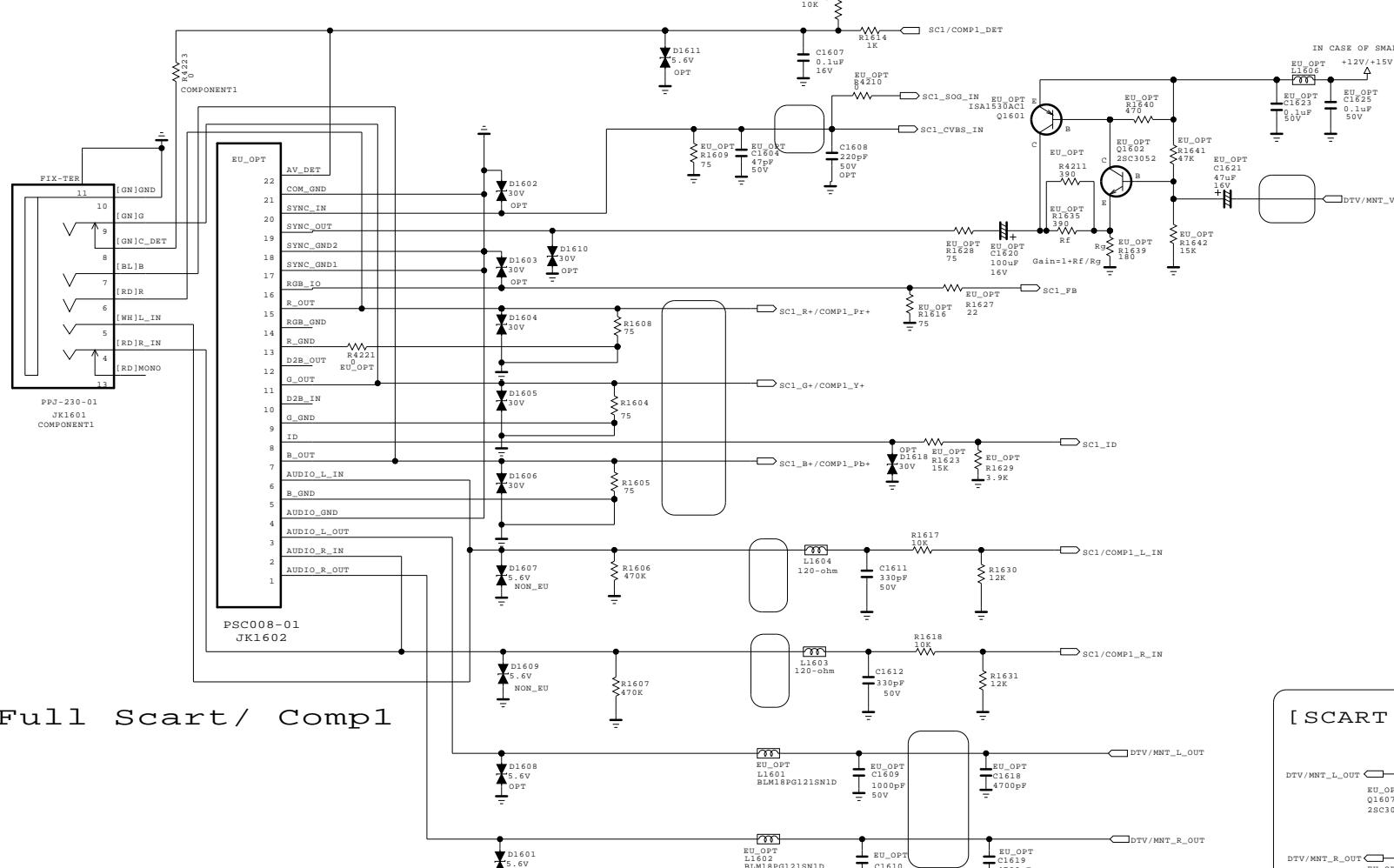
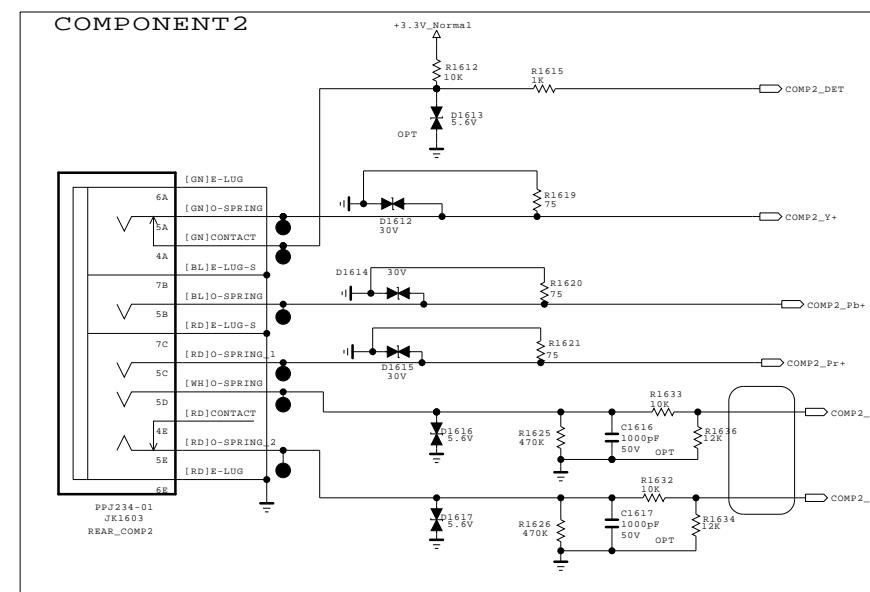
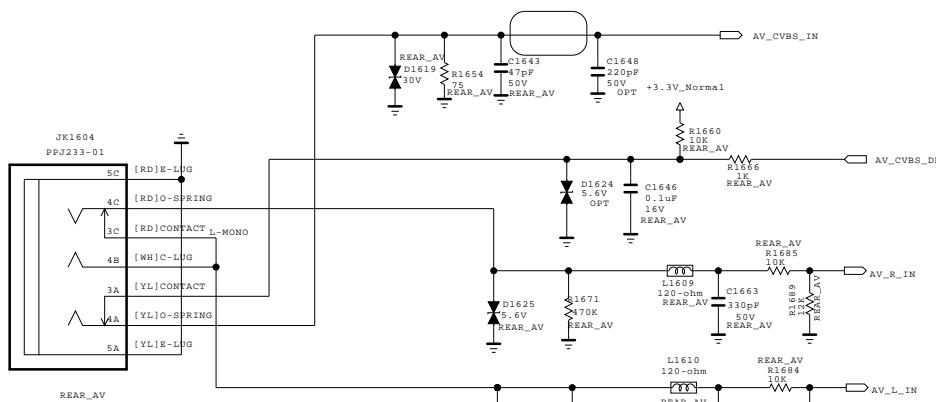
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FIRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110324
BLOCK	NTP7400	SHEET	16

Rear AV



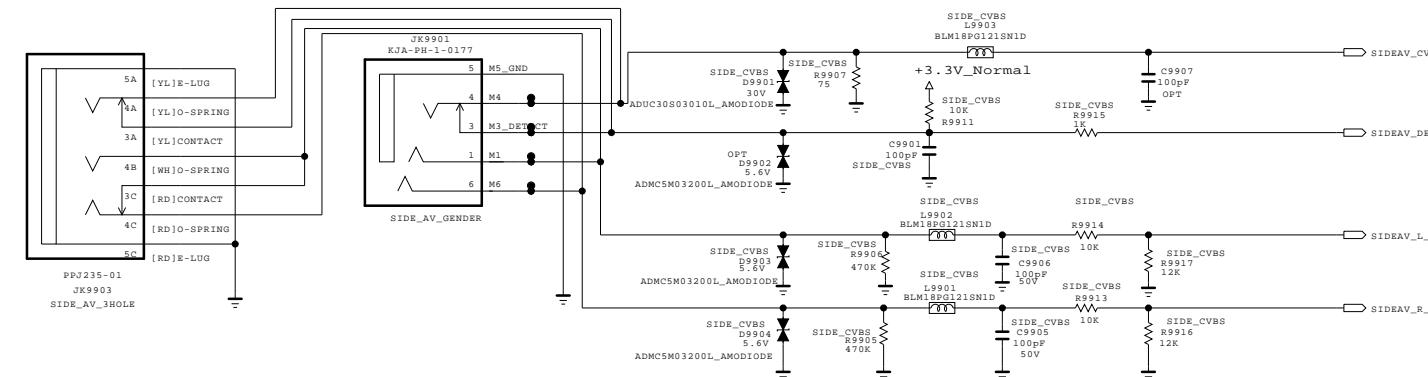
THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FIRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IT IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

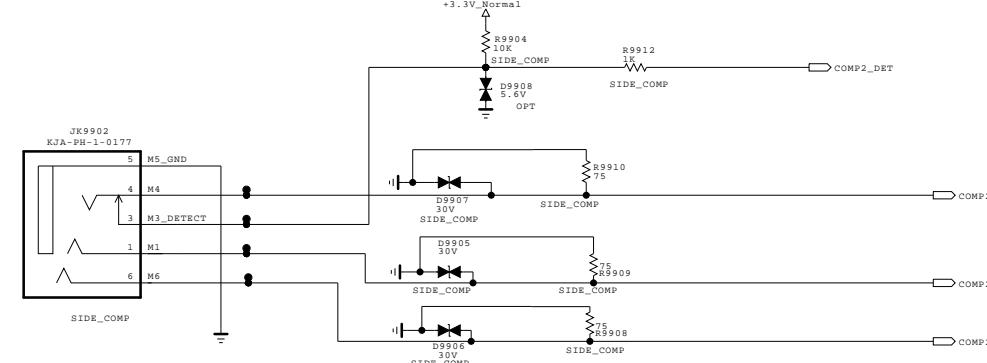
LG ELECTRONICS

MODEL	GP3 S7LR	DATE	20110324
BLOCK	REAR JACK	SHEET	17 /

SIDE CVBS PHONE JACK
(New Item Development)



SIDE COMPONENT PHONE JACK
(New Item Development)



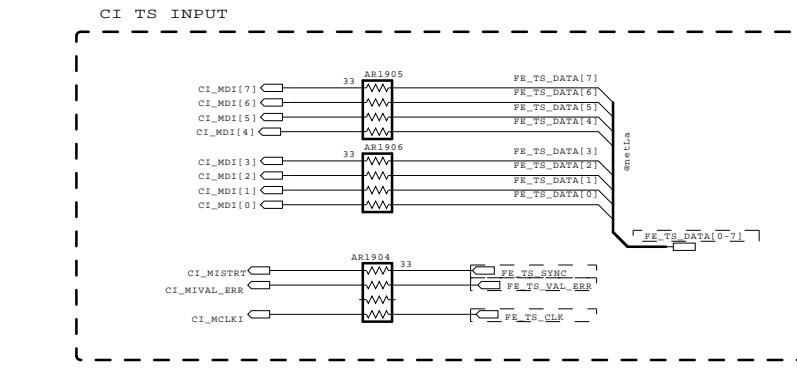
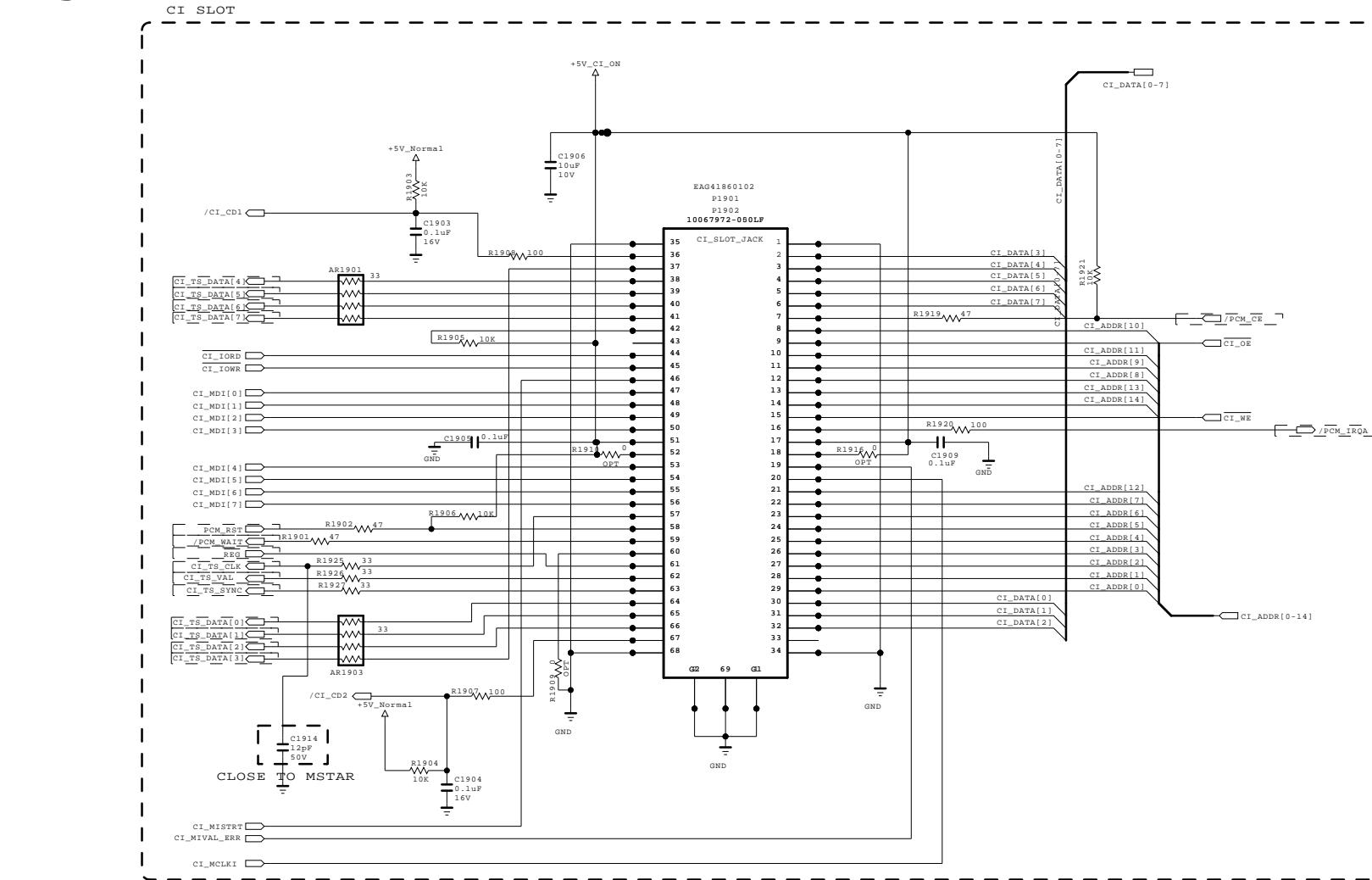
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION, FIRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IT IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

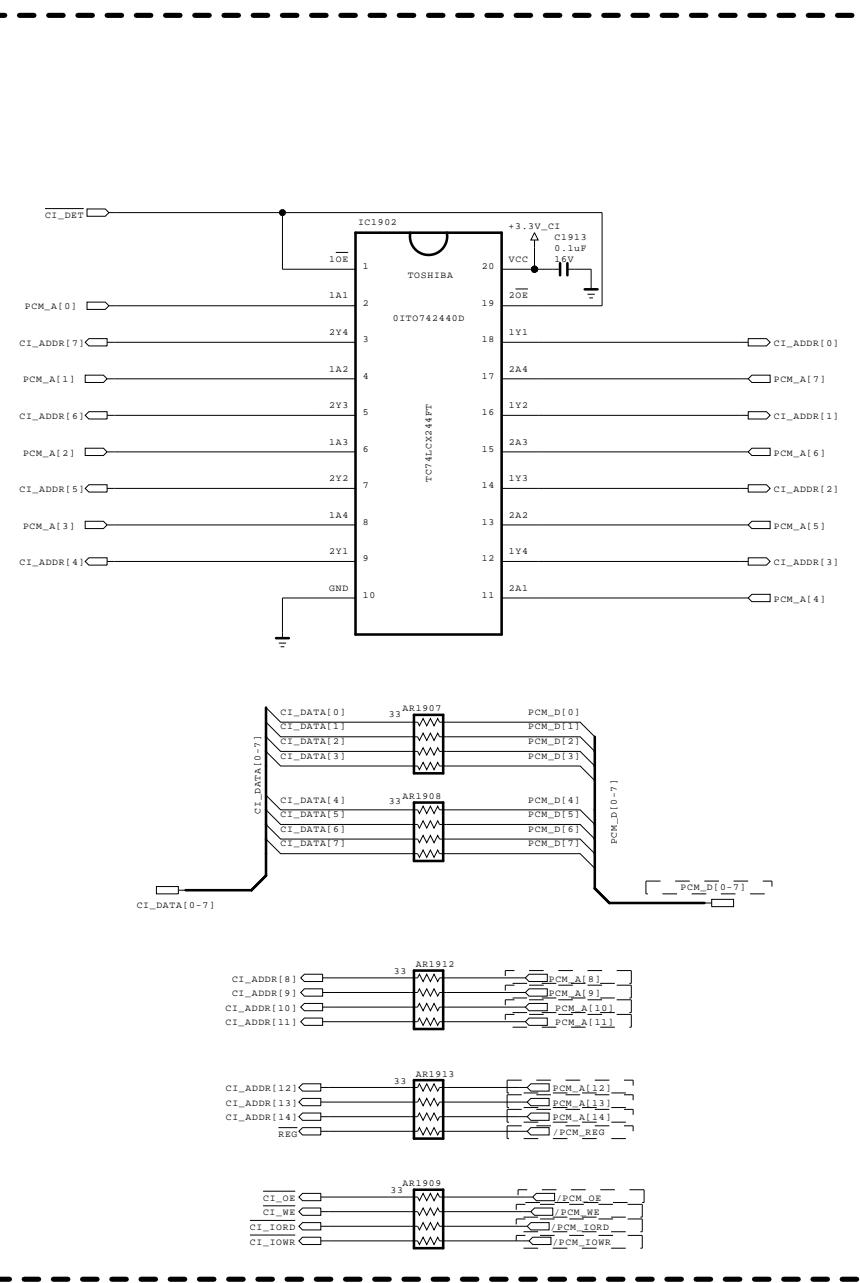
LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110324
BLOCK	SIDE_JACK	SHEET	18

CI Region



CI HOST I/F



SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION, FIRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

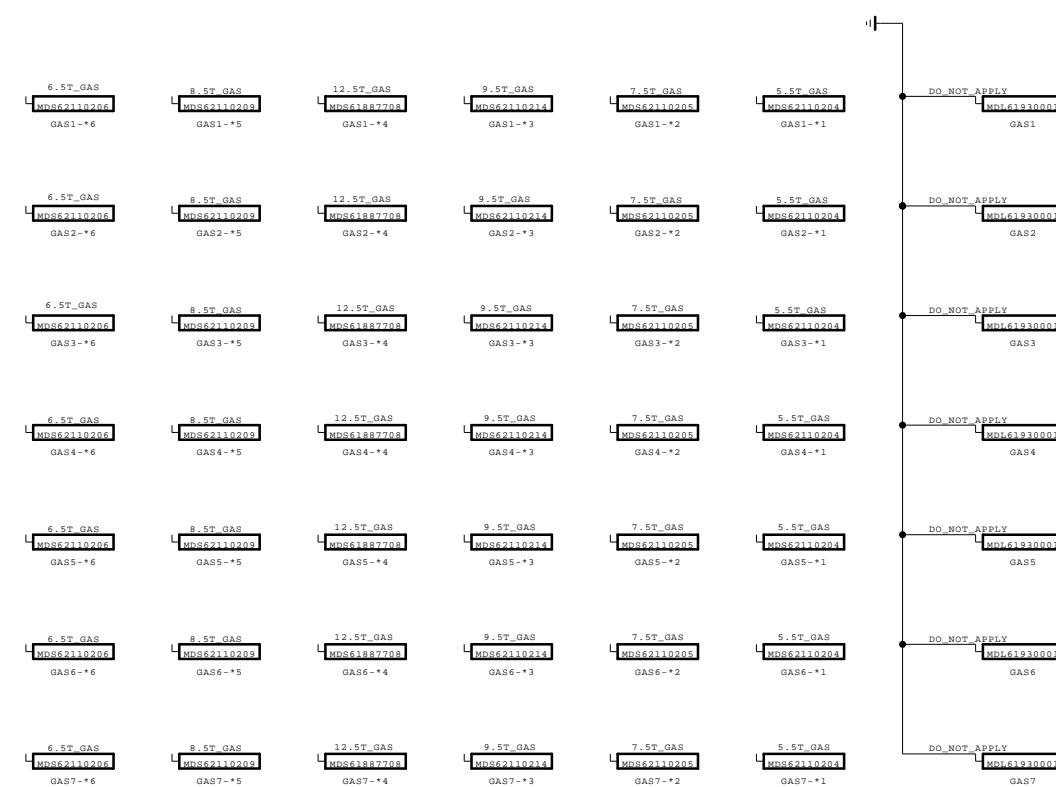
LG ELECTRONICS

MODEL	GP3_S7LR	DATE	20110324
BLOCK	PCMCII	SHEET	20

THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES
SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION,
FIRE AND ELECTRICAL SHOCK HAZARDS. WHEN SERVICING IF IS
ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR
THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

SECRET
LG Electronics

SMD GASKET



 **LG ELECTRONICS**

MODEL	GP3_S7LR	DATE	20110324
BLOCK	SMD_GAS	SHEET	20



Training Manual

(GP2R Mstar)

< Contents >

Overall Block Diagram

Video Signal Block

Audio Signal Block

Flash Block & Reset

I2C Block

GPIO Block

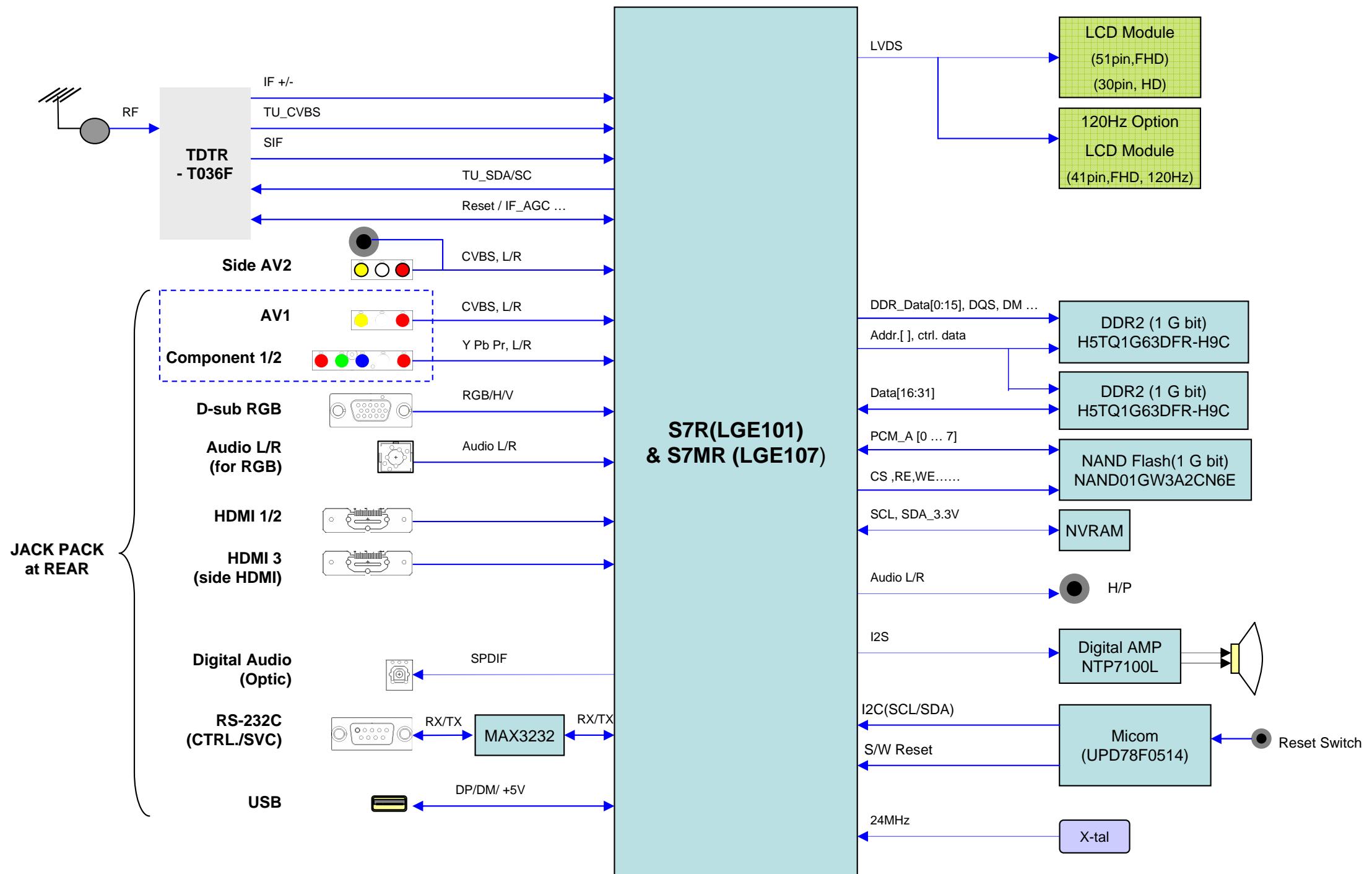
LVDS 출력 Block

POWER Block

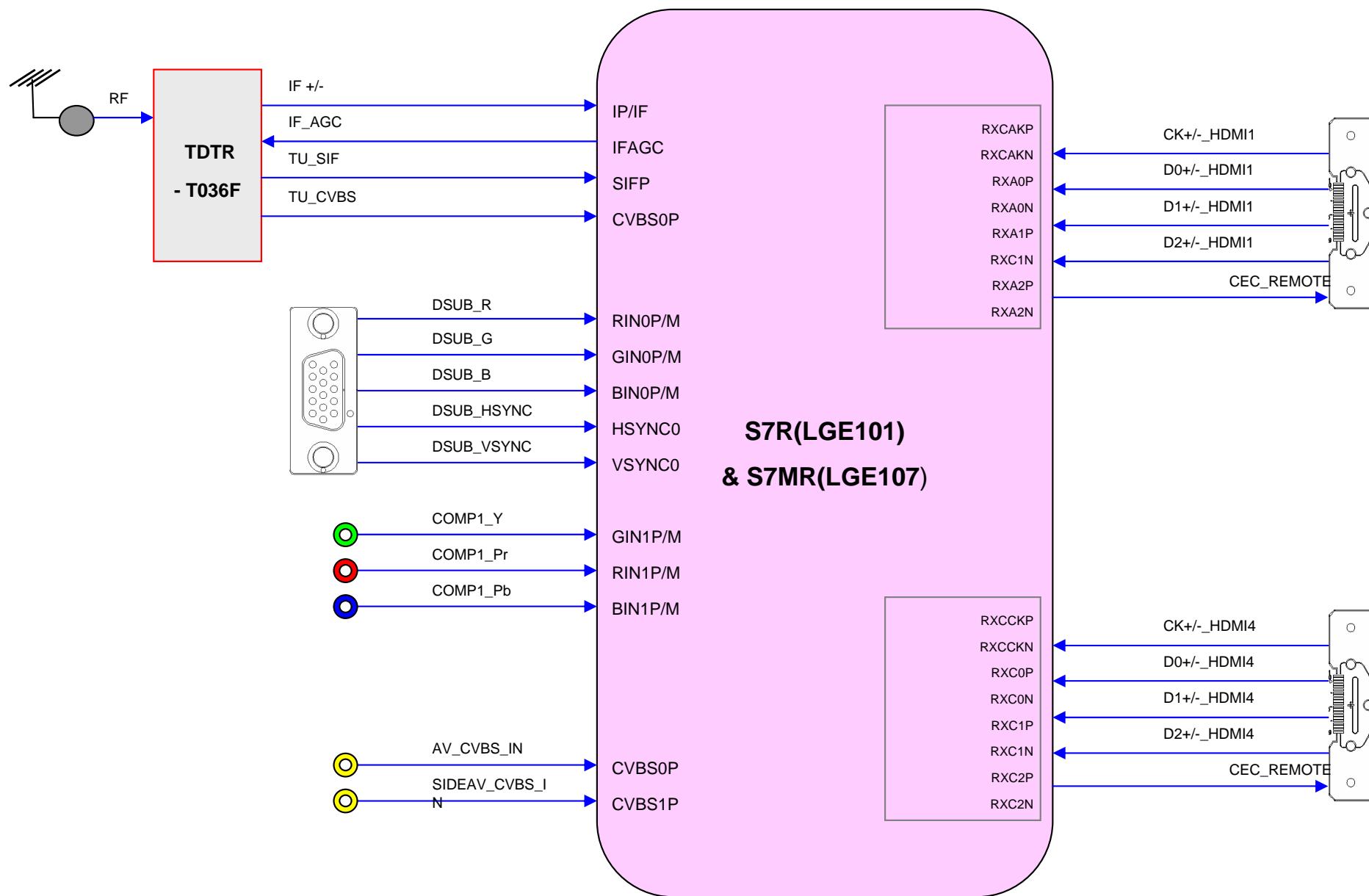
Trouble Shooting



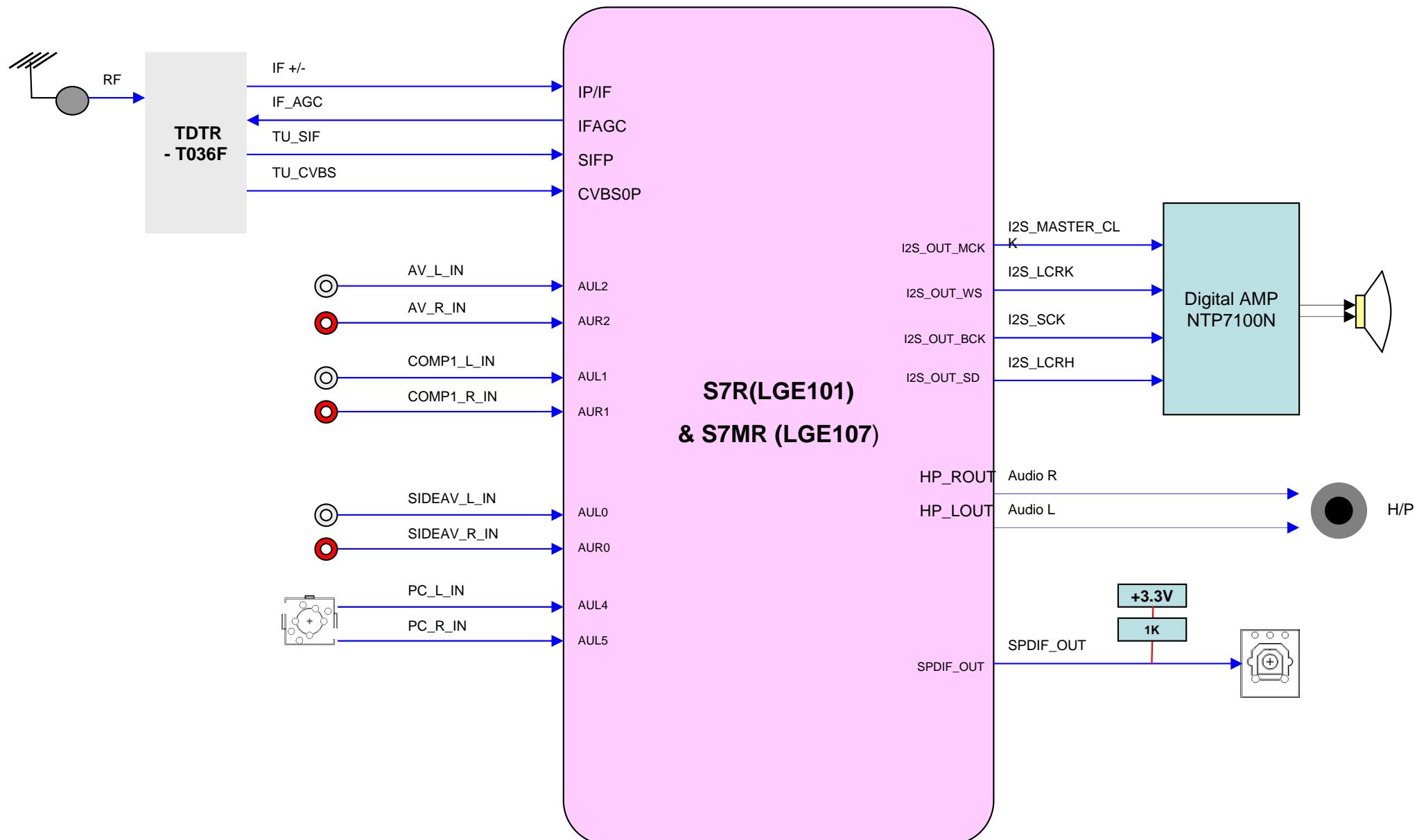
**LG Electronics/ LCD TV Division
LCD TV Gr.**



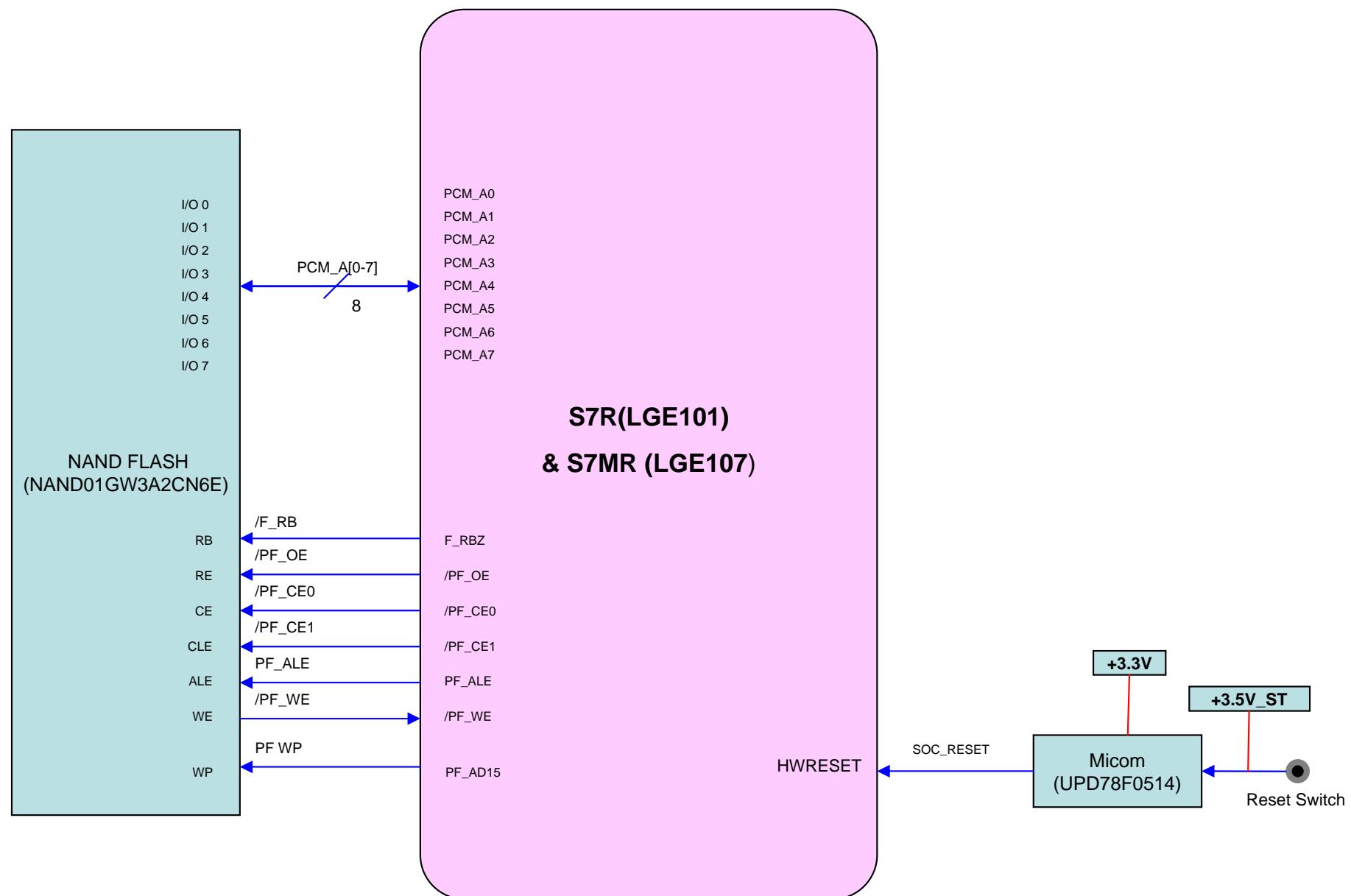
Video Signal Block



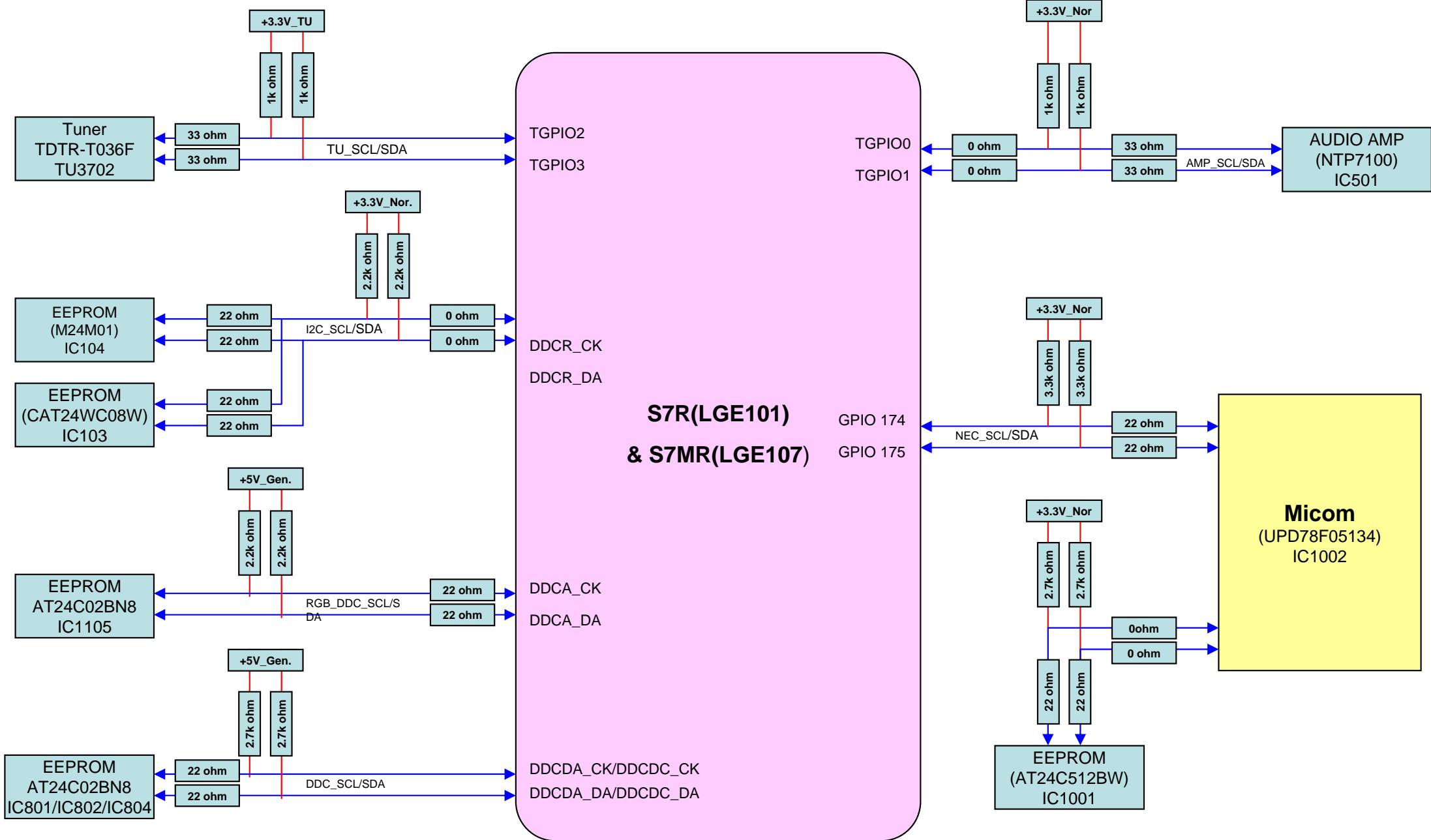
Audio Signal Block



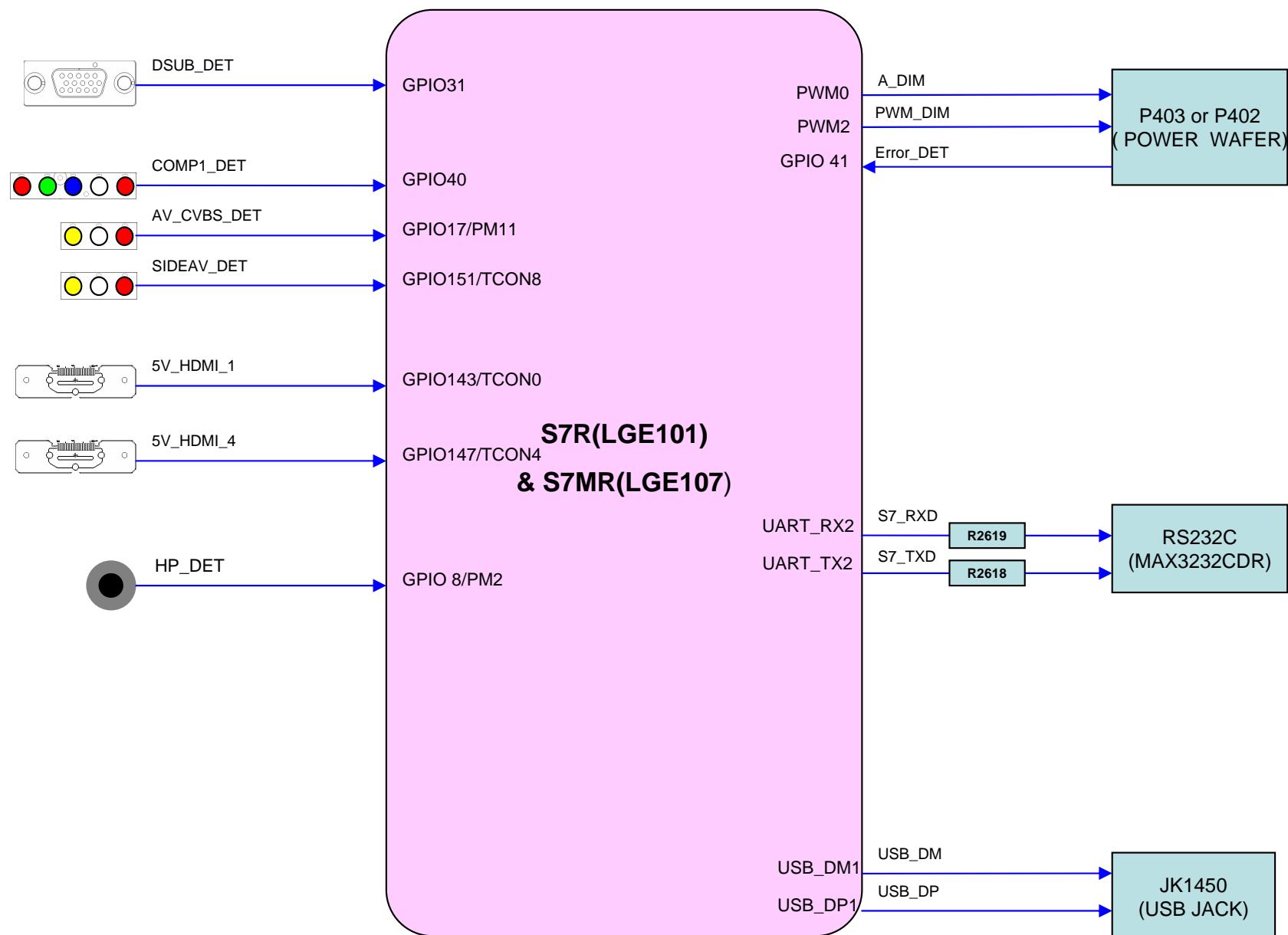
Flash & EJTAG Block



I2C Block



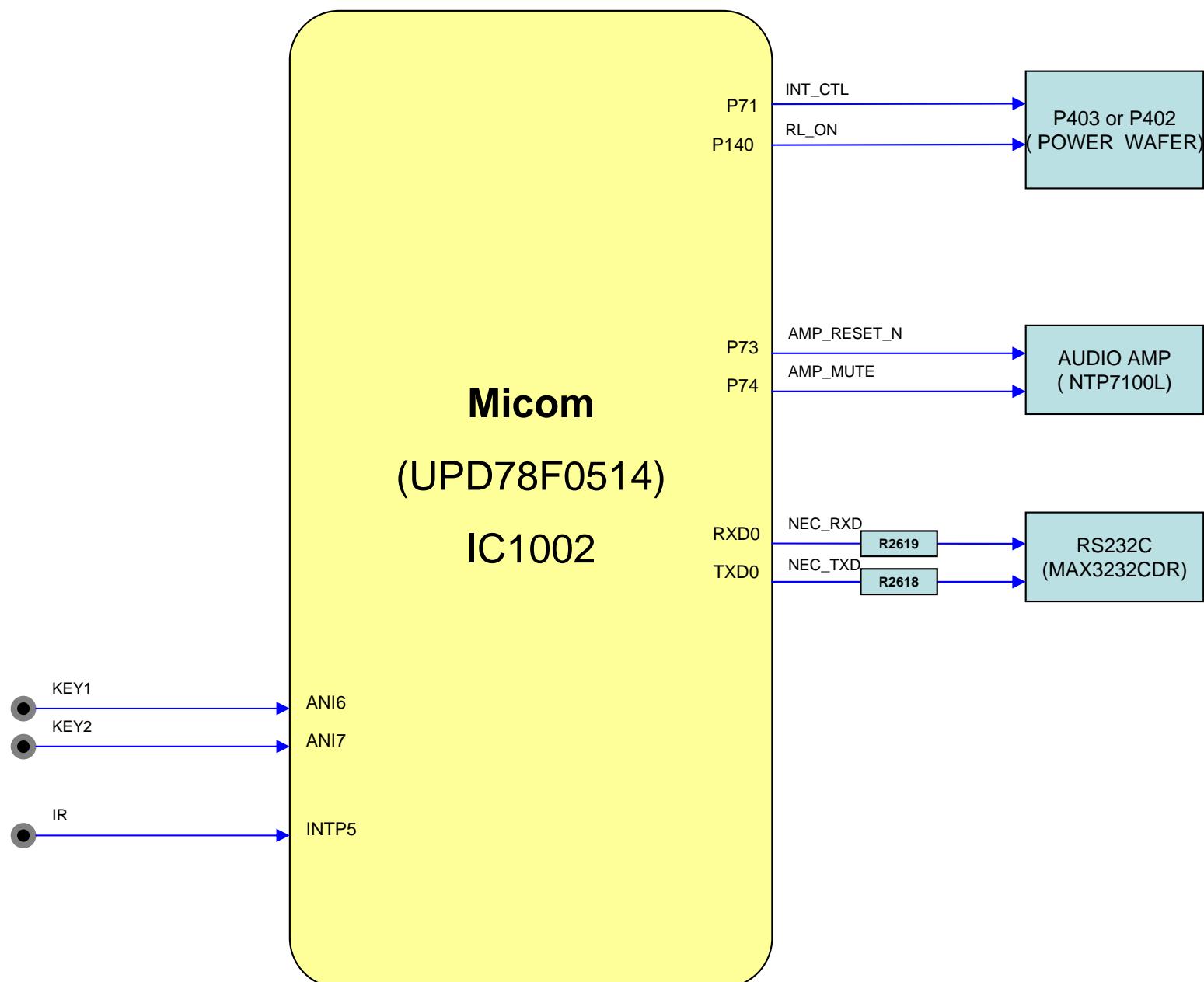
GPIO Block



GPIO Block

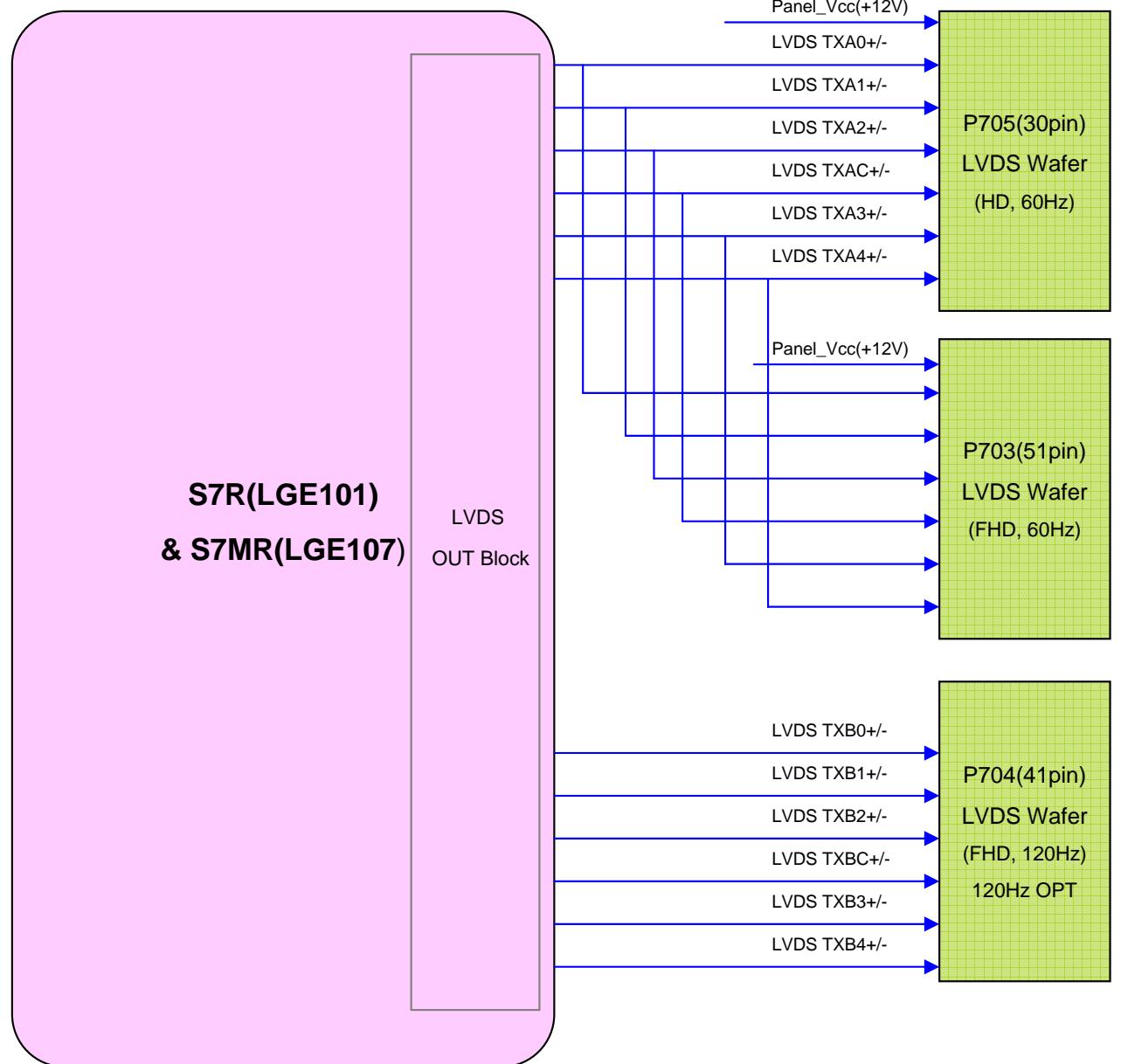
	Pin Number	Pin Name	Signal Name		Pin Number	Pin Name	Signal Name
41	UART_TX2/GPIO65	M23	S7_TXD		90	GPIO18/PM12/INT4	F10
42	UART_RX2/GPIO64	N23	S7_RXD		91	GPIO17/PM11/INT3	G12
43	DDCR_DA/GPIO71	M22	I2C_SDA		92	PM_SPI_CS2/GPIO16/PM10	D8
44	DDCR_CK/GPIO72	N22	I2C_SCL		93	GPIO15/PM9	F6
45	DDCA_DA/UART0_TX	A5	RGB_DDC_SDA		94	PM_SPI_WP2/GPIO14/PM8/INT2	F7
46	DDCA_CK/UART0_RX	B5	RGB_DDC_SCL		95	PM_SPI_WP1/GPIO13/PM7	E9
47	PWM0/GPIO66	K23	PWM0		96	PM_SPI_CS1/GPIO12/PM6	E8
48	PWM1/GPIO67	K22	PWM1		97	GPIO11/PM5/PM_UART_RX/INT1	C5
49	PWM2/GPIO68	G23	PWM2		98	GPIO10/PM4	F9
50	PWM3/GPIO69	G22	SC_RE2		99	GPIO9/PM3	G9
51	PWM4/GPIO70	G21	SC_RE1		100	GPIO8/PM2	E11
52	SAR0/GPIO31	C6	DSUB_DET		101	GPIO7/PM1/PM_UART_TX	D7
53	SAR1/GPIO32	B6	MODEL_OPT_		102	GPIO6/PM0/INT0	E7
54	SAR2/GPIO33	C8	PCM_5V_CTL		103	GPIO51/UART1_TX	F19
55	SAR3/GPIO34	C7	RST_PHY		104	GPIO50/UART1_RX	F20
56	SAR4/GPIO35	A6	RST_HUB		105	GPIO42	G19
62	MPIF_CS_N	D14	PIF_SPI_CS		106	GPIO41	G20
63	MPIF_CLK	D12	.		107	GPIO40	M20
86	PM_SPI_DO/GPIO3	D10	SPI_SDO		108	GPIO39	L20
87	PM_SPI_DI/GPIO2	E10	SPI_SDI		109	GPIO38	K20
88	GPIO0/PM_SPI_CZ	D11	.		110	GPIO37/UART3_TX	L23
89	PM_SPI_CK/GPIO1	D9	SPI_SCK		111	GPIO36/UART3_RX	K21
					112	GPIO151/TCON8	P21
					113	GPIO149/TCON6	L21
					114	GPIO147/TCON4	L22
					115	GPIO145/TCON2	M21
					116	GPIO143/TCON0	N21
							5V_DET_HDMI_1

GPIO Block(MICOM)

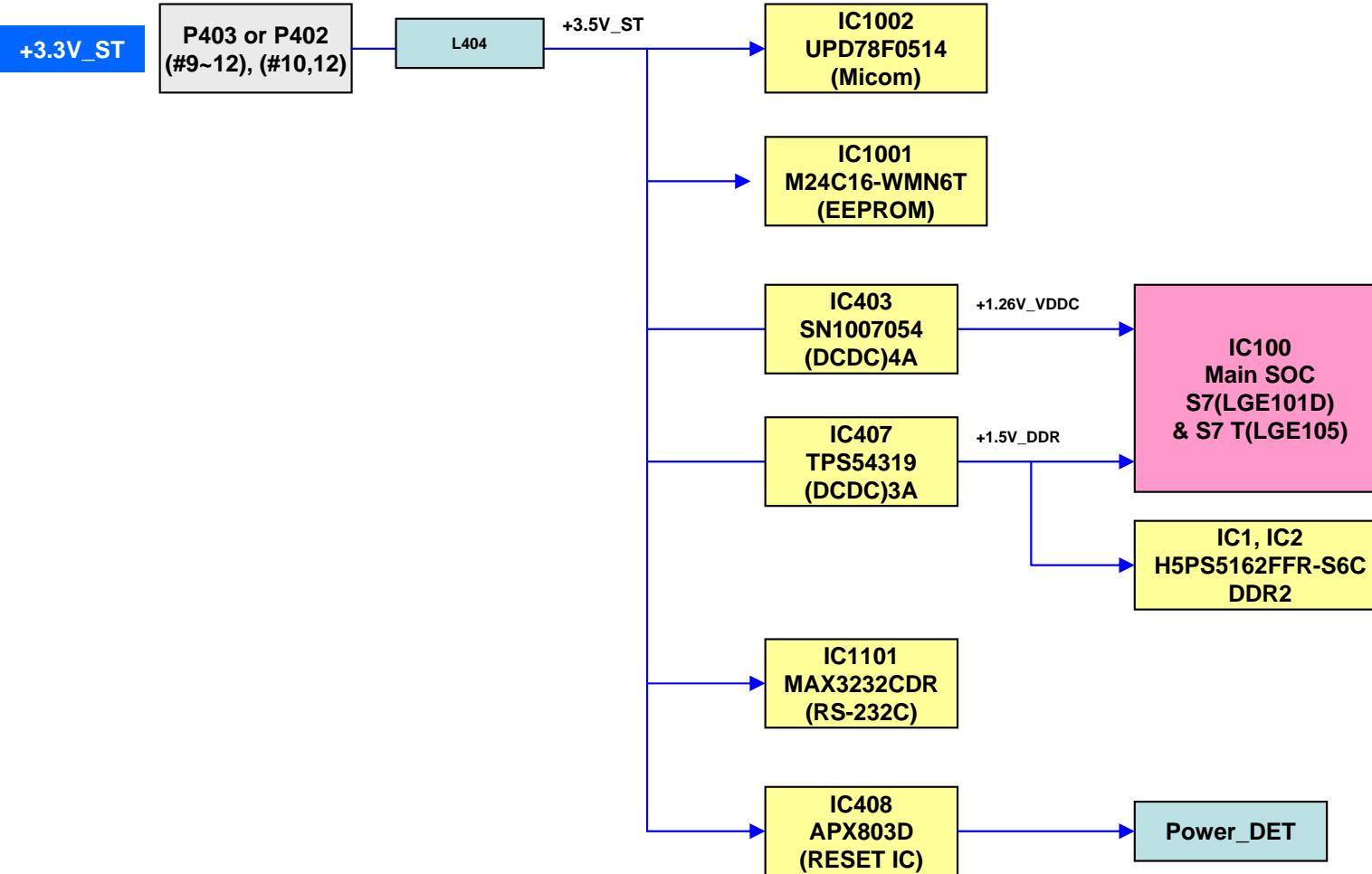


GPIO Block(MICOM)

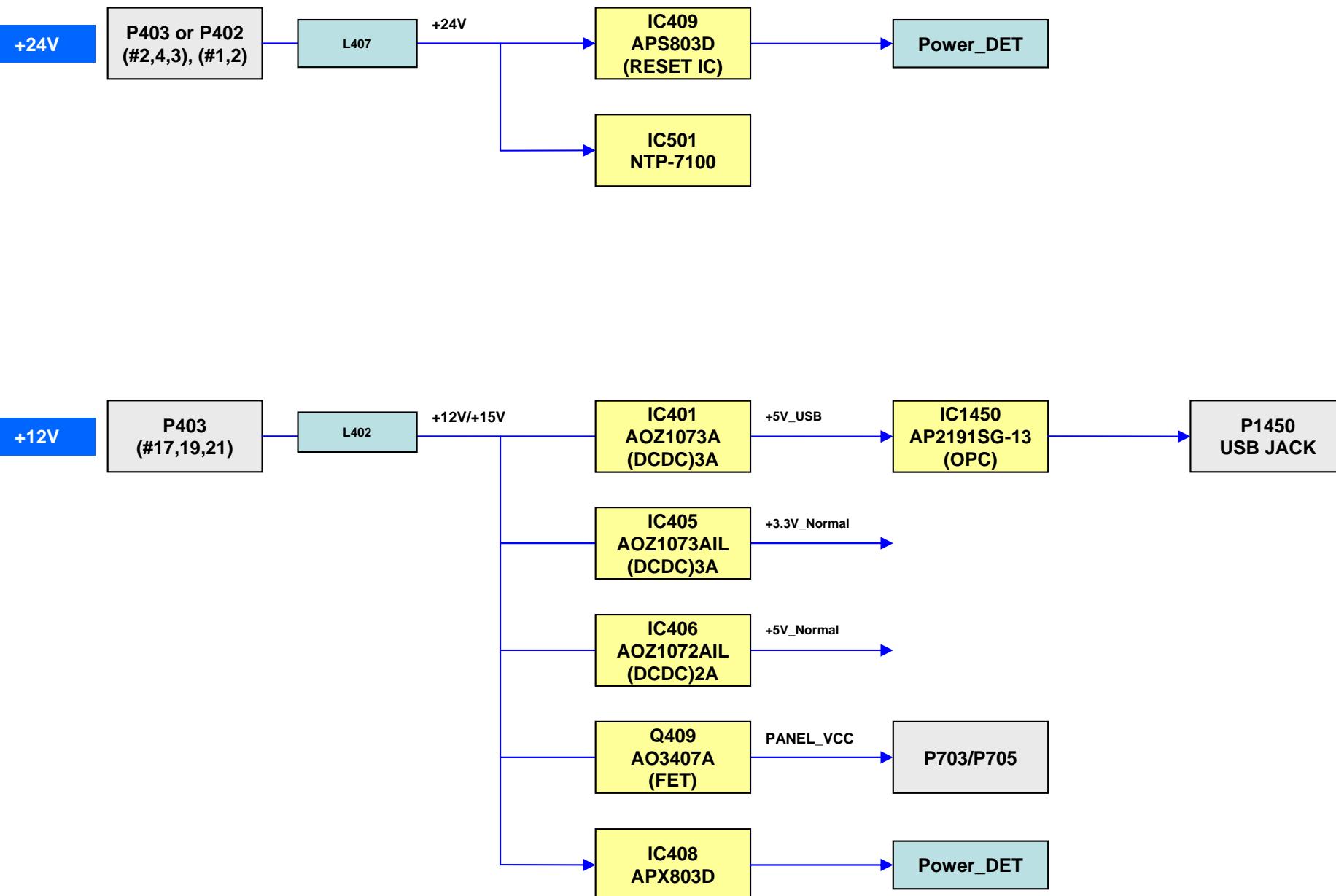
LVDS Output Block



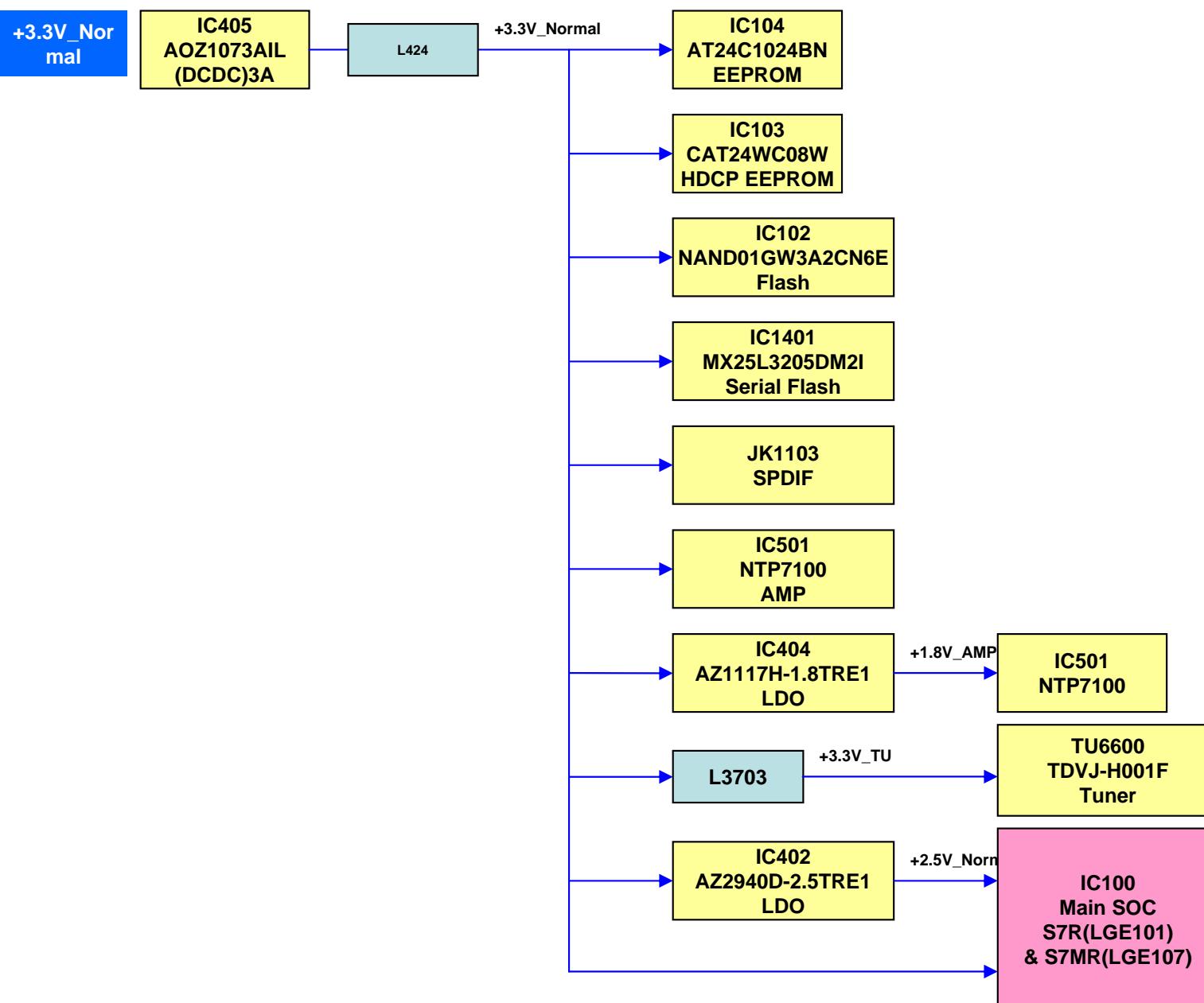
POWER Block (+3.5V_ST)



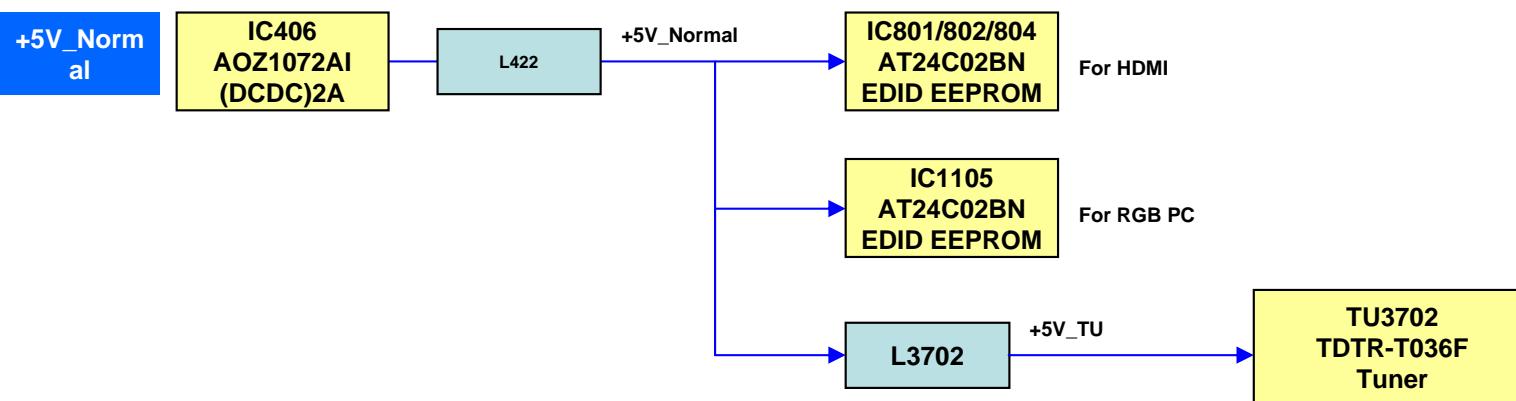
POWER Block (+24V & 12V)



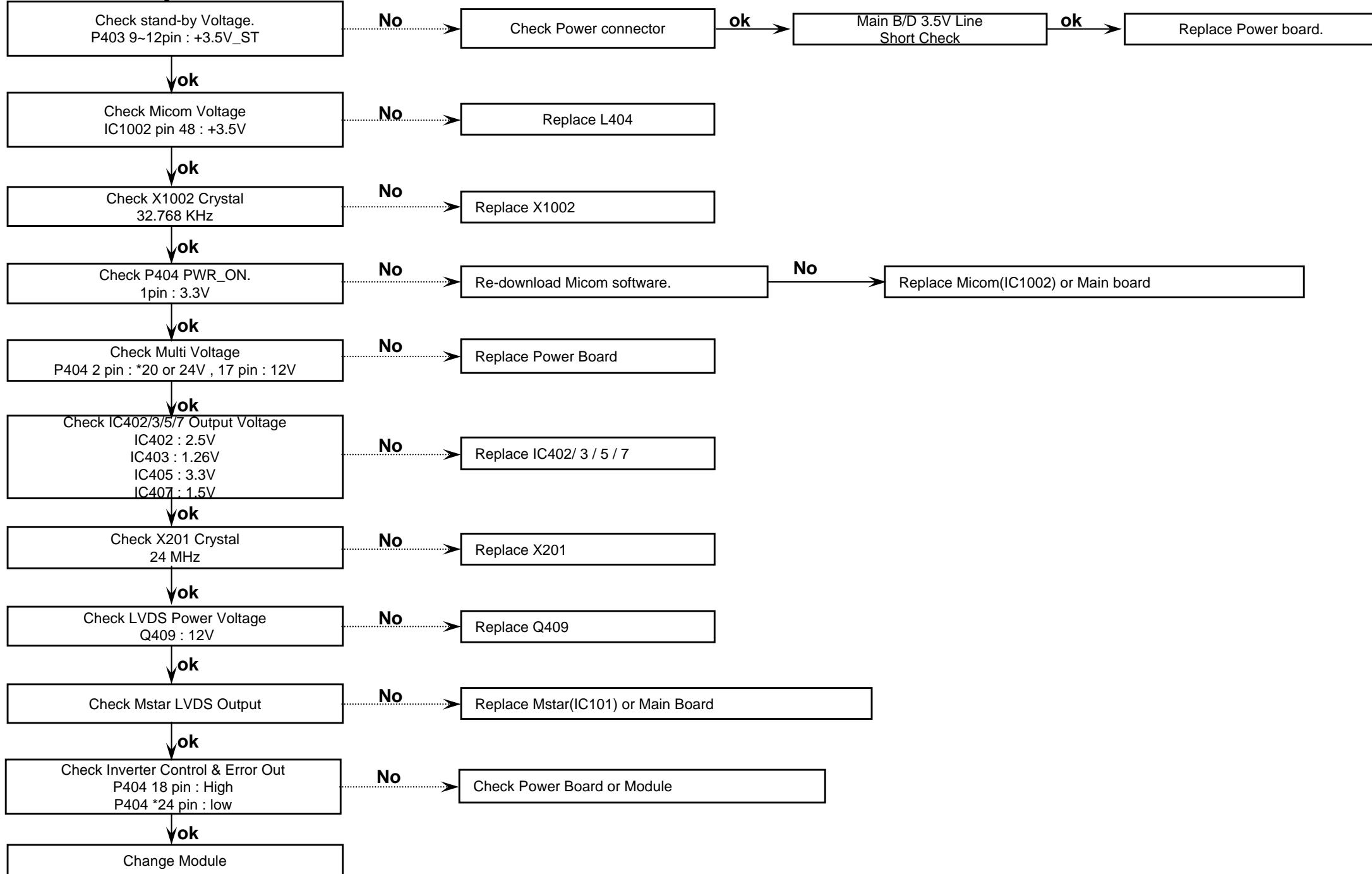
POWER Block (+3.3V_Normal)



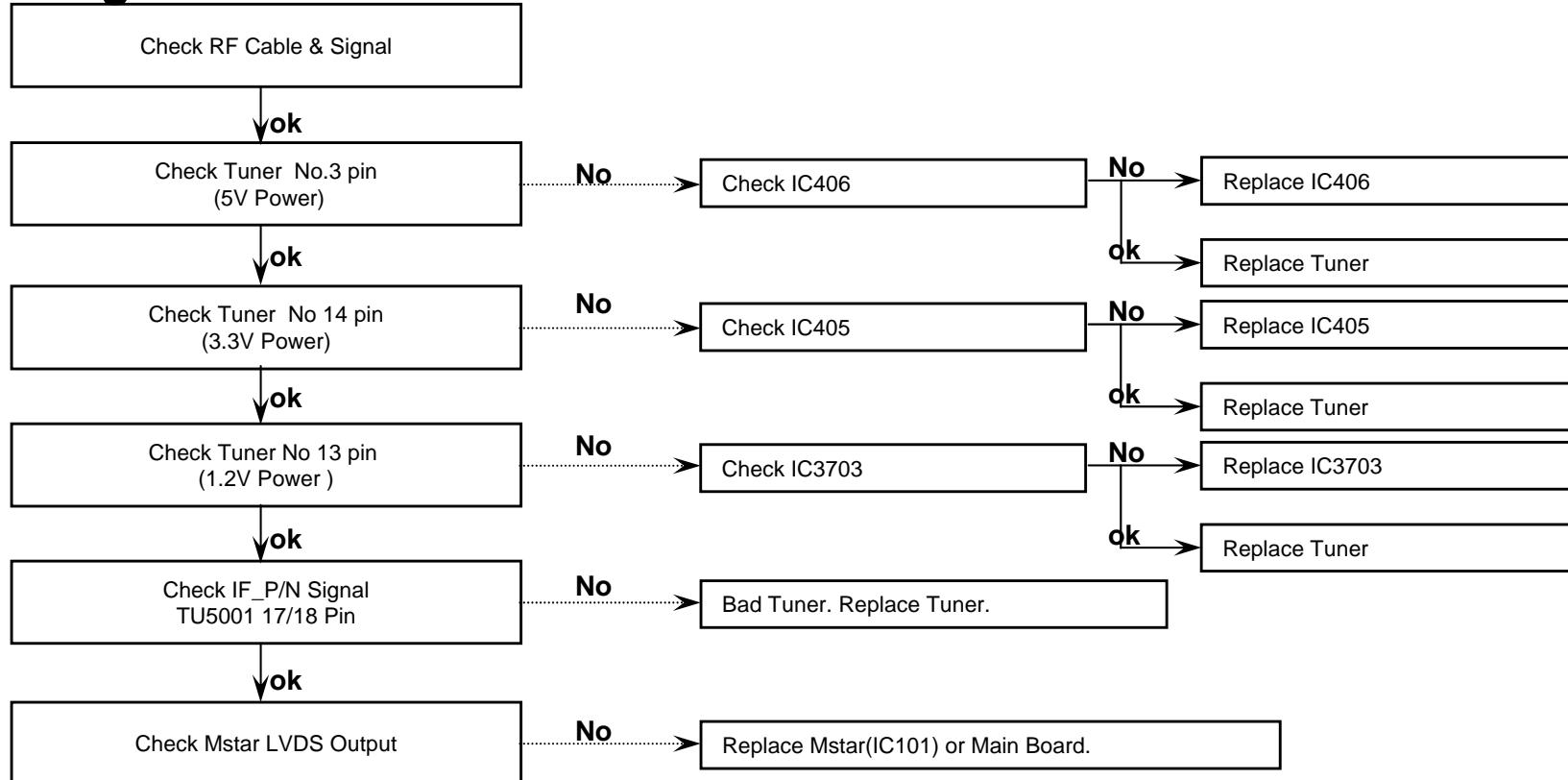
POWER Block (+5V_Normal)



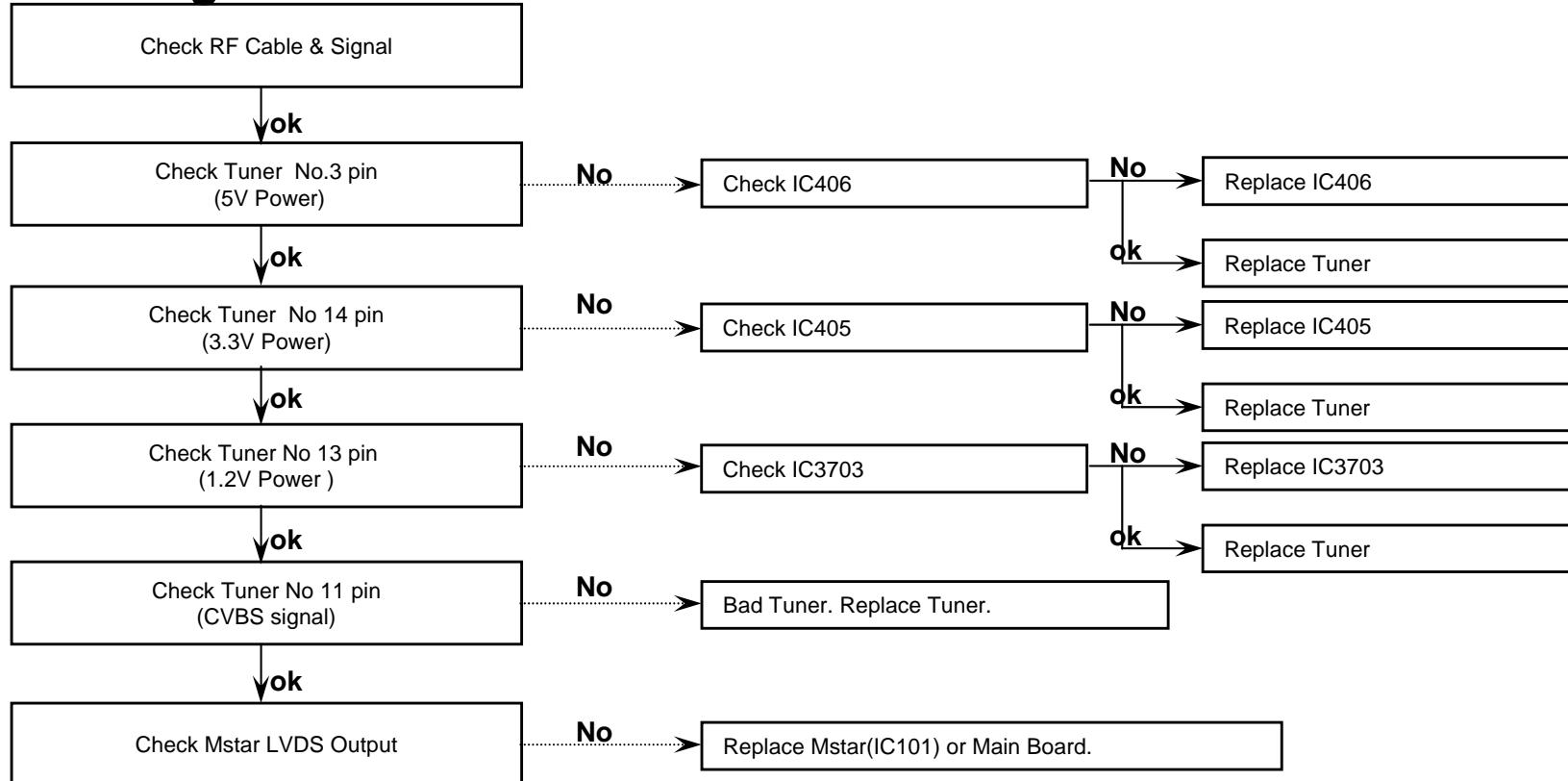
1. Power-up boot check



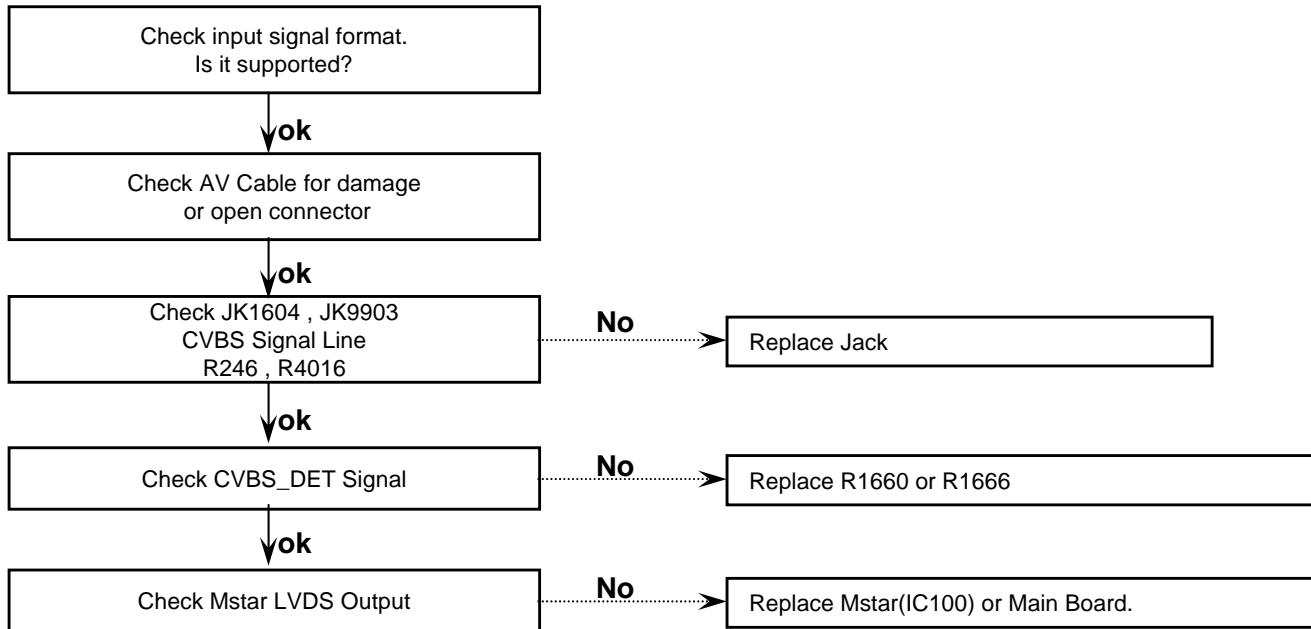
2. Digital TV Video



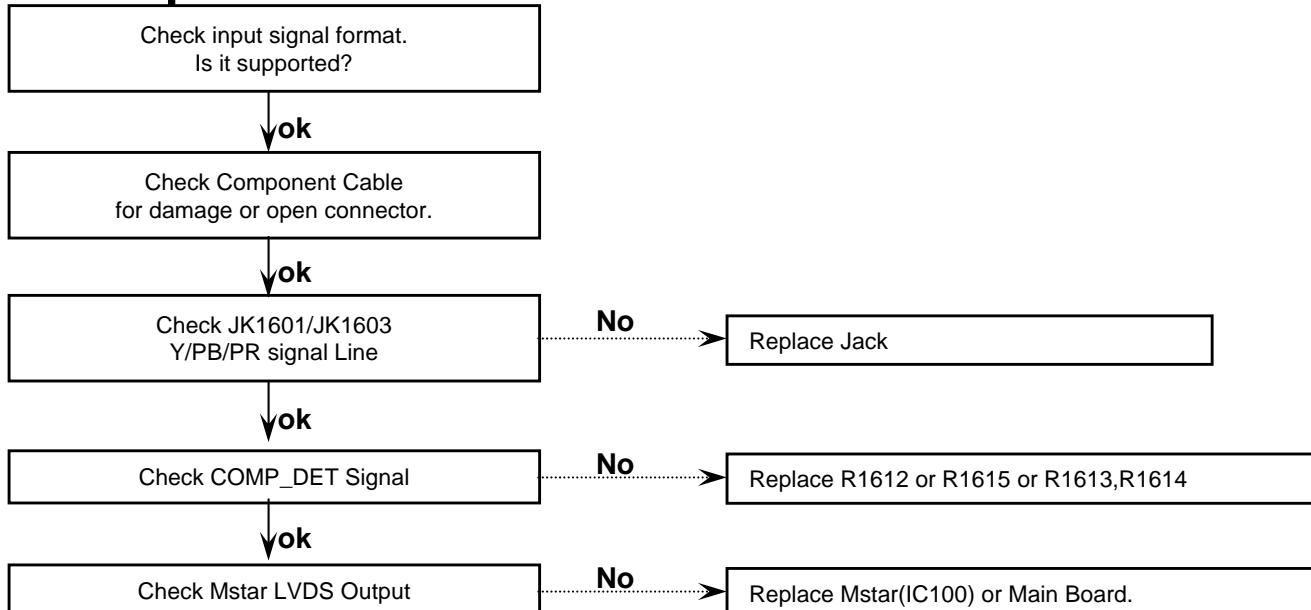
3. Analog TV Video



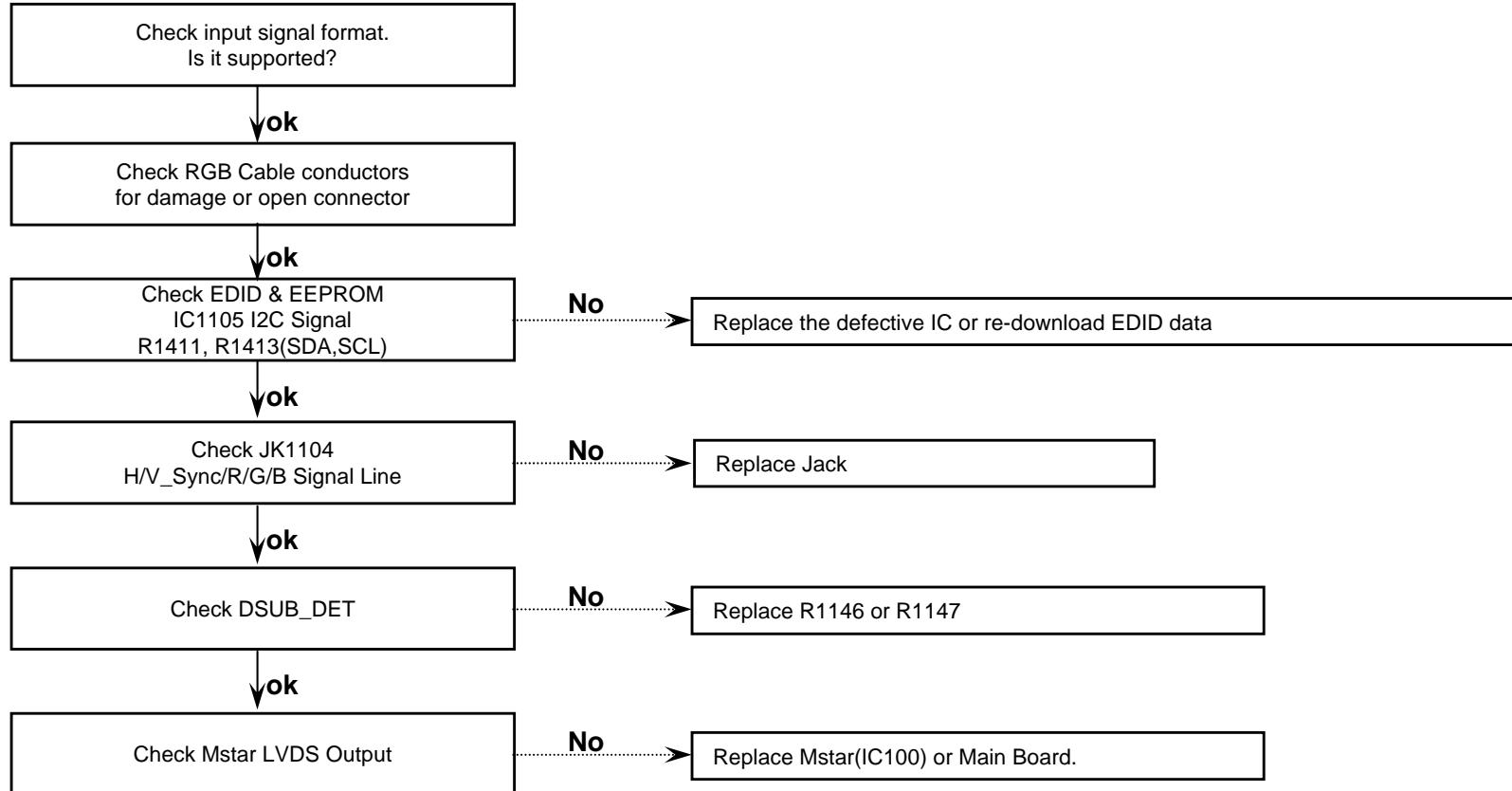
4. AV Video



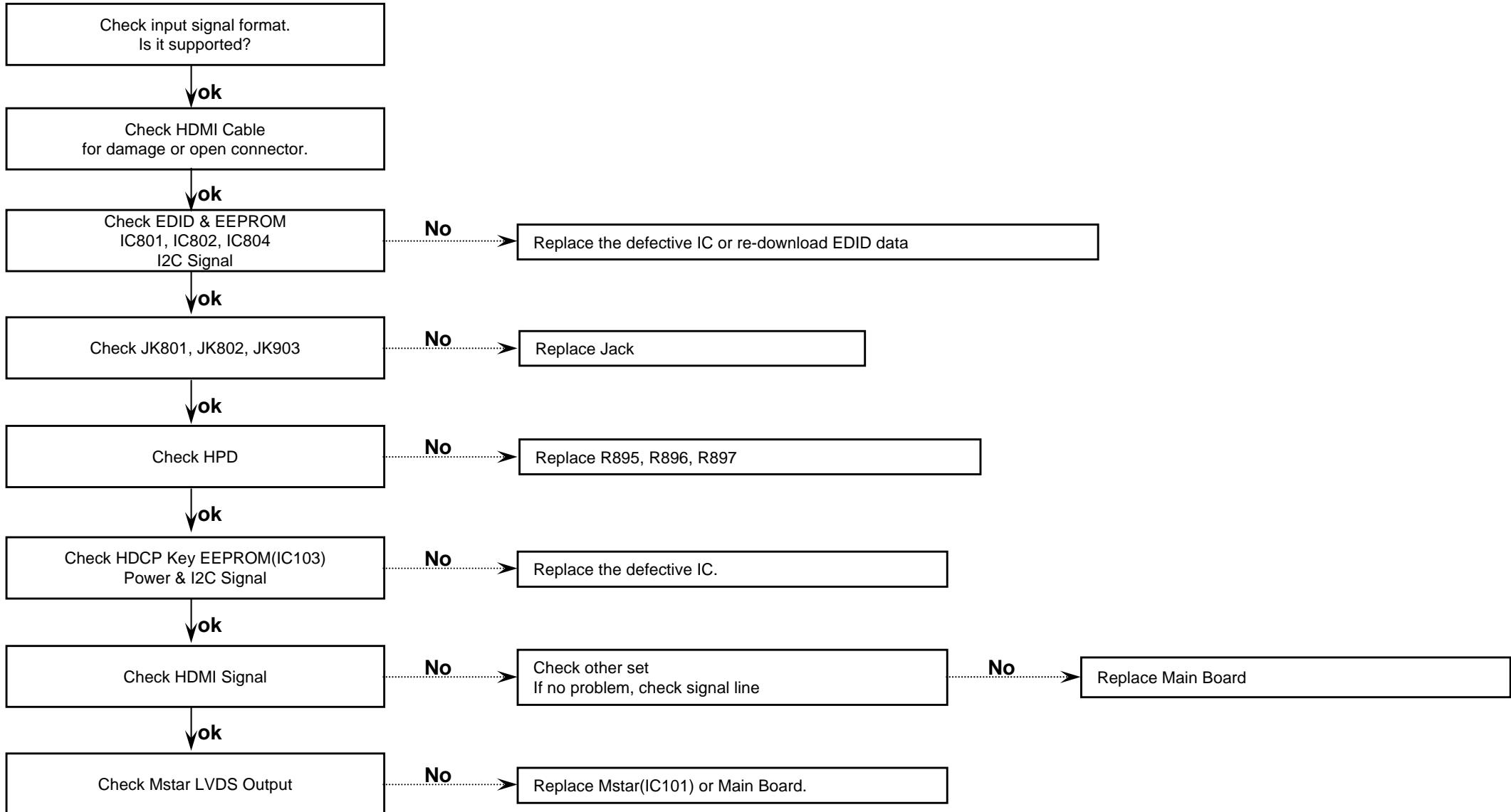
5. Component Video



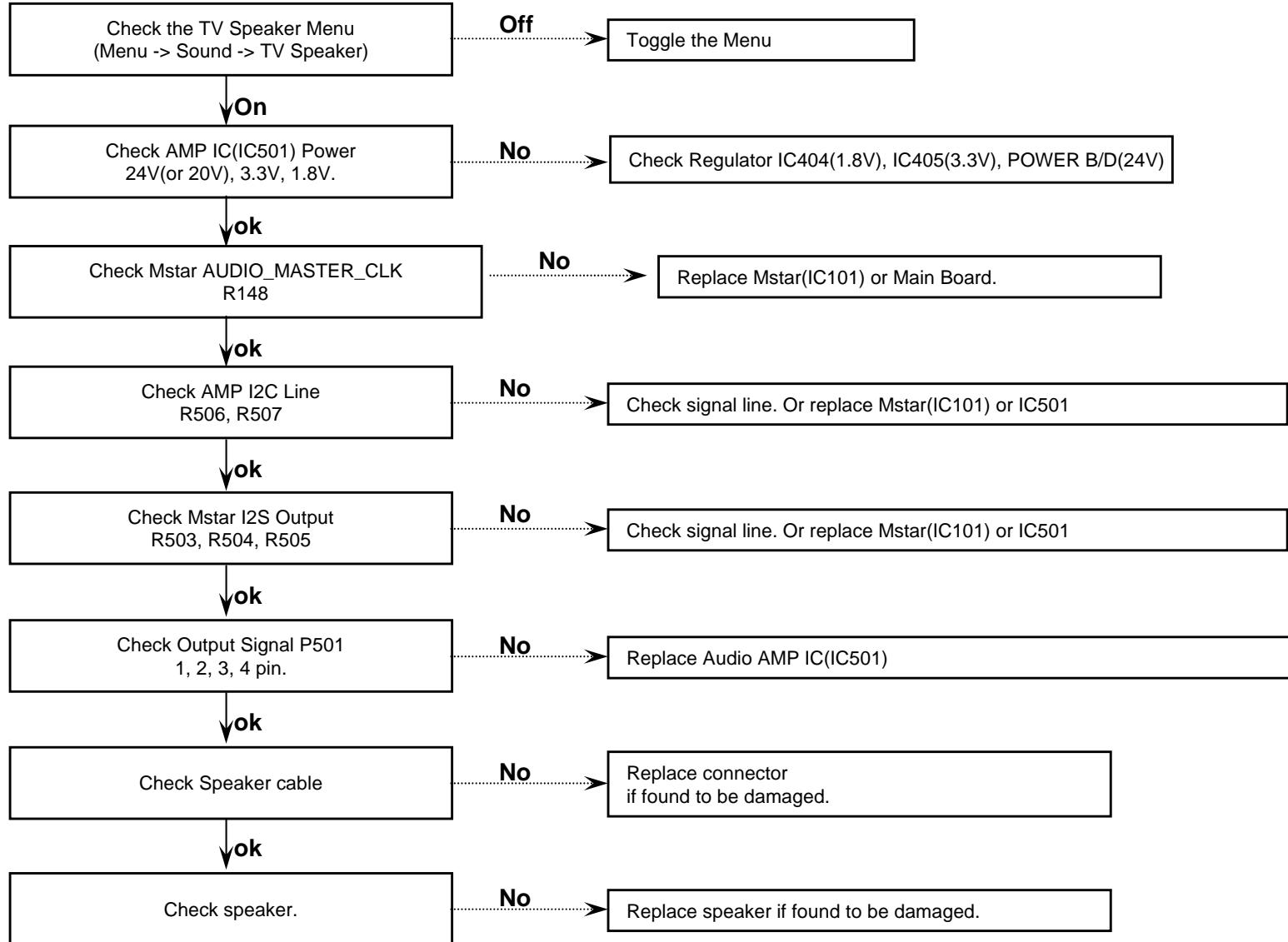
6. RGB Video



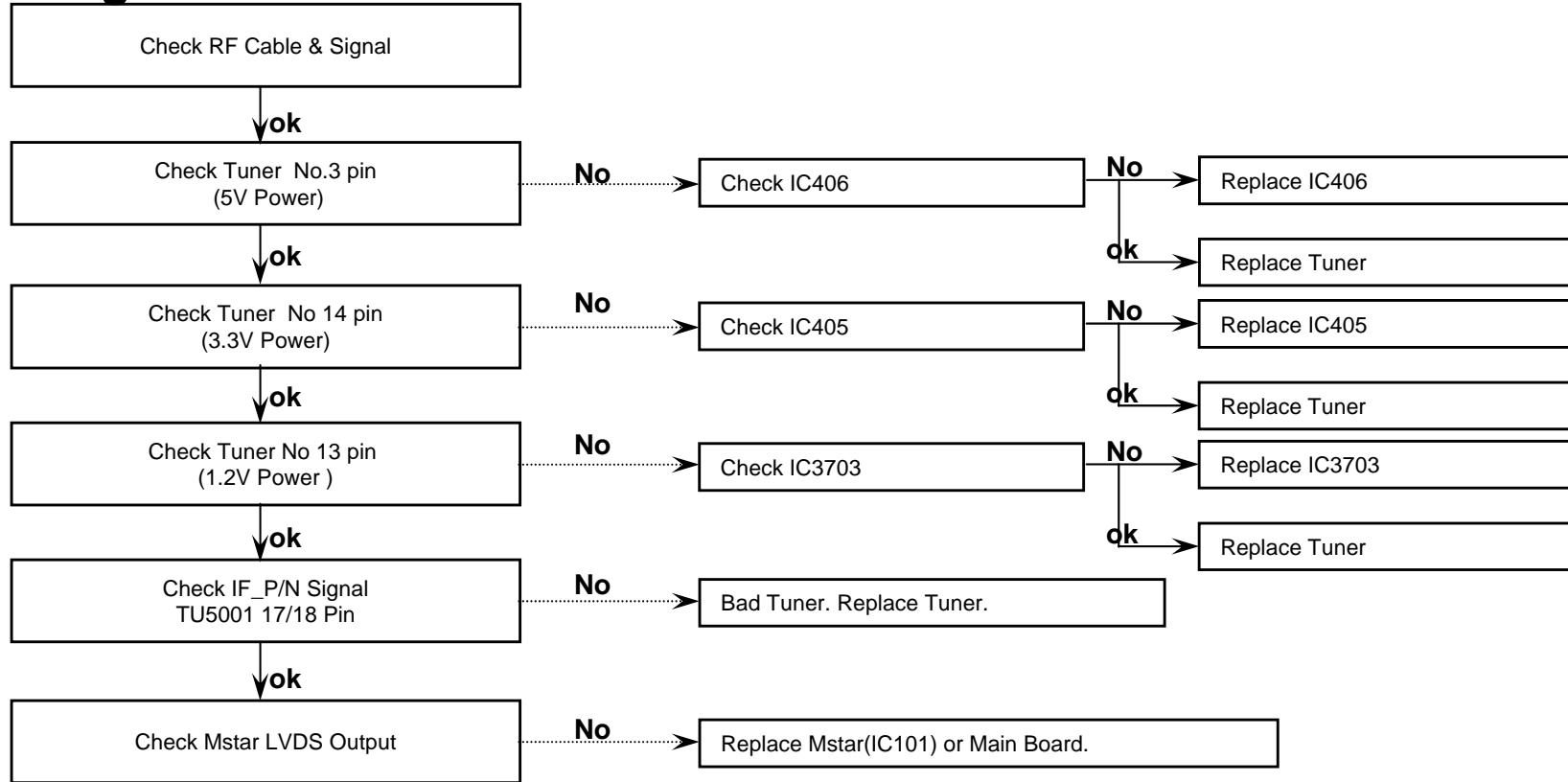
7. HDMI Video



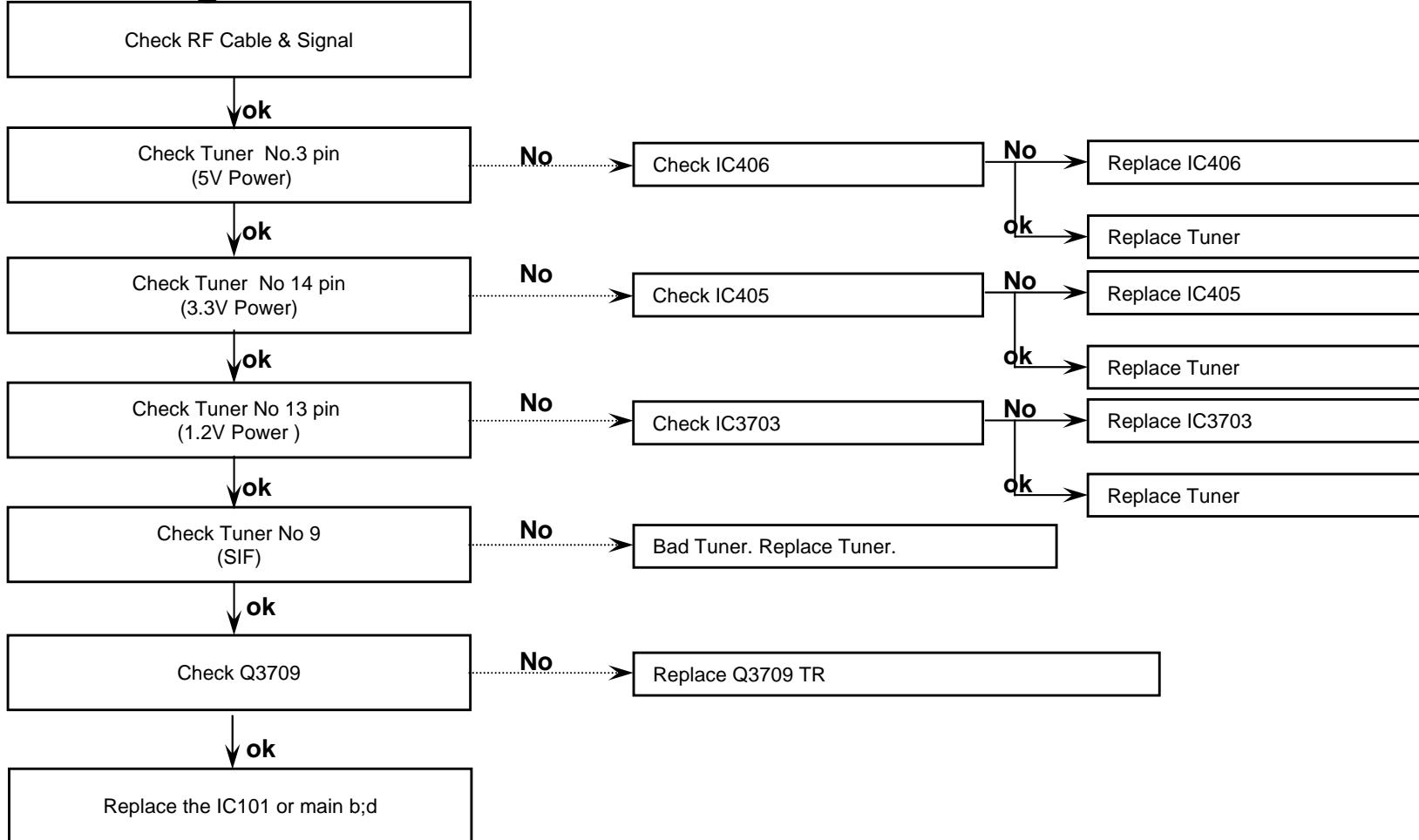
8. All Source Audio



9. Digital TV Audio



10. Analog TV Audio



11. AV Audio

Check AV Cable for damage
for damage or open connector

↓ok

Check JK1604 , JK9903 or JK9901
& Audio Line

No

Replace Jack

↓ok

Follow procedure
'8. All source audio'
trouble shooting guide.

12. Component Audio

Check Component Cable
for damage or open connector.

↓ok

Check JK1603, JK1601 & Audio Line

No

Replace Jack

↓ok

Follow procedure
'8. All source audio'
trouble shooting guide.

13. RGB Audio

Check Cable conductors
for damage or open connector

↓ok

Check JK1102 & Audio Line

No

Replace Jack

↓ok

Follow procedure
'8. All source audio'
trouble shooting guide.